HP ProLiant SL270s Gen8 Server User Guide

Abstract

This document provides detailed instructions to configure and use the HP ProLiant SL270s Gen8 Server.

Part Number: 666300-001
August 2012
Edition: 1

© Copyright 2012 Hewlett-Packard Development Company, L.P.

The information contained herein is subject to change without notice. The only warranties for HP products and services are set forth in the express warranty statements accompanying such products and services. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Microsoft® and Windows® are U.S. registered trademarks of Microsoft Corporation. Bluetooth® is a trademark owned by its proprietor and used by Hewlett-Packard Company under license.

Contents

Component identification 6
- Front panel components 6
- Front panel LEDs and buttons 7
- Rear panel components 8
- Rear panel LEDs and buttons 8
- System board components 9
  - DIMM slot locations 10
  - System maintenance switch 11
  - NMI jumper 11
- Device numbers 12
- GPU numbering 13
- Drive LED definitions 14

Operations 15
- Power up the server 15
- Power down the server 15
- Remove the server from the chassis 15
- Remove the processor air baffle 16

Setup 19
- Optional installation services 19
- Rack planning resources 19
- Optimum environment 19
  - Space and airflow requirements 20
  - Temperature requirements 20
  - Power requirements 21
  - Electrical grounding requirements 21
- Rack warnings 21
- Contents of the server shipping carton 22
- Installing the chassis 22
- Installing options 22
- Installing components 23
- Installing the server into the chassis 23
- Powering up the chassis 25
- Configuring the chassis 25
- Powering on and selecting boot options 25
- Installing the system software 26
- Registering the server 26

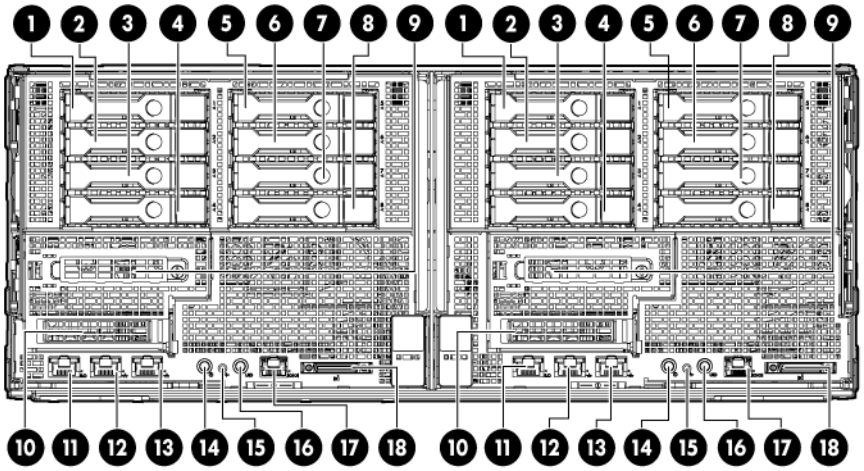
Hardware options installation 27
- Introduction 27
- Processor option 27
- Memory options 31
  - HP SmartMemory 31
  - Memory subsystem architecture 32
  - Single-, dual-, and quad-rank DIMMs 32
  - DIMM identification 33

Memory configurations ... 33
General DIMM slot population guidelines ... 35
Installing a DIMM ... 36
Hot-plug hard drive guidelines ... 37
Removing the hard drive blank ... 38
Installing a hot-plug SAS hard drive ... 38
Controller options ... 39
Installing the cache module ... 40
Installing the FBWC capacitor pack ... 42
Expansion board options ... 46
Installing an expansion board or FlexibleLOM ... 46
Installing a PCI riser board assembly ... 50
Redundant hot-plug power supply option ... 52
Installing the 8X SFF Smart Array enablement option ... 54
Connecting the SUV cable ... 60
HP Trusted Platform Module option ... 61
Installing the Trusted Platform Module board ... 61
Retaining the recovery key/password ... 64
Enabling the Trusted Platform Module ... 65
Cabling ... 66
Cabling overview ... 66
FBWC capacitor pack cabling ... 66
Software and configuration utilities ... 68
Server mode ... 68
Server QuickSpecs ... 68
HP iLO Management Engine ... 68
HP iLO ... 68
Intelligent Provisioning ... 70
HP Insight Remote Support software ... 71
Scripting Toolkit ... 72
HP Service Pack for ProLiant ... 72
HP Smart Update Manager ... 73
HP ROM-Based Setup Utility ... 73
Using RBSU ... 74
Auto-configuration process ... 74
Boot options ... 74
Configuring AMP modes ... 75
Re-entering the server serial number and product ID ... 75
Utilities and features ... 76
Array Configuration Utility ... 76
Option ROM Configuration for Arrays ... 77
ROMPaq utility ... 77
Automatic Server Recovery ... 77
USB support ... 77
Redundant ROM support ... 78
Keeping the system current ... 78
Drivers ... 78
Software and firmware ... 79
Version control ... 79
HP Operating Systems and Virtualization Software Support for ProLiant Servers ... 79
HP Technology Service Portfolio ... 80
Change control and proactive notification ... 80

Troubleshooting 81
Troubleshooting resources 81
System battery 82
Regulatory compliance notices 83
Regulatory compliance identification numbers 83
Federal Communications Commission notice 83
FCC rating label 83
FCC Notice, Class A Equipment 83
FCC Notice, Class B Equipment 83
Declaration of conformity for products marked with the FCC logo, United States only 84
Modifications 84
Cables 84
Canadian notice (Avis Canadien) 84
European Union regulatory notice 85
Disposal of waste equipment by users in private households in the European Union 85
Japanese notice 86
BSMI notice 86
Korean notice 86
Chinese notice 87
Vietnam compliance marking notice 87
Ukraine notice 87
Laser compliance 87
Battery replacement notice 88
Taiwan battery recycling notice 88
Power cord statement for Japan 88
Acoustics statement for Germany (Geräuschemission) 89
Electrostatic discharge 90
Preventing electrostatic discharge 90
Grounding methods to prevent electrostatic discharge 90
Specifications 91
Environmental specifications 91
Server specifications 91
Hot-plug power supply calculations 91
Support and other resources 92
Before you contact HP 92
HP contact information 92
Customer Self Repair 92
Acronyms and abbreviations 100
Documentation feedback 104
Index 105

Component identification

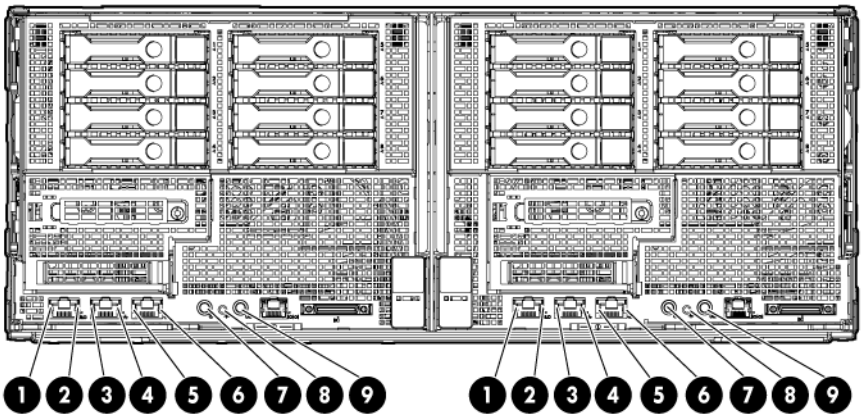
Front panel components



Item	Description
1	Hot-plug hard drive 1
2	Hot-plug hard drive 2
3	Hot-plug hard drive 3
4	Hot-plug hard drive 4
5	Hot-plug hard drive 5
6	Hot-plug hard drive 6
7	Hot-plug hard drive 7
8	Hot-plug hard drive 8
9	Option bay 2, FlexibleLOM
10	Option bay 1, PCI riser board
11	iLO 4 network port
12	NIC 2 network port
13	NIC 1 network port
14	Power On/Standby button and system power LED
15	Health LED
16	UID LED button
17	Serial port
18	SUV port

* Not shown

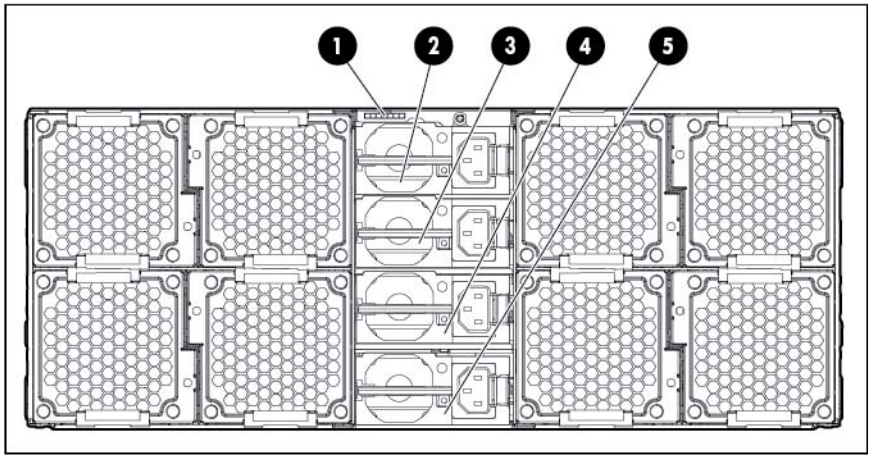
Front panel LEDs and buttons



Item	Description	Status
1	iLO 4 network speed LED	Green—LAN connection using a GbE link Amber—LAN connection using a 10 Mbps/100 Mbps link Off—No LAN connection exists.
2	iLO 4 network activity LED	Flashing green—Network data activity exists. Off—No network data activity exists, or no network connection exists.
3	NIC 2 activity LED	Flashing green—Network data activity exists. Off—No network data activity exists, or no network connection exists.
4	NIC 2 speed LED	Green—LAN connection using a GbE link Amber—LAN connection using a 10 Mbps/100 Mbps link Off—No LAN connection exists.
5	NIC 1/iLO 4 activity LED	Flashing green—Network data activity exists. Off—No network data activity exists, or no network connection exists.
6	NIC 1/iLO 4 speed LED	Green—LAN connection using a GbE link Amber—LAN connection using a 10 Mbps/100 Mbps link Off—No LAN connection exists.
7	Power On/Standby button and system power LED	Green—System on Amber—System shut down, but power still applied. Off—Power cord is not attached, or power supply has failed.
8	Health LED	Green—Normal Flashing amber—System degraded Flashing red—System critical
9	UID LED button	Blue—Activated Flashing blue—System is being remotely managed. Off—Deactivated

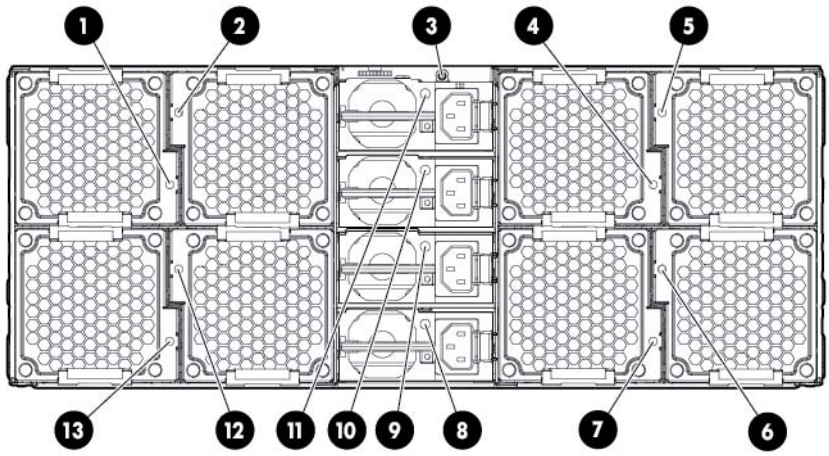
Rear panel components

The server has four power supplies, eight fans, and a single SLAPM interface located on the rear panel of the chassis.



Item	Description
1	SLAPM interface
2	Power supply 4
3	Power supply 3
4	Power supply 2
5	Power supply 1

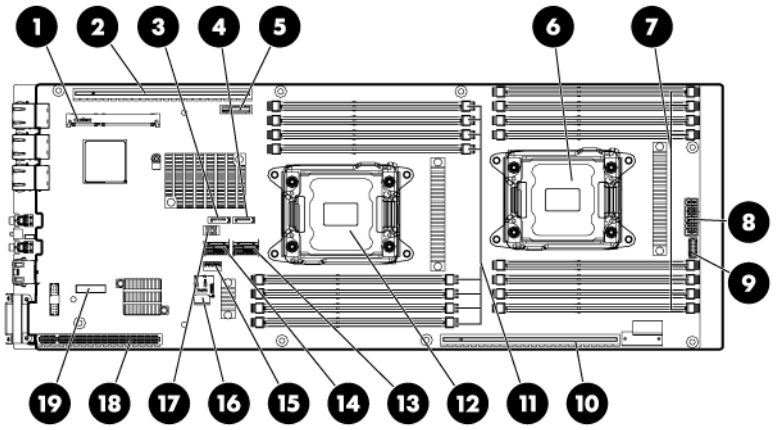
Rear panel LEDs and buttons



Item	Description	Status
1	Fan 8/16 power LED	Off—Normal Amber—Fan has failed.
2	Fan 7/15 power LED	Off—Normal Amber—Fan has failed.
3	UID LED button	Blue—Activated

Item	Description	Status
		Flashing blue—System is being remotely managed. Off—Deactivated
4	Fan 4/12 power LED	Off—Normal Amber—Fan has failed.
5	Fan 3/11 power LED	Off—Normal Amber—Fan has failed.
6	Fan 1/9 power LED	Off—Normal Amber—Fan has failed.
7	Fan 2/10 power LED	Off—Normal Amber—Fan has failed.
8	Power supply 1 power LED	Green—Normal Off—No AC power
9	Power supply 2 power LED	Green—Normal Off—No AC power
10	Power supply 3 power LED	Green—Normal Off—No AC power
11	Power supply 4 power LED	Green—Normal Off—No AC power
12	Fan 5/13 power LED	Off—Normal Amber—Fan has failed.
13	Fan 6/14 power LED	Off—Normal Amber—Fan has failed.

System board components



Item	Description
1	Cache module connector
2	x24 riser connector
3	SATA hard drive connector 1

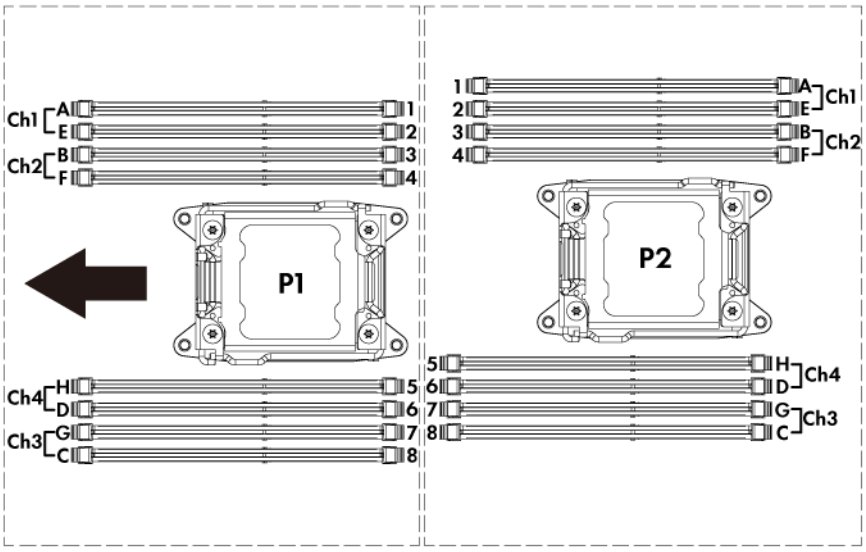
Item	Description
4	SATA hard drive connector 2
5	System battery
6	Processor socket 2
7	Processor 2 DIMM slots
8	Power connector
9	RPS connector
10	x32 riser connector
11	Processor 1 DIMM slots
12	Processor socket 1 (populated)
13	Mini-SAS hard drive connector port 2i
14	Mini-SAS hard drive connector port 1i
15	Internal USB connector
16	uSD card slot
17	Data LED connector
18	x16 FlexibleLOM slot
19	System maintenance switch

NOTE: This server supports PCIe Gen3 only in the FlexibleLOM slot. PCIe Gen2 is supported in all other slots.

DIMM slot locations

DIMM slots are numbered sequentially (1 through 8) for each processor. The supported AMP modes use the alpha assignments for population order, and the slot numbers designate the DIMM slot ID for spare replacement.

The arrow points to the front of the server.



System maintenance switch

Position	Default	Function
S1	Off	Off = iLO 4 security is enabled. On = iLO 4 security is disabled.
S2	Off	Off = System configuration can be changed. On = System configuration is locked.
S3	Off	Reserved
S4	Off	Reserved
S5	Off	Off = Power-on password is enabled. On = Power-on password is disabled.
S6	Off	Off = No function On = ROM reads system configuration as invalid.
S7	—	Reserved
S8	—	Reserved
S9	—	Reserved
S10	—	Reserved
S11	—	Reserved
S12	—	Reserved

To access redundant ROM, set S1, S5, and S6 to on.

When the system maintenance switch position 6 is set to the On position, the system is prepared to erase all system configuration settings from both CMOS and NVRAM.

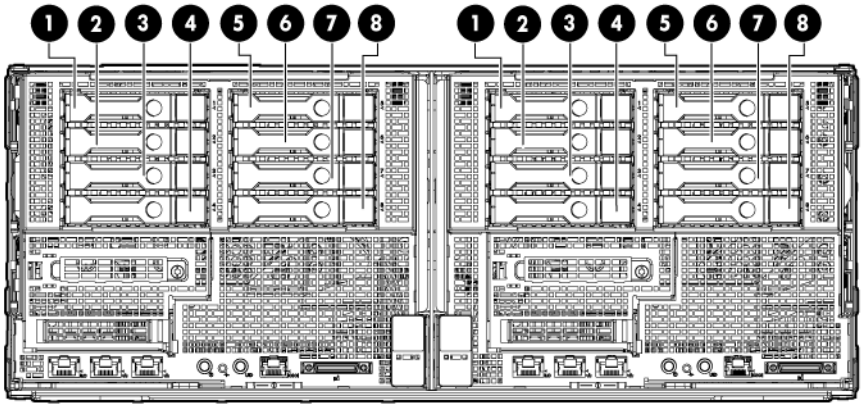
△ **CAUTION:** Clearing CMOS and/or NVRAM deletes configuration information. Be sure to properly configure the server or data loss could occur.

NMI jumper

The NMI jumper allows administrators to perform a memory dump before performing a hard reset. Crash dump analysis is an essential part of eliminating reliability problems, such as hangs or crashes in OSs, device drivers, and applications. Many crashes can freeze a system, requiring you to do a hard reset. Resetting the system erases any information that would support root cause analysis.

Systems running Microsoft® Windows® experience a blue-screen trap when the OS crashes. When this happens, Microsoft® recommends that system administrators perform an NMI event by temporarily shorting the NMI header with a jumper. The NMI event enables a hung system to become responsive again.

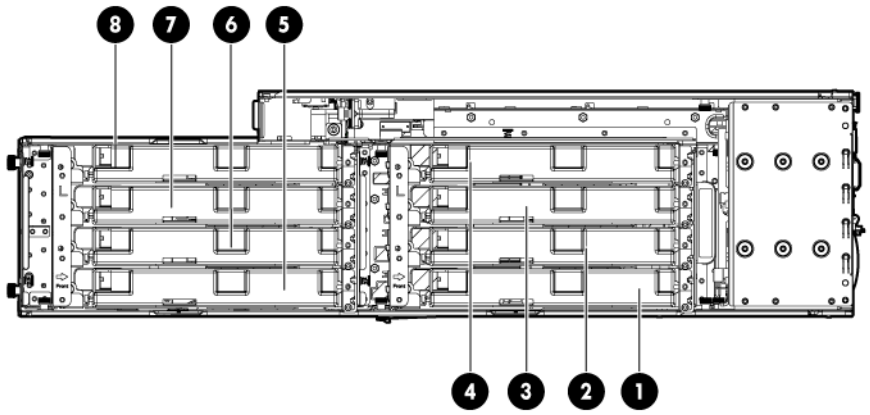
Device numbers



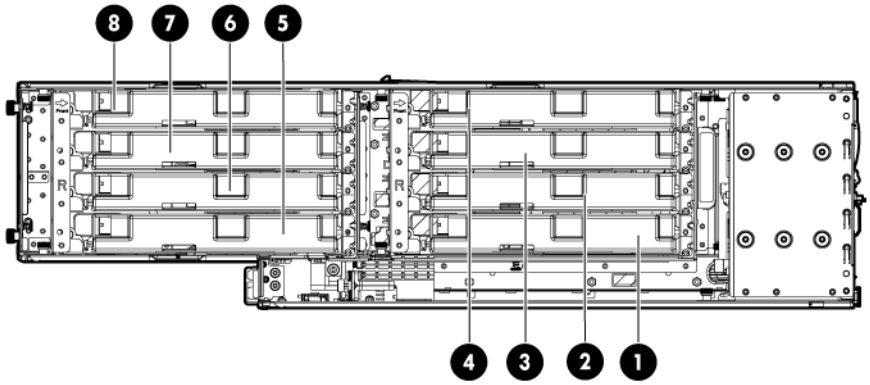
Item	Description
1	Hard drive 1
2	Hard drive 2
3	Hard drive 3
4	Hard drive 4
5	Hard drive 5
6	Hard drive 6
7	Hard drive 7
8	Hard drive 8

GPU numbering

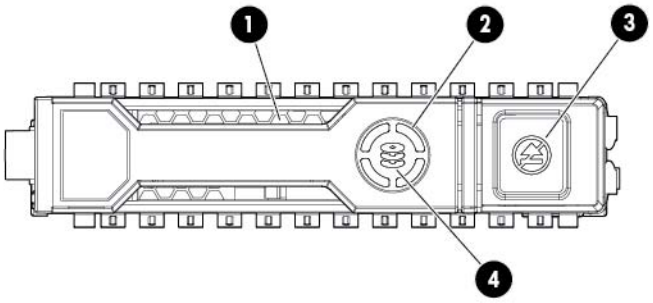
Left node



Right node



Drive LED definitions



Item	LED	Status	Definition
1	Locate	Solid blue	The drive is being identified by a host application.
		Flashing blue	The drive carrier firmware is being updated or requires an update.
2	Activity ring	Rotating green	Drive activity
		Off	No drive activity
3	Do not remove	Solid white	Do not remove the drive. Removing the drive causes one or more of the logical drives to fail.
		Off	Removing the drive does not cause a logical drive to fail.
4	Drive status	Solid green	The drive is a member of one or more logical drives.
		Flashing green	The drive is rebuilding or performing a RAID migration, stripe size migration, capacity expansion, or logical drive extension, or is erasing.
		Flashing amber/green	The drive is a member of one or more logical drives and predicts the drive will fail.
		Flashing amber	The drive is not configured and predicts the drive will fail.
		Solid amber	The drive has failed.
		Off	The drive is not configured by a RAID controller.

Operations

Power up the server

To power up the server, press the Power On/Standby button.

Power down the server

Before powering down the server for any upgrade or maintenance procedures, perform a backup of critical server data and programs.

IMPORTANT: When the server is in standby mode, auxiliary power is still being provided to the system.

To power down the server, use one of the following methods:

- Press and release the Power On/Standby button.

  This method initiates a controlled shutdown of applications and the OS before the server enters standby mode.
- Press and hold the Power On/Standby button for more than 4 seconds to force the server to enter standby mode.

  This method forces the server to enter standby mode without properly exiting applications and the OS. If an application stops responding, you can use this method to force a shutdown.
- Use a virtual power button selection through iLO 4.

  This method initiates a controlled remote shutdown of applications and the OS before the server enters standby mode.

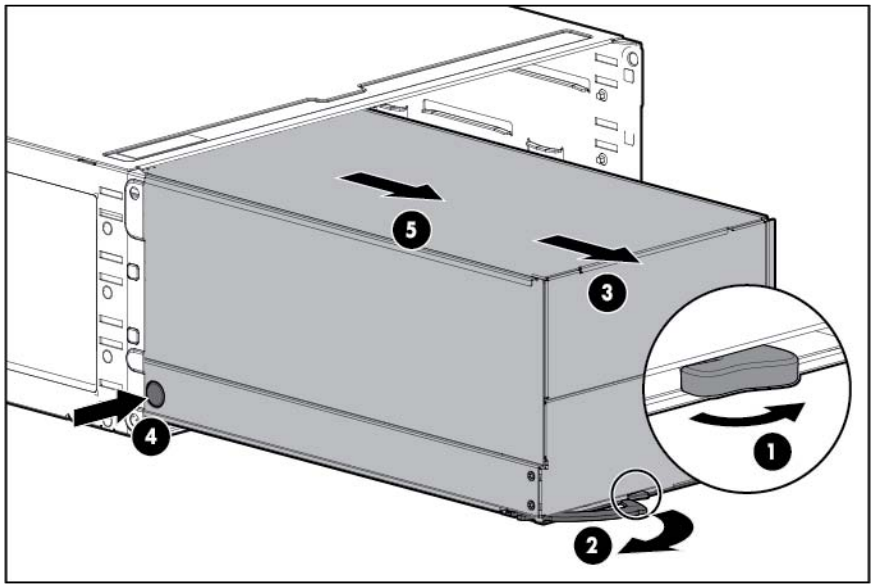
Before proceeding, verify the server is in standby mode by observing that the system power LED is amber.

Remove the server from the chassis

NOTE: If the optional cable management arm option is installed, you can extend the server without powering down the server or disconnecting peripheral cables and power cords. These steps are only necessary with the standard cable management solution.

1. Power down the server (on page 15).
2. Disconnect all peripheral cables and power cords.

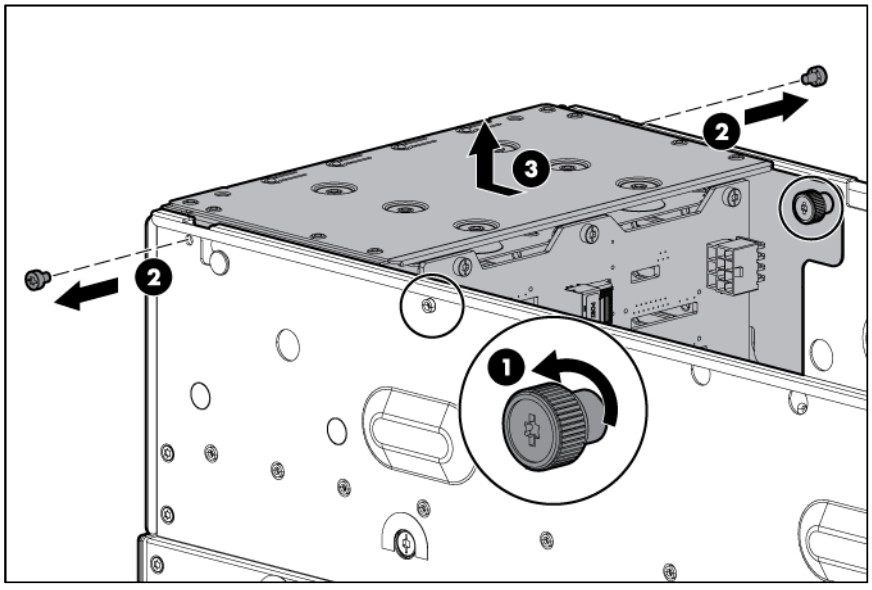
3. Remove the server from the chassis.



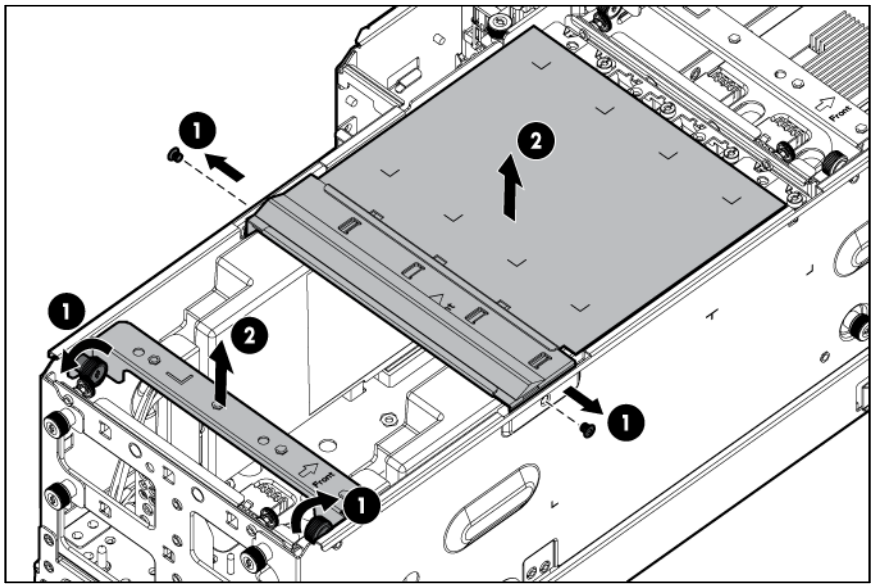
Remove the processor air baffle

To remove the component:

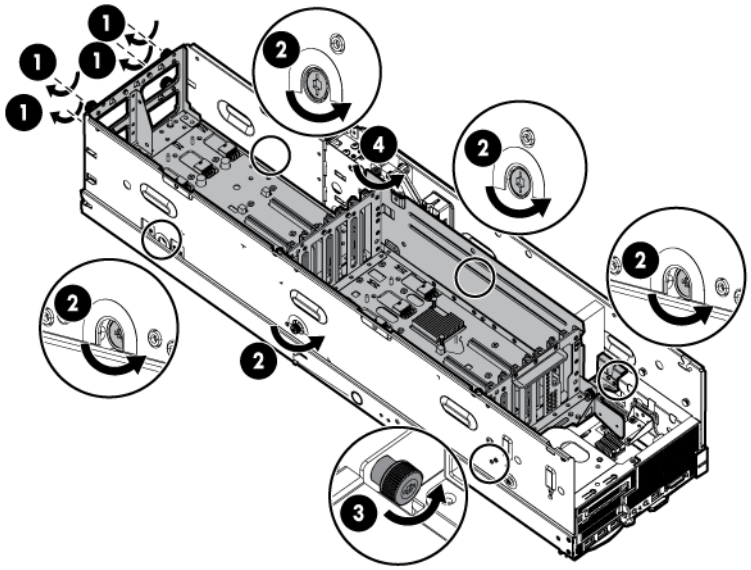
1. Power down the server (on page 15).
2. Disconnect all peripheral cables from the server.
3. Remove the server from the chassis (on page 15).
4. Remove the hard drive cage.



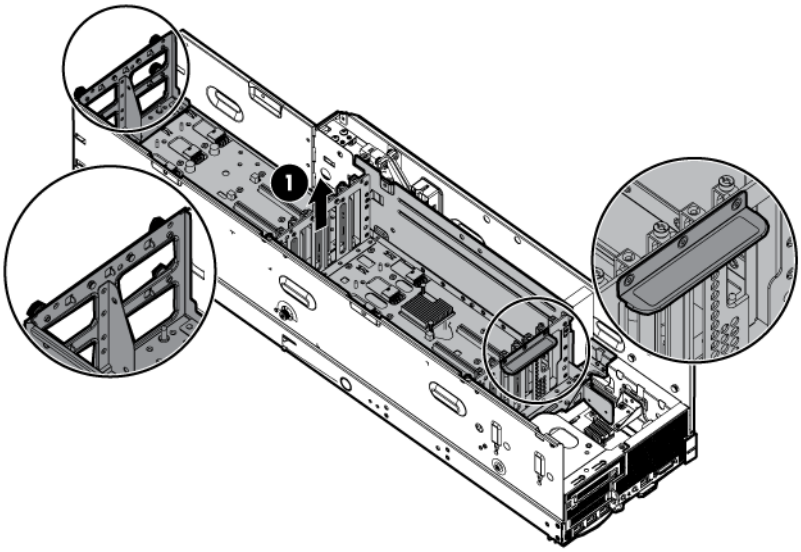
5. Remove all shipping brackets.



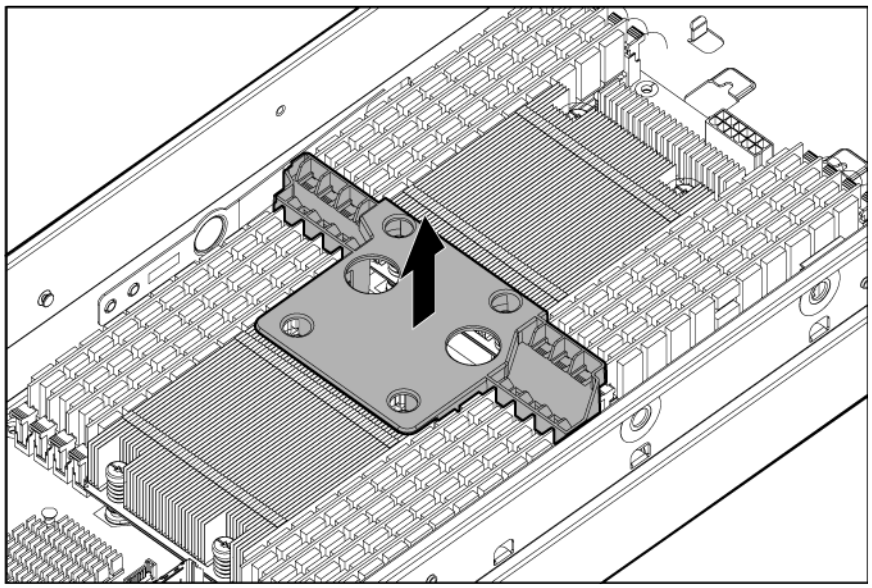
6. Loosen screws securing the GPU shelf.



7. Remove the GPU shelf.



8. Remove the air baffle ("Remove the server from the chassis" on page 15, "Remove the processor air baffle" on page 16).



To replace the component, reverse the removal procedure.

Setup

Optional installation services

Delivered by experienced, certified engineers, HP Care Pack services help you keep your servers up and running with support packages tailored specifically for HP ProLiant systems. HP Care Packs let you integrate both hardware and software support into a single package. A number of service level options are available to meet your needs.

HP Care Pack Services offer upgraded service levels to expand your standard product warranty with easy-to-buy, easy-to-use support packages that help you make the most of your server investments. Some of the Care Pack services are:

- Hardware support
  - 6-Hour Call-to-Repair
  - 4-Hour 24x7 Same Day
  - 4-Hour Same Business Day
- Software support
  - Microsoft®
  - Linux
  - HP ProLiant Essentials (HP SIM and RDP)
  - VMWare
- Integrated hardware and software support
  - Critical Service
  - Proactive 24
  - Support Plus
  - Support Plus 24
- Startup and implementation services for both hardware and software

For more information on HP Care Pack Services, see the HP website (http://www.hp.com/services/carepack).

Rack planning resources

The rack resource kit ships with all HP branded or Compaq branded 9000, 10000, and H9 series racks. For more information on the content of each resource, see the rack resource kit documentation.

Optimum environment

When installing the server in a rack, select a location that meets the environmental standards described in this section.

Space and airflow requirements

To allow for servicing and adequate airflow, observe the following space and airflow requirements when deciding where to install a rack:

- Leave a minimum clearance of 63.5 cm (25 in) in front of the rack.
- Leave a minimum clearance of 76.2 cm (30 in) behind the rack.
- Leave a minimum clearance of 121.9 cm (48 in) from the back of the rack to the back of another rack or row of racks.

HP servers draw in cool air through the front door and expel warm air through the rear door. Therefore, the front and rear rack doors must be adequately ventilated to allow ambient room air to enter the cabinet, and the rear door must be adequately ventilated to allow the warm air to escape from the cabinet.

△ **CAUTION:** To prevent improper cooling and damage to the equipment, do not block the ventilation openings.

When vertical space in the rack is not filled by a server or rack component, the gaps between the components cause changes in airflow through the rack and across the servers. Cover all gaps with blanking panels to maintain proper airflow.

△ **CAUTION:** Always use blanking panels to fill empty vertical spaces in the rack. This arrangement ensures proper airflow. Using a rack without blanking panels results in improper cooling that can lead to thermal damage.

The 9000 and 10000 Series Racks provide proper server cooling from flow-through perforations in the front and rear doors that provide 64 percent open area for ventilation.

△ **CAUTION:** When using a Compaq branded 7000 series rack, install the high airflow rack door insert (PN 327281-B21 for 42U rack, PN 157847-B21 for 22U rack) to provide proper front-to-back airflow and cooling.

△ **CAUTION:** If a third-party rack is used, observe the following additional requirements to ensure adequate airflow and to prevent damage to the equipment:

- Front and rear doors—If the 42U rack includes closing front and rear doors, you must allow 5,350 sq cm (830 sq in) of holes evenly distributed from top to bottom to permit adequate airflow (equivalent to the required 64 percent open area for ventilation).
- Side—The clearance between the installed rack component and the side panels of the rack must be a minimum of 7 cm (2.75 in).

Temperature requirements

To ensure continued safe and reliable equipment operation, install or position the system in a well-ventilated, climate-controlled environment.

The maximum recommended ambient operating temperature (TMRA) for most server products is 35°C (95°F). The temperature in the room where the rack is located must not exceed 35°C (95°F).

△ **CAUTION:** To reduce the risk of damage to the equipment when installing third-party options:

- Do not permit optional equipment to impede airflow around the server or to increase the internal rack temperature beyond the maximum allowable limits.
- Do not exceed the manufacturer's TMRA.

Power requirements

Installation of this equipment must comply with local and regional electrical regulations governing the installation of information technology equipment by licensed electricians. This equipment is designed to operate in installations covered by NFPA 70, 1999 Edition (National Electric Code) and NFPA-75, 1992 (code for Protection of Electronic Computer/Data Processing Equipment). For electrical power ratings on options, refer to the product rating label or the user documentation supplied with that option.

⚠ **WARNING:** To reduce the risk of personal injury, fire, or damage to the equipment, do not overload the AC supply branch circuit that provides power to the rack. Consult the electrical authority having jurisdiction over wiring and installation requirements of your facility.

⚠ **CAUTION:** Protect the server from power fluctuations and temporary interruptions with a regulating uninterruptible power supply. This device protects the hardware from damage caused by power surges and voltage spikes and keeps the system in operation during a power failure.

When installing more than one server, you might need to use additional power distribution devices to safely provide power to all devices. Observe the following guidelines:

- Balance the server power load between available AC supply branch circuits.
- Do not allow the overall system AC current load to exceed 80 percent of the branch circuit AC current rating.
- Do not use common power outlet strips for this equipment.
- Provide a separate electrical circuit for the server.

For more information on the hot-plug power supply and calculators to determine server power consumption in various system configurations, refer to the HP Enterprise Configurator website (http://h30099.www3.hp.com/configurator/).

Electrical grounding requirements

The server must be grounded properly for proper operation and safety. In the United States, you must install the equipment in accordance with NFPA 70, 1999 Edition (National Electric Code), Article 250, as well as any local and regional building codes. In Canada, you must install the equipment in accordance with Canadian Standards Association, CSA C22.1, Canadian Electrical Code. In all other countries, you must install the equipment in accordance with any regional or national electrical wiring codes, such as the International Electrotechnical Commission (IEC) Code 364, parts 1 through 7. Furthermore, you must be sure that all power distribution devices used in the installation, such as branch wiring and receptacles, are listed or certified grounding-type devices.

Because of the high ground-leakage currents associated with multiple servers connected to the same power source, HP recommends the use of a PDU that is either permanently wired to the building's branch circuit or includes a nondetachable cord that is wired to an industrial-style plug. NEMA locking-style plugs or those complying with IEC 60309 are considered suitable for this purpose. Using common power outlet strips for the server is not recommended.

Rack warnings

⚠ **WARNING:** To reduce the risk of personal injury or damage to the equipment, be sure that:

- The leveling jacks are extended to the floor.
- The full weight of the rack rests on the leveling jacks.
- The stabilizing feet are attached to the rack if it is a single-rack installation.
- The racks are coupled together in multiple-rack installations.
- Only one component is extended at a time. A rack may become unstable if more than one component is extended for any reason.

⚠ **WARNING:** To reduce the risk of personal injury or equipment damage when unloading a rack:

- At least two people are needed to safely unload the rack from the pallet. An empty 42U rack can weigh as much as 115 kg (253 lb), can stand more than 2.1 m (7 ft) tall, and might become unstable when being moved on its casters.
- Never stand in front of the rack when it is rolling down the ramp from the pallet. Always handle the rack from both sides.

Contents of the server shipping carton

Unpack the server shipping carton and locate the materials and documentation necessary for installing the server. All the rack mounting hardware necessary for installing the server into the rack is included with the rack or the server.

The contents of the server shipping carton include:

- Server
- Power cord
- Printed setup documentation, Documentation CD, and software products
- Rack mounting hardware kit and documentation

In addition to these supplied items, you might need:

- T-10/T-15 Torx screwdriver
- Hardware options
- Operating system or application software

Installing the chassis

The chassis can be installed either in a rack or rack-free environment. For rack installations, install the rack rails, and then install the chassis and other components.

For more information, see the *HP ProLiant s6500 Chassis Setup and Installation Guide*, *Quick Deploy Rail System Installation Instructions* that ship with the rack hardware kit, and applicable installation instructions.

Installing options

Install any hardware options before initializing the server. For options installation information, see the documentation that ships with the option. For server-specific information, see the server user guide on the HP website (http://www.hp.com).

Installing components

WARNING: The server is very heavy. To reduce the risk of personal injury or damage to the equipment:

- Reduce the weight of the server by removing the hard drives and power supplies before installing the server into the rack.
- Get help to lift and stabilize the server during installation. When the server weighs more than 22.5 kg (50 lb), two people might be required to install the server into the rack.

CAUTION: Always plan the rack installation so that the heaviest item is on the bottom of the rack. Install the heaviest item first, and continue to populate the rack from the bottom to the top.

Before installing front or rear components into the chassis, review chassis bay numbering for each component. For slot numbering information, see the quick setup instructions.

Based on the total number ordered and the planned configuration, install the following components:

- Nodes
- Power supplies
- System fans

For more information, see the appropriate chassis setup and installation guide and the node installation instructions.

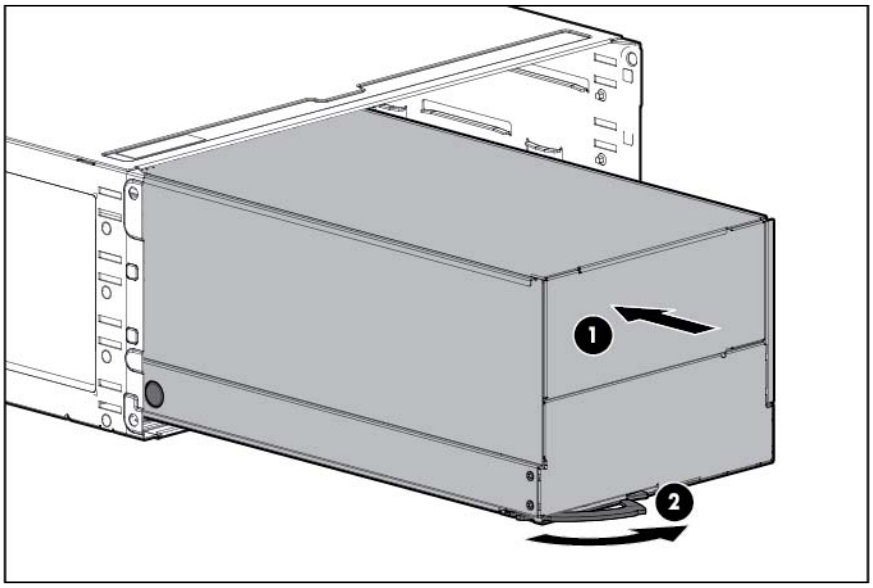
Installing the server into the chassis

WARNING: This server is very heavy. To reduce the risk of personal injury or damage to the equipment:

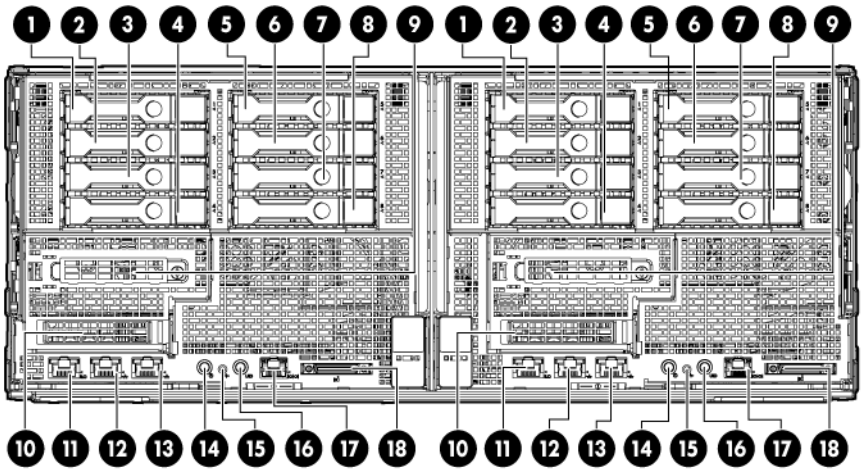
- Observe local occupational health and safety requirements and guidelines for manual material handling.
- Get help to lift and stabilize the product during installation or removal, especially when the product is not fastened to the rails. HP recommends that a minimum of two people are required for all rack server installations. A third person may be required to help align the server if the server is installed higher than chest level.
- Use caution when installing the server in or removing the server from the rack; it is unstable when not fastened to the rails.

1. Insert the system tray into the chassis.

2. Rotate the tray handle to lock.



3. Connect peripheral devices to the server.



Item	Description
1	Hot-plug hard drive 1
2	Hot-plug hard drive 2
3	Hot-plug hard drive 3
4	Hot-plug hard drive 4
5	Hot-plug hard drive 5
6	Hot-plug hard drive 6
7	Hot-plug hard drive 7
8	Hot-plug hard drive 8
9	Option bay 2, FlexibleLOM
10	Option bay 1, PCI riser board
11	iLO 4 network port

Item	Description
12	NIC 2 network port
13	NIC 1 network port
14	Power On/Standby button and system power LED
15	Health LED
16	UID LED button
17	Serial port
18	SUV port

* Not shown

⚠ **WARNING:** To reduce the risk of electric shock, fire, or damage to the equipment, do not plug telephone or telecommunications connectors into RJ-45 connectors.

4. Connect the power cords to the power supplies.
5. Connect the power cord to the AC power source.

⚠ **WARNING:** To reduce the risk of electric shock or damage to the equipment:

- Do not disable the power cord grounding plug. The grounding plug is an important safety feature.
- Plug the power cord into a grounded (earthed) electrical outlet that is easily accessible at all times.
- Unplug the power cord from the power supply to disconnect power to the equipment.
- Do not route the power cord where it can be walked on or pinched by items placed against it. Pay particular attention to the plug, electrical outlet, and the point where the cord extends from the server.

Powering up the chassis

Connect the AC or DC power cables, depending on the power configuration.

When the circuit breakers are powered, the chassis and HP ProLiant SL Advanced Power Manager have power. By default, each installed component also powers up. Examine the HP ProLiant SL Advanced Power Manager for any errors which may prevent installed components from powering up.

Configuring the chassis

For further information on setting up and configuring your system, see the *HP ProLiant s6500 Chassis Quick Setup Instructions* and the *HP ProLiant s6500 Chassis Setup and Installation Guide*.

Powering on and selecting boot options

1. Connect the Ethernet cable and press the Power On/Standby button.
2. During the initial boot:
   - To modify the server configuration ROM default settings, press **F9** when prompted from the start up sequence to enter the RBSU. By default, RBSU runs in the English language.
   - If you do not need to modify the server configuration and are ready to install the system software, press **F10** to access Intelligent Provisioning.

NOTE: If an HP Smart Array controller has been added or is embedded in the system, the controller defaults to a RAID configuration based on the size and number of hard drives installed. For more information on modifying the controller default settings, see the documentation on the Documentation CD.

For more information on automatic configuration, see the *HP ROM-Based Setup Utility User Guide* on the Documentation CD or the iLO Management Engine Information Library (http://www.hp.com/go/ilomgmtengine/docs).

Installing the system software

To install an operating system on a single server using Intelligent Provisioning:

1. If needed, access Intelligent Provisioning by rebooting the server and pressing **F10**.
2. In the application, complete step 1, Set Intelligent Provisioning preferences.
3. From the Home screen, click **Perform Maintenance**, and then click **Firmware Update**.
4. Ensure the latest drivers are available for installation. Select **Intelligent Provisioning Software** from the list of firmware and click **Update**. If the check box is not selected, the latest drivers are already installed.
5. From the Home screen, click **Configure and Install**.
6. Follow the on-screen prompts to finish the installation.

To update your drivers and system software:

Intelligent Provisioning automatically integrates optimized ProLiant server support software from the HP SPP. SPP is the installation package for operating system-specific bundles of ProLiant optimized drivers, utilities, management agents, and system firmware. For more information on using SPP, see the *HP Service Pack for ProLiant User Guide* on the Documentation CD or the SPP Information Library (http://www.hp.com/go/spp/documentation).

The Smart Update Firmware DVD ISO image is also available at the download tab on the HP website (http://www.hp.com/go/foundation).

Registering the server

To register the server, refer to the HP Registration website (http://register.hp.com).

Hardware options installation

Introduction

If more than one option is being installed, read the installation instructions for all the hardware options and identify similar steps to streamline the installation process.

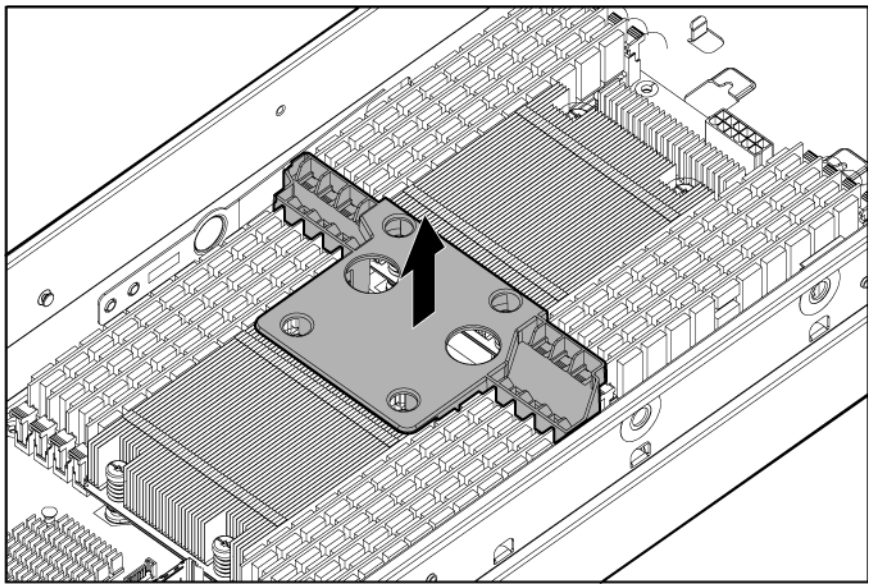
⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

⚠ **CAUTION:** To prevent damage to electrical components, properly ground the server before beginning any installation procedure. Improper grounding can cause electrostatic discharge.

Processor option

1. Update the system ROM.

   Locate and download the latest ROM version from the HP website (http://www.hp.com/support). Follow the instructions on the website to update the system ROM.
2. Power down the server (on page 15).
3. Remove the server from the chassis (on page 15).
4. Place the server on a flat, level work surface.
5. Remove any necessary components to obtain access to the system board. For procedures to remove server components, see the maintenance and service guide.
6. Remove the air baffle ("Remove the server from the chassis" on page 15, "Remove the processor air baffle" on page 16).



WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

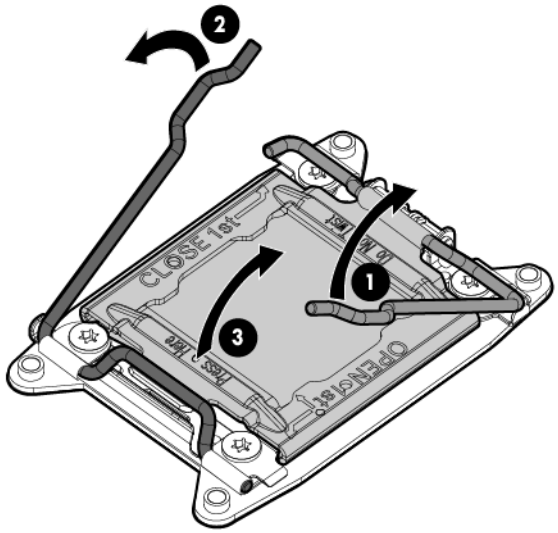
CAUTION: To prevent possible server malfunction and damage to the equipment, multiprocessor configurations must contain processors with the same part number.

CAUTION: The heatsink thermal interface media is not reusable and must be replaced if the heatsink is removed from the processor after it has been installed.

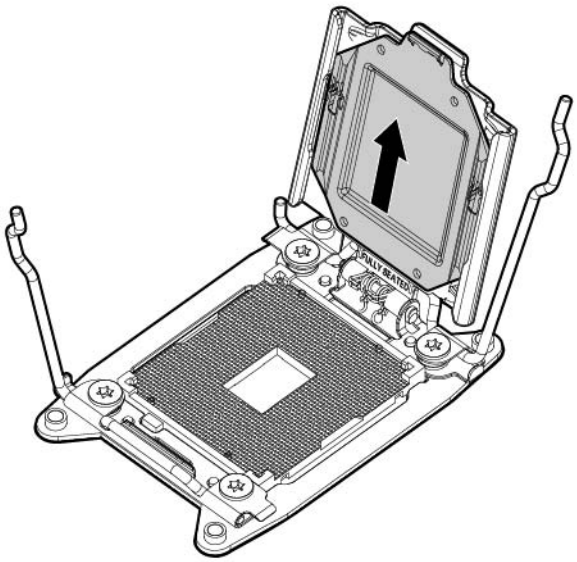
CAUTION: To prevent possible server overheating, always populate processor socket 2 with a processor and a heatsink or a processor socket cover and a heatsink blank.

IMPORTANT: Processor socket 1 must be populated at all times or the server does not function.

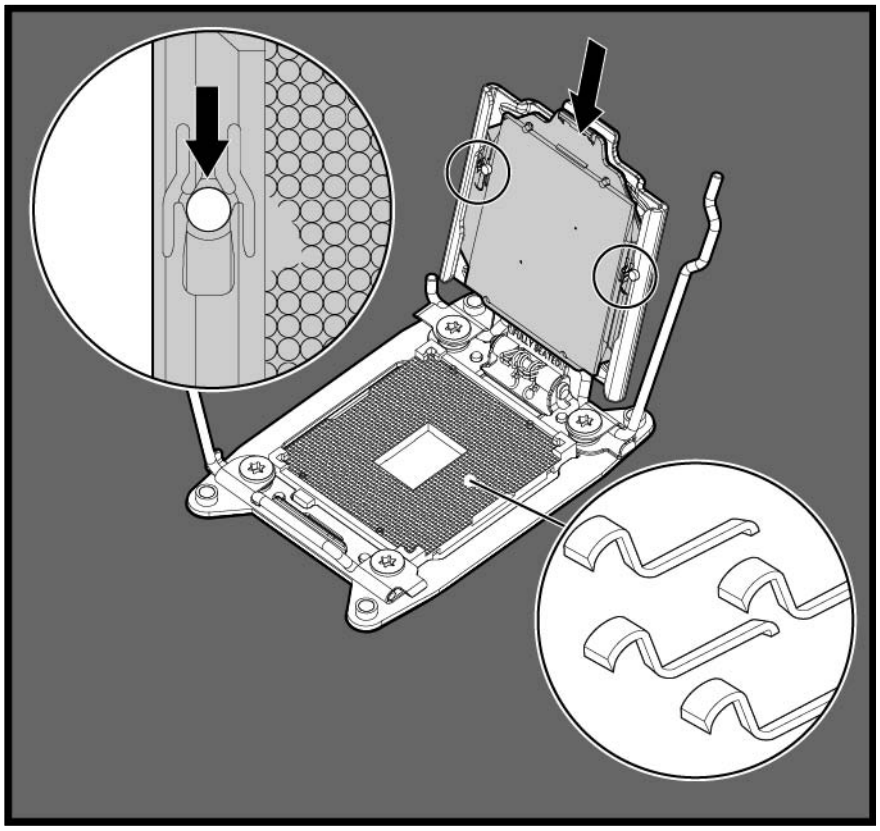
7. Open each of the processor locking levers in the order indicated, and then open the processor retaining bracket.



8. Remove the clear processor socket cover. Retain the processor socket cover for future use.



9. Install the processor. Verify that the processor is fully seated in the processor retaining bracket by visually inspecting the processor installation guides on either side of the processor. **THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.**

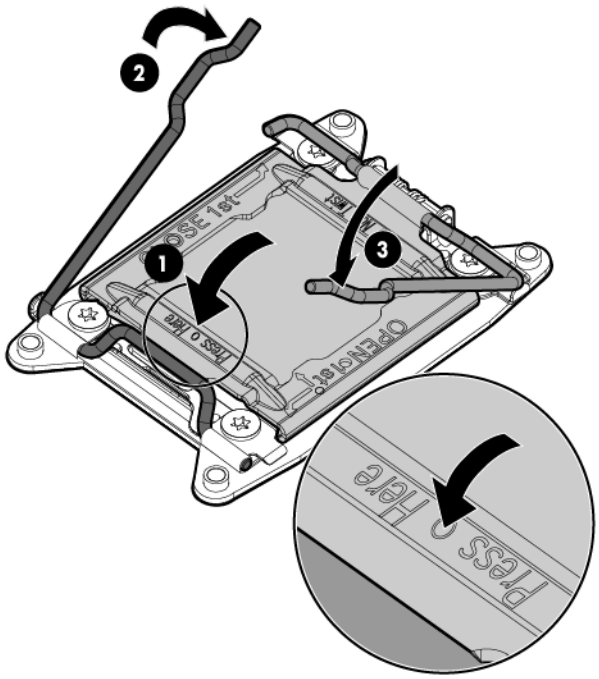


△ **CAUTION: THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.** To avoid damage to the system board, do not touch the processor or the processor socket contacts.

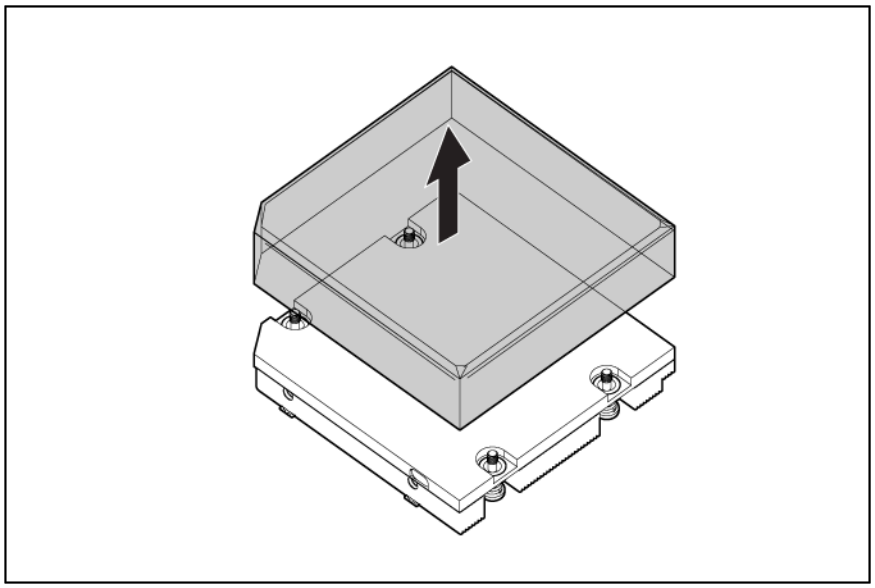
10. Close the processor retaining bracket. When the processor is installed properly inside the processor retaining bracket, the processor retaining bracket clears the flange on the front of the socket.

CAUTION: Do not press down on the processor. Pressing down on the processor may cause damage to the processor socket and the system board. Press only in the area indicated on the processor retaining bracket.

11. Press and hold the processor retaining bracket in place, and then close each processor locking lever. Press only in the area indicated on the processor retaining bracket.

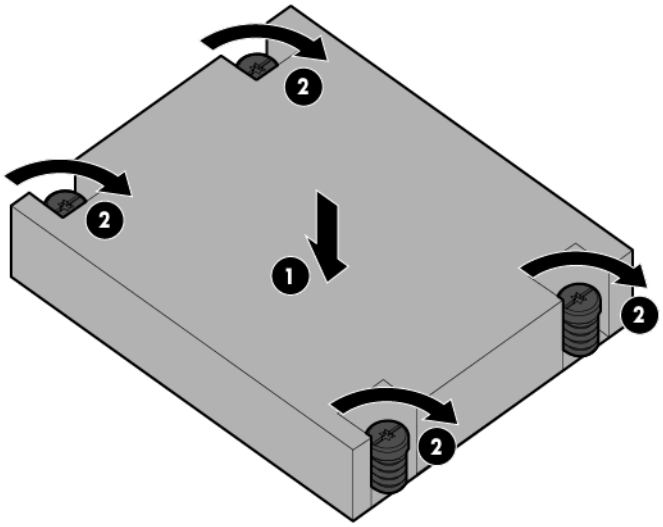


12. Remove the thermal interface protective cover from the heatsink.



CAUTION: Heatsink retaining screws should be tightened in diagonally opposite pairs (in an "X" pattern).

13. Install the heatsink.



14. Install the air baffle.
15. Install the server into the chassis.
16. Power up the server.

Memory options

IMPORTANT: This server does not support mixing LRDIMMs, RDIMMs, or UDIMMs. Attempting to mix any combination of these DIMMs can cause the server to halt during BIOS initialization.

The memory subsystem in this server can support LRDIMMs, RDIMMs, or UDIMMs. All three types are referred to as DIMMs when the information applies to all three types. When specified as LRDIMM, RDIMM, or UDIMM, the information applies to that type only. All memory installed in the server must be the same type.

The server supports the following DIMM speeds:

- Single-rank and dual-rank PC3-12800 (DDR-1600) DIMMs operating at 1600, 1333, and 1066 MHz
- Single-rank and dual-rank PC3-10600 (DDR-1333) DIMMs operating at 1333 and 1066 MHz
- Quad-rank PC3-10600 (DDR-1333) LRDIMMs operating at 1333 and 1066 MHz

Depending on the processor model, the number of DIMMs installed, and whether LRDIMMs, UDIMMs, or RDIMMs are installed, the memory clock speed might be reduced to 1333, 1066 or 800 MHz. For more information on the effect of DIMM slot population, see "General DIMM slot population guidelines (on page 35)."

HP SmartMemory

HP SmartMemory, introduced for Gen8 servers, authenticates and unlocks certain features available only on HP Qualified memory and verifies whether installed memory has passed HP qualification and test processes. Qualified memory is performance-tuned for HP ProLiant and BladeSystem servers and provides future enhanced support through HP Active Health and manageability software.

Certain performance features are unique with HP SmartMemory. HP SmartMemory 1.35V DDR3-1333 Registered memory is engineered to achieve the same performance level as 1.5V memory. For example, while the industry supports DDR3-1333 RDIMM at 1.5V, this Gen8 server supports DDR3-1333 RDIMM at 1.35V. This difference equates to up to 20% less power at the DIMM level with no performance penalty.

Memory subsystem architecture

The memory subsystem in this server is divided into channels. Each processor supports four channels, and each channel supports two DIMM slots, as shown in the following table.

Channel	Slot	Slot number
1	A E	1 2
2	B F	3 4
3	C G	8 7
4	D H	6 5

For the location of the slot numbers, see "DIMM slot locations."

This multi-channel architecture provides enhanced performance in Advanced ECC mode. This architecture also enables the Lockstep memory mode.

DIMM slots in this server are identified by number and by letter. Letters identify the population order. Slot numbers indicate the DIMM slot ID for spare replacement.

Single-, dual-, and quad-rank DIMMs

To understand and configure memory protection modes properly, an understanding of single-, dual-, and quad-rank DIMMs is helpful. Some DIMM configuration requirements are based on these classifications.

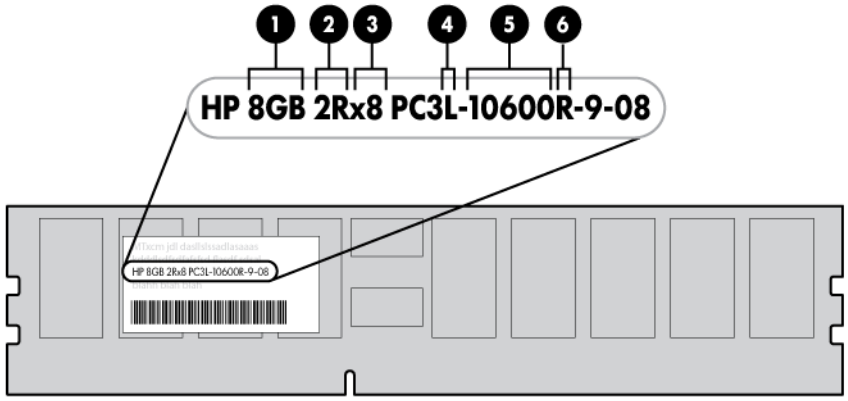
A single-rank DIMM has one set of memory chips that is accessed while writing to or reading from the memory. A dual-rank DIMM is similar to having two single-rank DIMMs on the same module, with only one rank accessible at a time. A quad-rank DIMM is, effectively, two dual-rank DIMMs on the same module. Only one rank is accessible at a time. The server memory control subsystem selects the proper rank within the DIMM when writing to or reading from the DIMM.

Dual- and quad-rank DIMMs provide the greatest capacity with the existing memory technology. For example, if current DRAM technology supports 8-GB single-rank DIMMs, a dual-rank DIMM would be 16 GB, and a quad-rank DIMM would be 32 GB.

LRDIMMs are labeled as quad-rank DIMMs; however, they function more like dual-rank DIMMs. There are four ranks of DRAM on the DIMM, but the LRDIMM buffer creates an abstraction that allows the DIMM to appear as a dual-rank DIMM to the system. The LRDIMM buffer also isolates the electrical loading of the DRAM from the system to allow for faster operation. These two changes allow the system to support up to three LRDIMMs per memory channel, providing for up to 50% greater memory capacity and higher memory operating speed compared to quad-rank RDIMMs.

DIMM identification

To determine DIMM characteristics, use the label attached to the DIMM and the following illustration and table.



Item	Description	Definition
1	Size	—
2	Rank	1R = Single-rank 2R = Dual-rank 4R = Quad-rank
3	Data width	x4 = 4-bit x8 = 8-bit
4	Voltage rating	L = Low voltage (1.35v) U = Ultra low voltage (1.25v) Blank or omitted = Standard
5	Memory speed	12800 = 1600-MT/s 10600 = 1333-MT/s 8500 = 1066-MT/s
6	DIMM type	R = RDIMM (registered) E = UDIMM (unbuffered with ECC) L = LRDIMM (load reduced)

For the latest supported memory information, see the QuickSpecs on the HP website (http://h18000.www1.hp.com/products/quickspecs/ProductBulletin.html). At the website, choose the geographic region, and then locate the product by name or product category.

Memory configurations

To optimize server availability, the server supports the following AMP modes:

- Advanced ECC—Provides up to 4-bit error correction and enhanced performance over Lockstep mode. This mode is the default option for this server.
- Online spare memory—Provides protection against failing or degraded DIMMs. Certain memory is reserved as spare, and automatic failover to spare memory occurs when the system detects a DIMM that

is degrading. This configuration enables DIMMs that have a higher probability of receiving an uncorrectable memory error (resulting in system downtime) to be removed from operation.

Advanced Memory Protection options are configured in RBSU. If the requested AMP mode is not supported by the installed DIMM configuration, the server boots in Advanced ECC mode. For more information, see "HP ROM-Based Setup Utility (on page 73)."

The server also can operate in independent channel mode or combined channel mode (lockstep). When running in lockstep mode, you gain reliability in one of two ways:

- If running with UDIMMs (built with x8 DRAM devices), the system can survive a complete DRAM failure (SDDC). In independent channel mode, this failure would be an uncorrectable error.
- If running with RDIMM (built with x4 DRAM devices), the system can survive the complete failure of two DRAM devices (DDDC). Running in independent mode, the server can only survive the complete failure of a single DRAM device (SDDC).

Maximum capacity

DIMM type	DIMM rank	One processor	Two processors
RDIMM	Single-rank	64GB	128 GB
RDIMM	Dual-rank	128 GB	256 GB
UDIMM	Single-rank	32 GB	64 GB
UDIMM	Dual-rank	64 GB	128GB

For the latest memory configuration information, see the QuickSpecs on the HP website (http://www.hp.com).

Maximum memory configurations

The server supports a maximum of 256 GB of memory with one processor (8 x 32 GB), or 512 GB of memory with two processors (16 x 32 GB).

Advanced ECC memory configuration

Advanced ECC memory is the default memory protection mode for this server. Standard ECC can correct single-bit memory errors and detect multi-bit memory errors. When multi-bit errors are detected using Standard ECC, the error is signaled to the server and causes the server to halt.

Advanced ECC protects the server against some multi-bit memory errors. Advanced ECC can correct both single-bit memory errors and 4-bit memory errors if all failed bits are on the same DRAM device on the DIMM.

Advanced ECC provides additional protection over Standard ECC because it is possible to correct certain memory errors that would otherwise be uncorrected and result in a server failure. Using HP Advanced Memory Error Detection technology, the server provides notification when a DIMM is degrading and has a higher probability of uncorrectable memory error.

Online Spare memory configuration

Online spare memory provides protection against degraded DIMMs by reducing the likelihood of uncorrected memory errors. This protection is available without any operating system support.

Online spare memory protection dedicates one rank of each memory channel for use as spare memory. The remaining ranks are available for OS and application use. If correctable memory errors occur at a rate higher than a specific threshold on any of the non-spare ranks, the server automatically copies the memory

contents of the degraded rank to the online spare rank. The server then deactivates the failing rank and automatically switches over to the online spare rank.

Lockstep memory configuration

Lockstep mode provides protection against multi-bit memory errors that occur on the same DRAM device. Lockstep mode can correct any single DRAM device failure on x4 and x8 DIMM types. The DIMMs in each channel must have identical HP part numbers.

General DIMM slot population guidelines

Observe the following guidelines for all AMP modes:

- Install DIMMs only if the corresponding processor is installed.
- When two processors are installed, balance the DIMMs across the two processors.
- White DIMM slots denote the first slot of a channel (Ch 1-A, Ch 2-B, Ch 3-C, Ch 4-D)
- Do not mix RDIMMs, UDIMMs, or LRDIMMs.
- When one processor is installed, install DIMMs in sequential alphabetic order: A, B, C, D, E, F, and so forth.
- When two processors are installed, install the DIMMs in sequential alphabetic order balanced between the two processors: P1-A, P2-A, P1-B, P2-B, P1-C, P2-C, and so forth.
- For DIMM spare replacement, install the DIMMs per slot number as instructed by the system software.

For detailed memory configuration rules and guidelines, use the Online DDR3 Memory Configuration Tool on the HP website (http://www.hp.com/go/ddr3memory-configurator).

DIMM speeds are supported as indicated in the following table.

Populated slots (per channel)	Rank	Speeds supported (MHz)
1	Single- or dual-rank	1066, 1333, 1600
1	Quad-rank	1066, 1333
2	Single- or dual-rank	1066, 1333, 1600
2	Quad-rank	1066, 1333

Advanced ECC population guidelines

For Advanced ECC mode configurations, observe the following guidelines:

- Observe the general DIMM slot population guidelines (on page 35).
- DIMMs may be installed individually.

Online spare population

For Online Spare memory mode configurations, observe the following guidelines:

- Observe the general DIMM slot population guidelines (on page 35).
- Each channel must have a valid online spare configuration.
- Each channel can have a different valid online spare configuration.

- Each populated channel must have a spare rank:
  - A single dual-rank DIMM is not a valid configuration.
  - LRDIMMs are treated as dual-rank DIMMs.

Lockstep Memory population guidelines

For Lockstep memory mode configurations, observe the following guidelines:

- Observe the general DIMM slot population guidelines (on page 35).
- DIMM configuration on all channels of a processor must be identical.
- In multi-processor configurations, each processor must have a valid Lockstep Memory configuration.
- In multi-processor configurations, each processor may have a different valid Lockstep Memory configuration.

Population order

For memory configurations with a single processor or multiple processors, populate the DIMM slots in the following order:

- LRDIMM: Sequentially in alphabetical order (A through H)
- RDIMM: Sequentially in alphabetical order (A through H)
- UDIMM: A through H, sequentially in alphabetical order

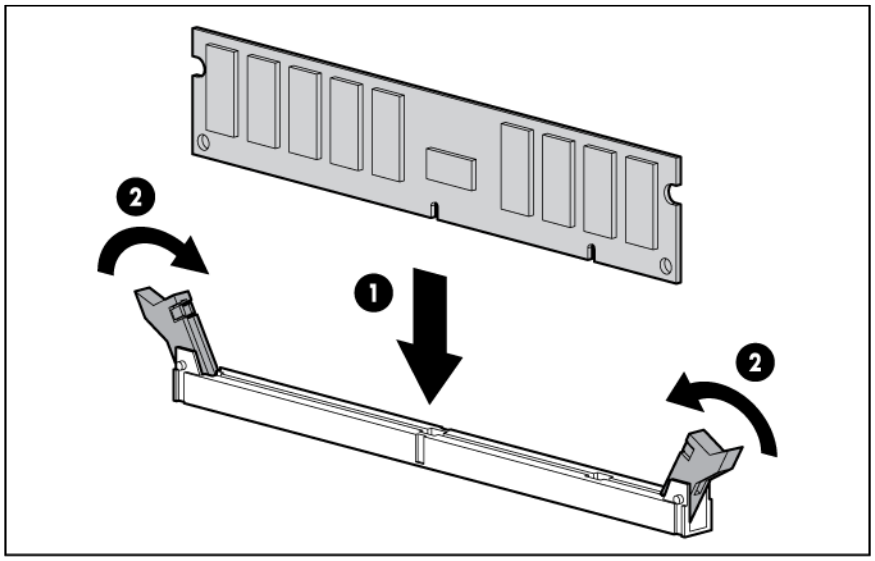
After installing the DIMMs, use RBSU to configure Advanced ECC, online spare, or lockstep memory support.

Installing a DIMM

△ **CAUTION:** To avoid damage to the hard drives, memory, and other system components, the air baffle, and drive blanks must be installed when the server is powered up.

1. Power down the server (on page 15).
2. Remove the server from the chassis (on page 15).
3. If installed, remove the FBWC capacitor pack ("Installing the FBWC capacitor pack" on page 42).
4. Remove the processor air baffle.
5. Open the DIMM slot latches.

6. Install the DIMM.



7. Install the processor air baffle.
8. If removed, install the FBWC capacitor pack.
9. Install the server into the chassis ("Installing the server into the chassis" on page 23).
10. Power up the server (on page 15).

If you are installing DIMMs in online spare, mirrored, or lock-step configuration, configure this mode in RBSU ("HP ROM-Based Setup Utility" on page 73).

For more information about LEDs and troubleshooting failed DIMMs, see "Systems Insight Display LED combinations."

Hot-plug hard drive guidelines

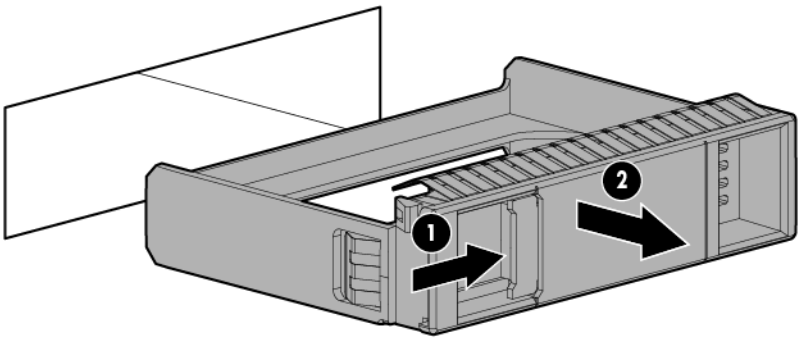
When adding hard drives to the server, observe the following general guidelines:

- The system automatically sets all device numbers.
- If only one hard drive is used, install it in the bay with the lowest device number.
- Drives should be the same capacity to provide the greatest storage space efficiency when drives are grouped together into the same drive array.

⚠ **WARNING:** To reduce the risk of injury from electric shock, do not remove more than one drive carrier at a time.

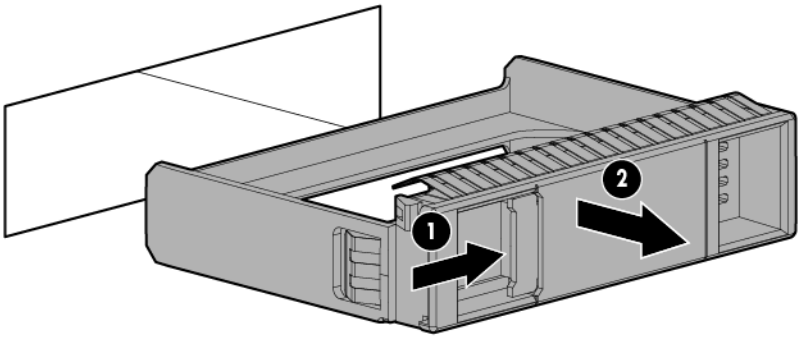
Removing the hard drive blank

Remove the component as indicated.

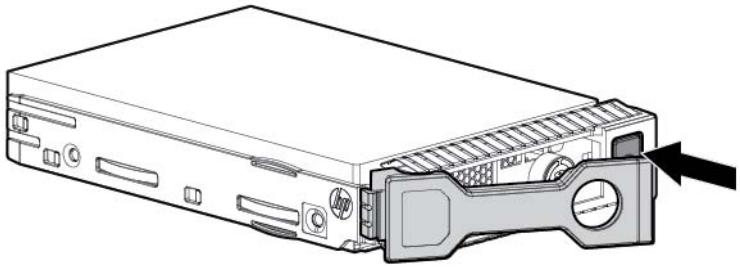


Installing a hot-plug SAS hard drive

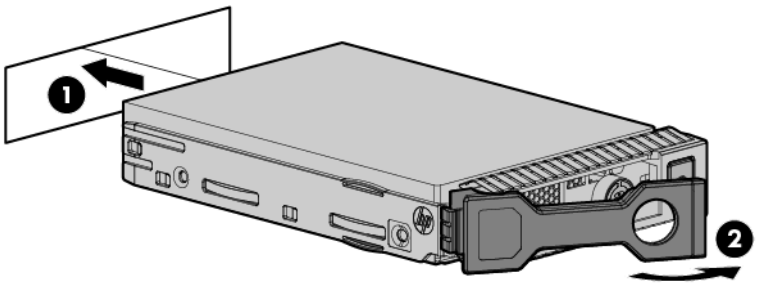
1. Remove the drive blank.



2. Prepare the drive.



3. Install the drive.



4. Determine the status of the drive from the drive LED definitions (on page 14).

Controller options

The server ships with HP Smart Array P220i Controller. For more information about the controller and its features, see the *HP Smart Array Controllers for HP ProLiant Servers User Guide* on the HP website (http://www.hp.com/support/SAC_UG_ProLiantServers_en). To configure arrays, see the *Configuring Arrays on HP Smart Array Controllers Reference Guide* on the HP website (http://www.hp.com/support/CASAC_RG_en).

Upgrade options exist for the integrated array controller. For a list of supported options, see the QuickSpecs on the HP website (http://www.hp.com/support).

The server supports FBWC. FBWC consists of a cache module and a capacitor pack. The DDR cache module buffers and stores data being written by the controller. When the system is powered on, the capacitor pack charges fully in about 5 minutes. In the event of a system power failure, a fully charged capacitor pack provides power for up to 80 seconds. During that interval, the controller transfers the cached data from DDR memory to flash memory, where the data remains indefinitely or until a controller retrieves the data.

△ **CAUTION:** The cache module connector does not use the industry-standard DDR3 mini-DIMM pinout. Do not use this controller with cache modules designed for other controller models, because the controller can malfunction and you can lose data. Also, do not transfer this cache module to an unsupported controller model, because you can lose data.

△ **CAUTION:** To prevent a server malfunction or damage to the equipment, do not add or remove the battery pack while an array capacity expansion, RAID level migration, or stripe size migration is in progress.

△ **CAUTION:** After the server is powered down, wait 15 seconds and then check the amber LED before unplugging the cable from the cache module. If the amber LED blinks after 15 seconds, do not remove the cable from the cache module. The cache module is backing up data, and data is lost if the cable is detached.

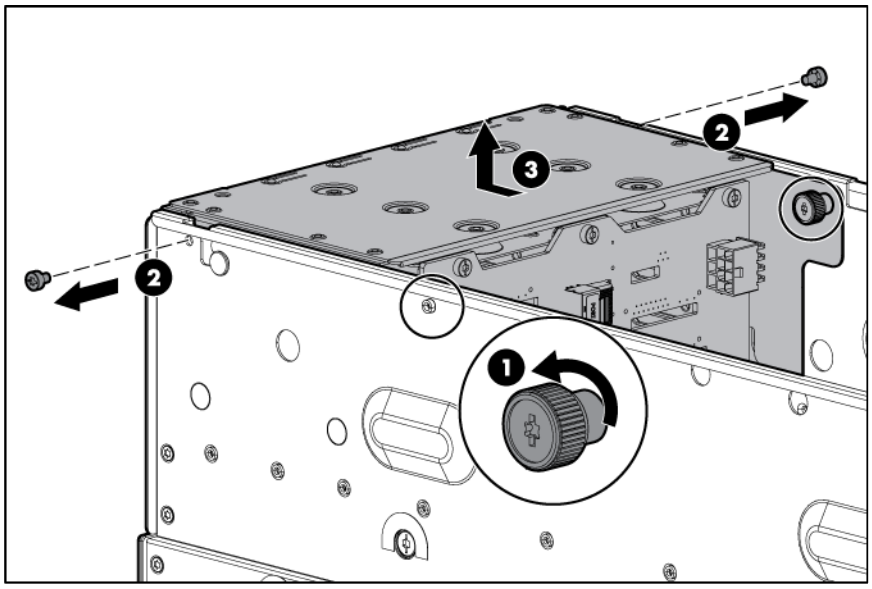
IMPORTANT: The battery pack might have a low charge when installed. In this case, a POST error message is displayed when the server is powered up, indicating that the battery pack is temporarily disabled. No action is necessary on your part. The internal circuitry automatically recharges the batteries and enables the battery pack. This process might take up to four hours. During this time, the cache module functions properly, but without the performance advantage of the battery pack.

NOTE: The data protection and the time limit also apply if a power outage occurs. When power is restored to the system, an initialization process writes the preserved data to the hard drives.

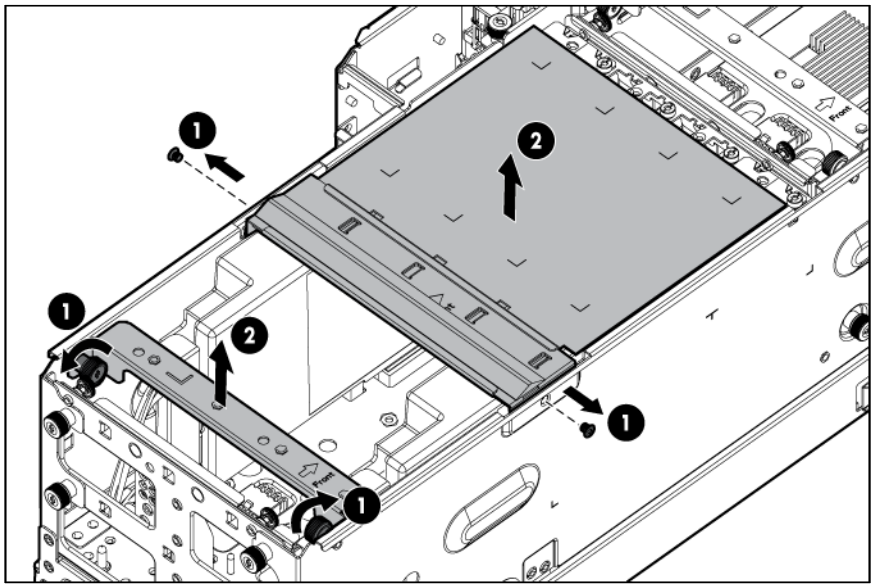
Installing the cache module

CAUTION: In systems that use external data storage, be sure that the server is the first unit to be powered down and the last to be powered back up. Taking this precaution ensures that the system does not erroneously mark the drives as failed when the server is powered up.

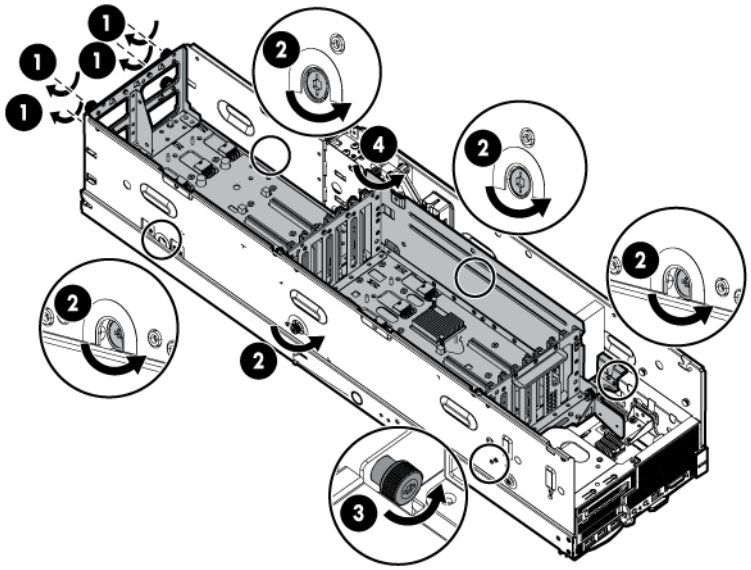
1. Power down the server (on page 15).
2. Disconnect all peripheral cables from the server.
3. Remove the server from the chassis (on page 15).
4. Remove the hard drive cage.



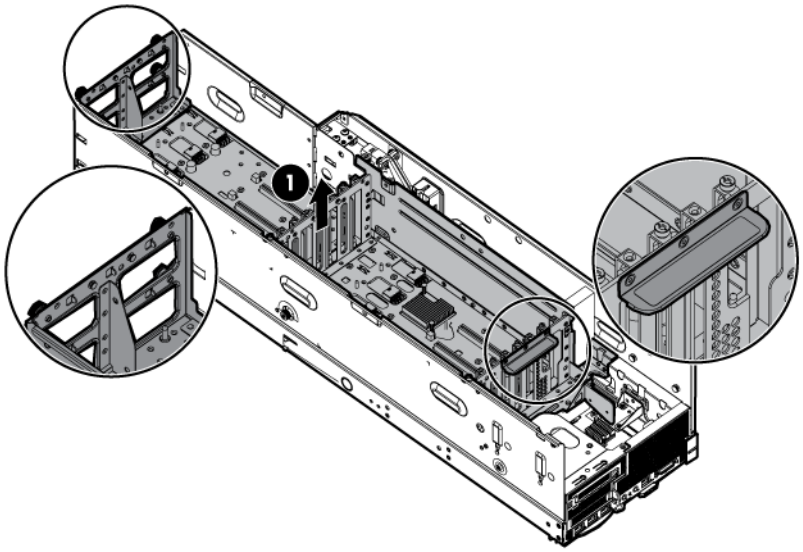
5. Remove all shipping brackets.



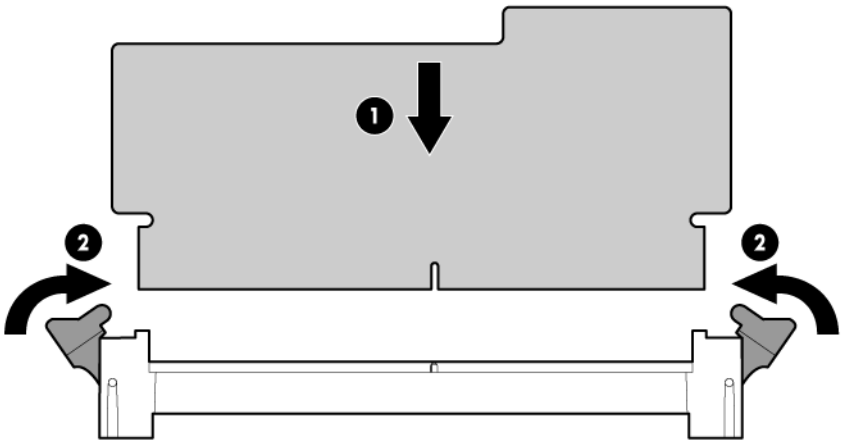
6. Loosen screws securing the GPU shelf.



7. Remove the GPU shelf.



8. Install the cache module in the SAS cache module connector on the system board. For connector locations, see "System board components (on page 9)."



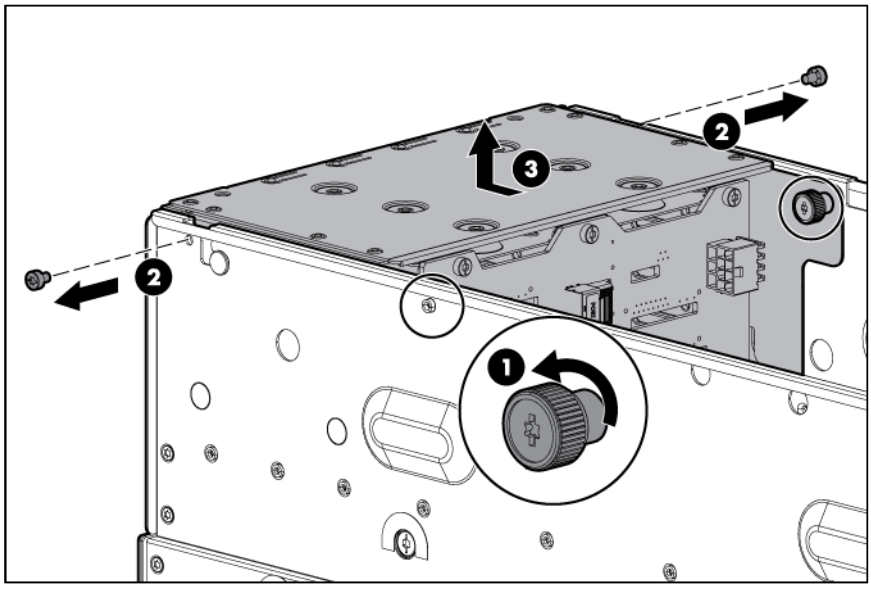
9. Install all components removed from the server.
10. Install the server into the chassis ("Installing the server into the chassis" on page 23).
11. Power up the server (on page 15).

Installing the FBWC capacitor pack

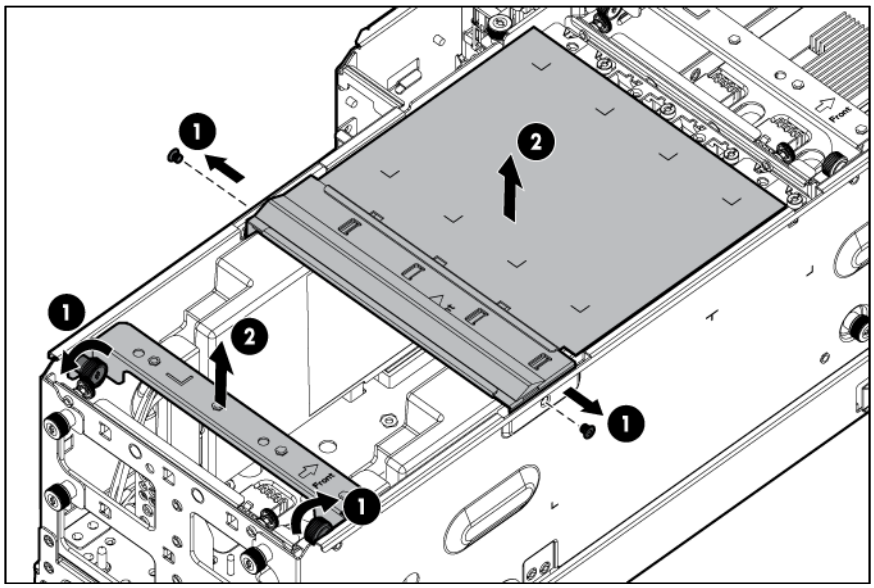
WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

CAUTION: To prevent damage to electrical components, properly ground the server before beginning any installation procedure. Improper grounding can cause ESD.

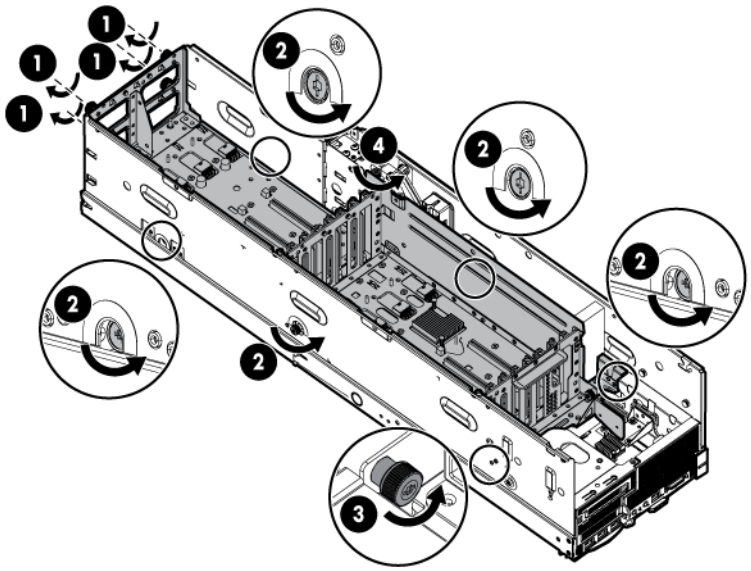
1. Back up all data on the server.
2. Power down the server (on page 15).
3. Disconnect all peripheral cables from the server.
4. Remove the server from the chassis (on page 15).
5. Remove the hard drive cage.



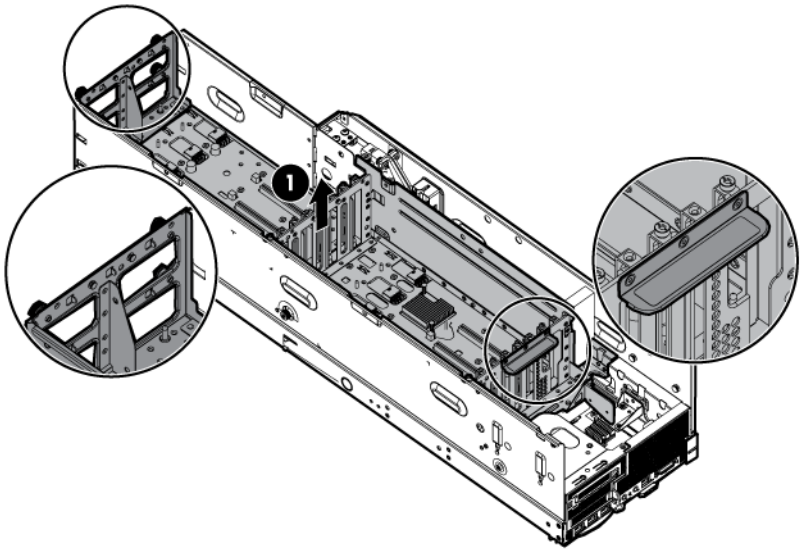
6. Remove all shipping brackets.



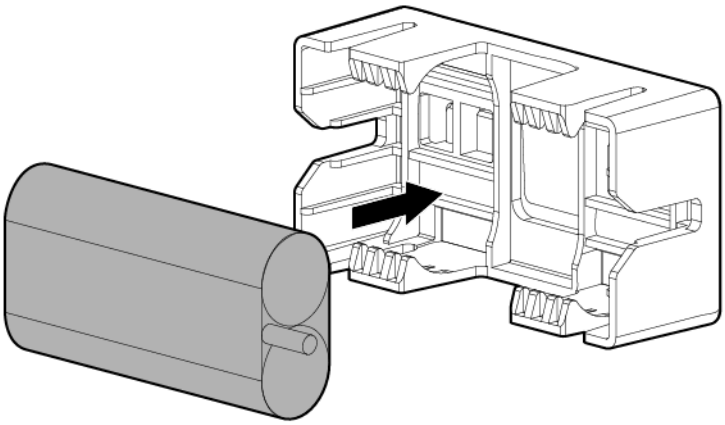
7. Loosen screws securing the GPU shelf.



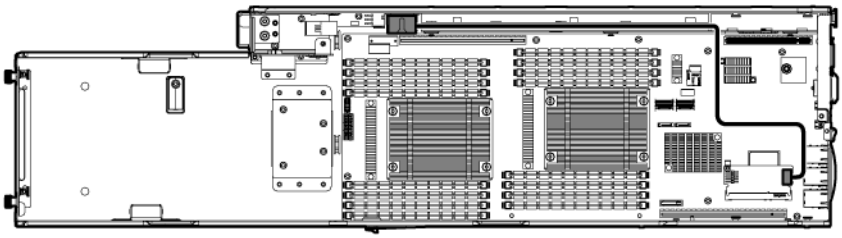
8. Remove the GPU shelf.



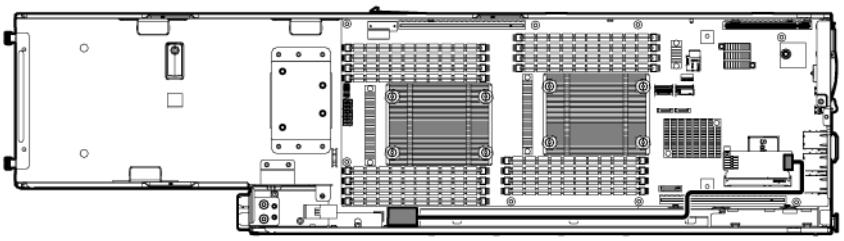
9. Install the FBWC module into the holder mounted in the server tray.



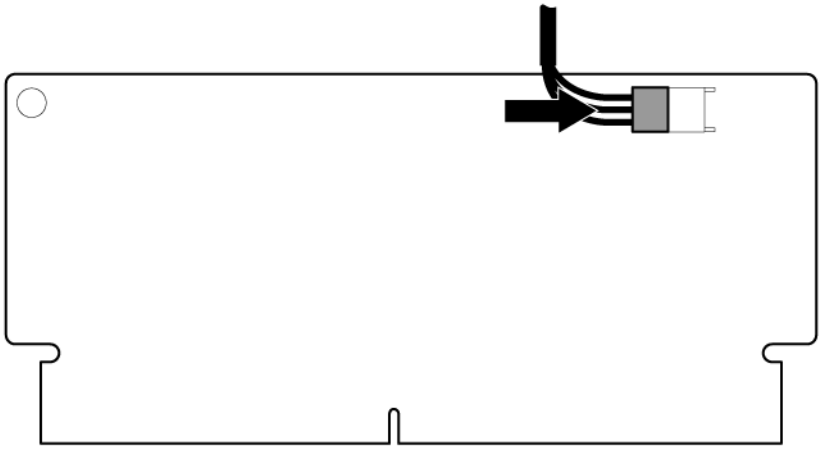
10. Route the FBWC cable as indicated:
    - Left node



- Right node



11. Attach the FBWC cable to the cache module on the system board or to the controller card.



12. Install all components removed from the server.
13. Install the server into the chassis ("Installing the server into the chassis" on page 23).
14. Power up the server (on page 15).

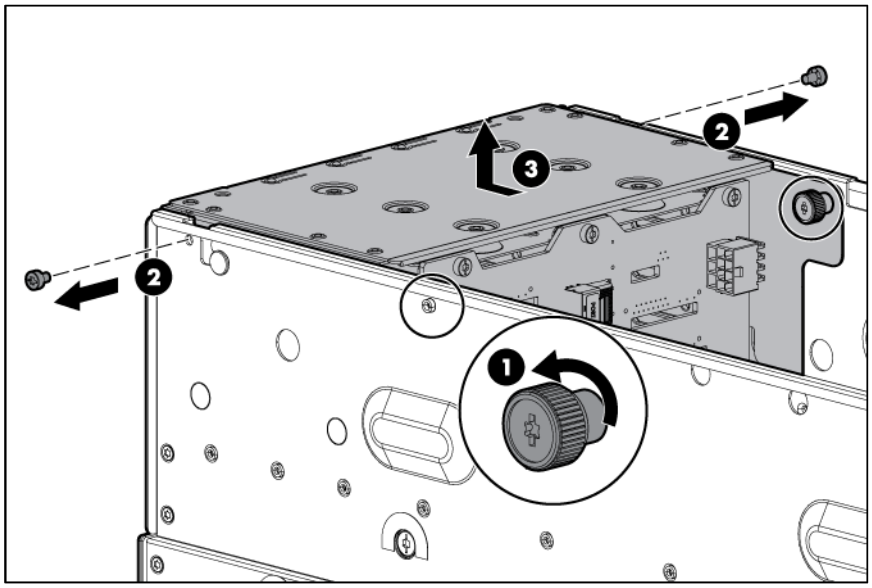
Expansion board options

Installing an expansion board or FlexibleLOM

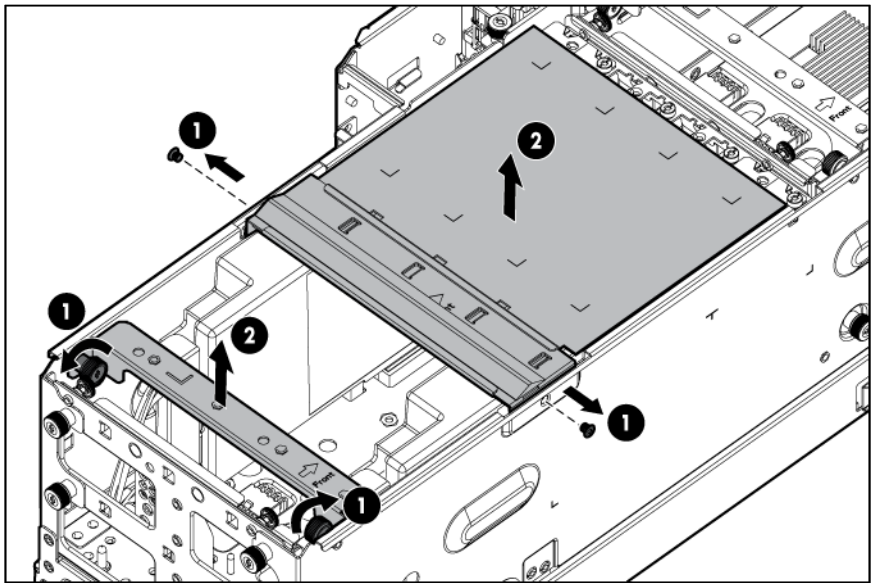
The server ships with PCIe riser boards and expansion slots. PCIe expansion boards and FlexibleLOMs are supported with an optional riser board.

1. Power down the server (on page 15).
2. Disconnect all peripheral cables from the server.
3. Remove the server from the chassis (on page 15).

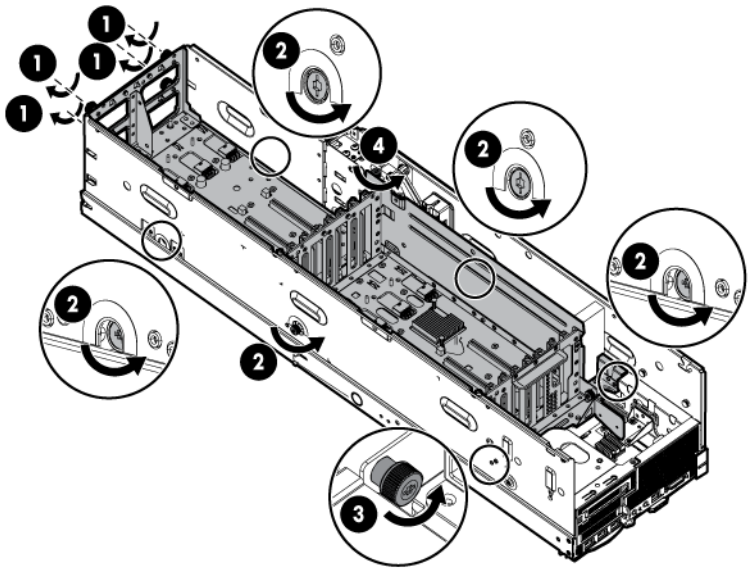
4. Remove the hard drive cage.



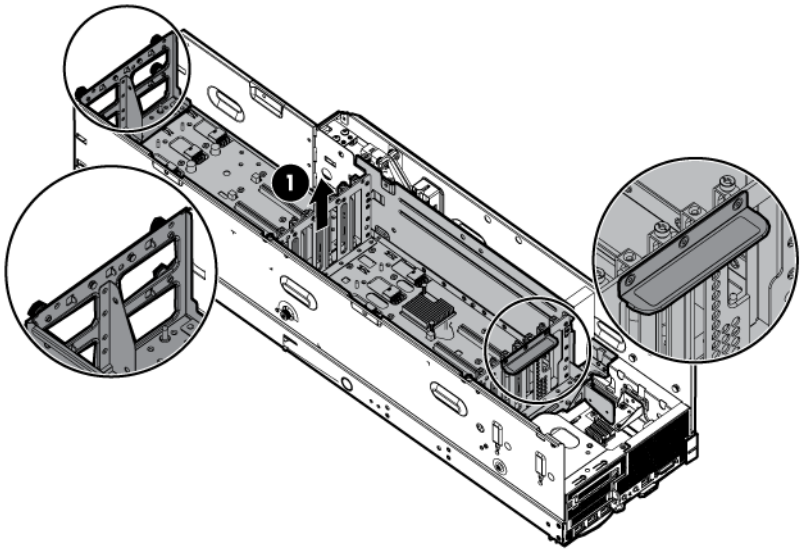
5. Remove all shipping brackets.



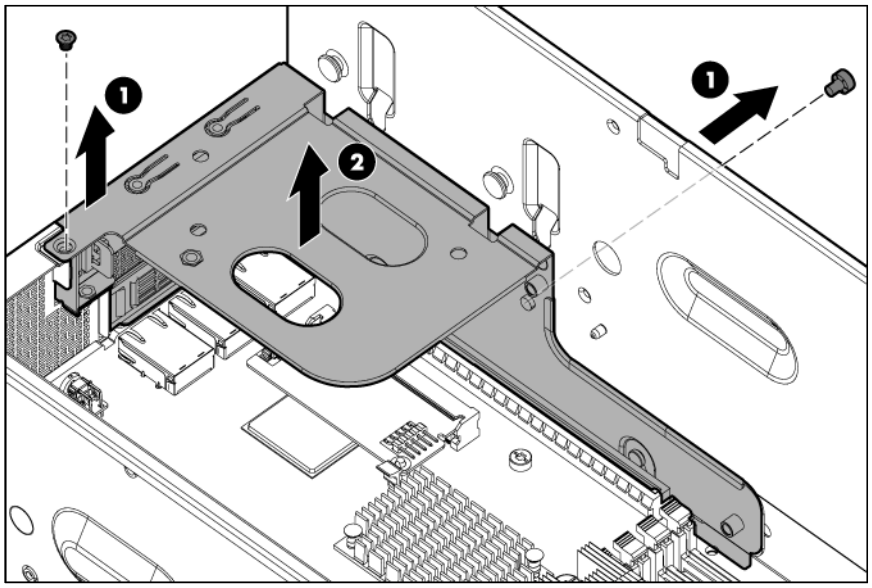
6. Loosen screws securing the GPU shelf.



7. Remove the GPU shelf.



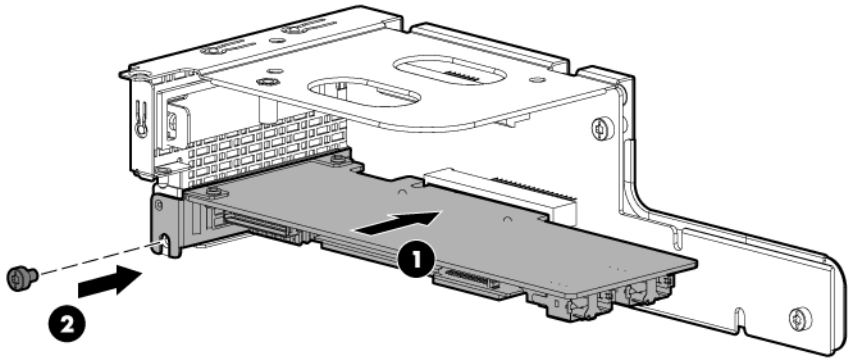
8. Remove the PCI cage.



9. Remove the expansion slot cover from the PCI riser board assembly.

IMPORTANT: If the expansion board ships with an extender bracket, remove it from the expansion board before inserting the board into the expansion slot of the PCI riser board assembly.

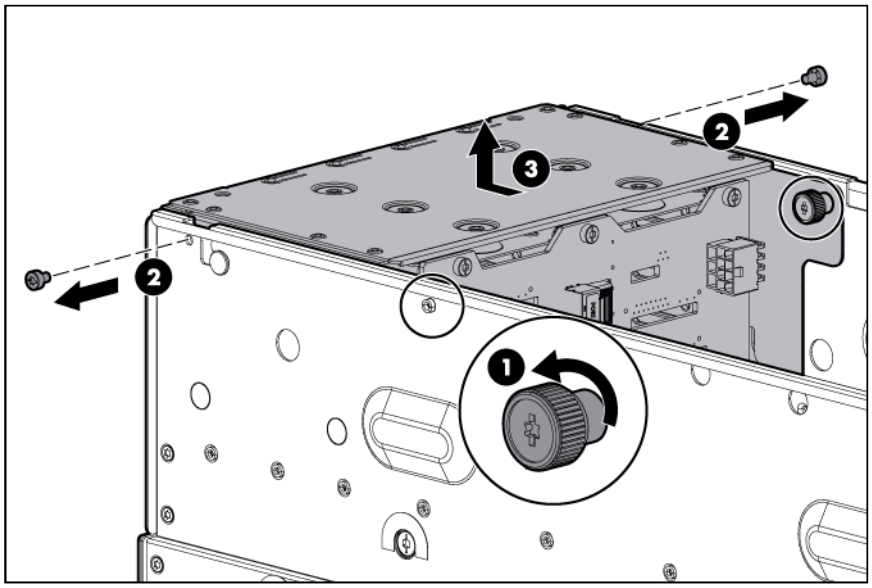
10. Install the expansion board or FlexibleLOM into the slot until it seats firmly.



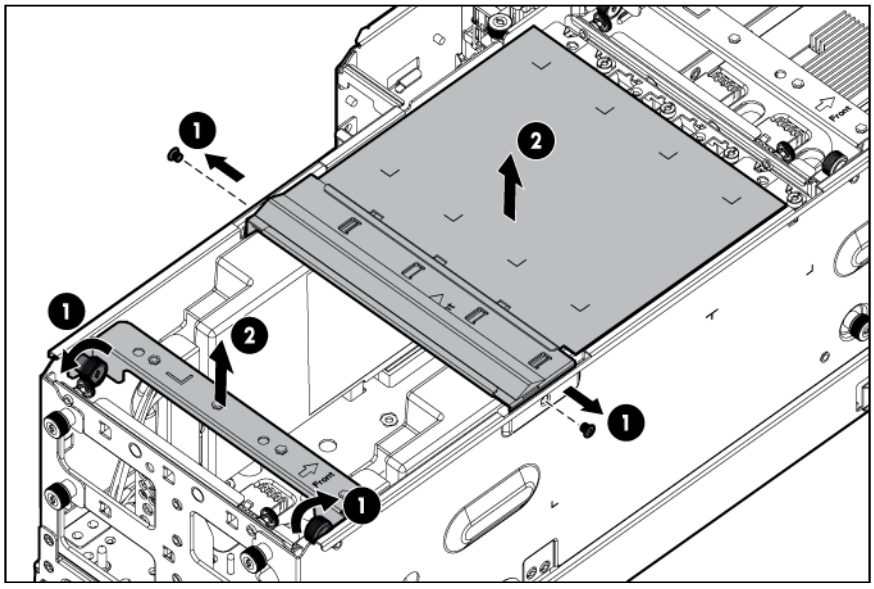
11. Connect all internal or external cabling to the installed board.
12. Install all components removed from the server.
13. Install the server into the chassis ("Installing the server into the chassis" on page 23).
14. Power up the server (on page 15).

Installing a PCI riser board assembly

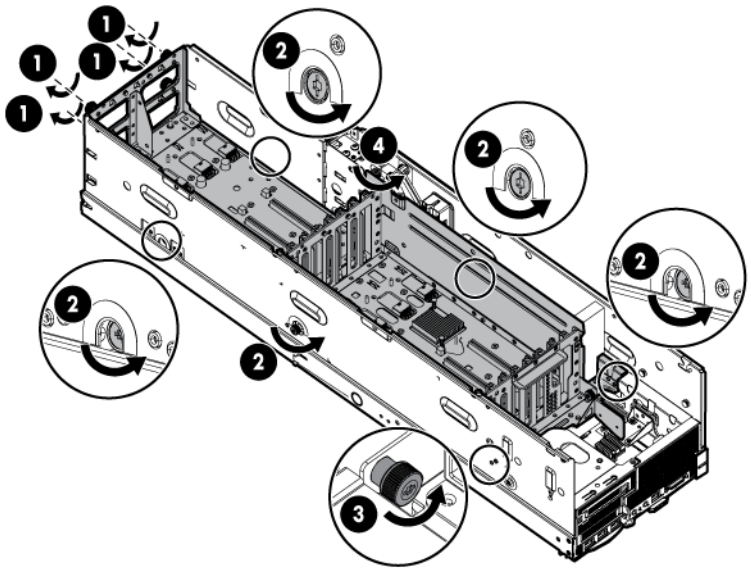
1. Power down the server (on page 15).
2. Disconnect all peripheral cables from the server.
3. Remove the server from the chassis (on page 15).
4. Remove the hard drive cage.



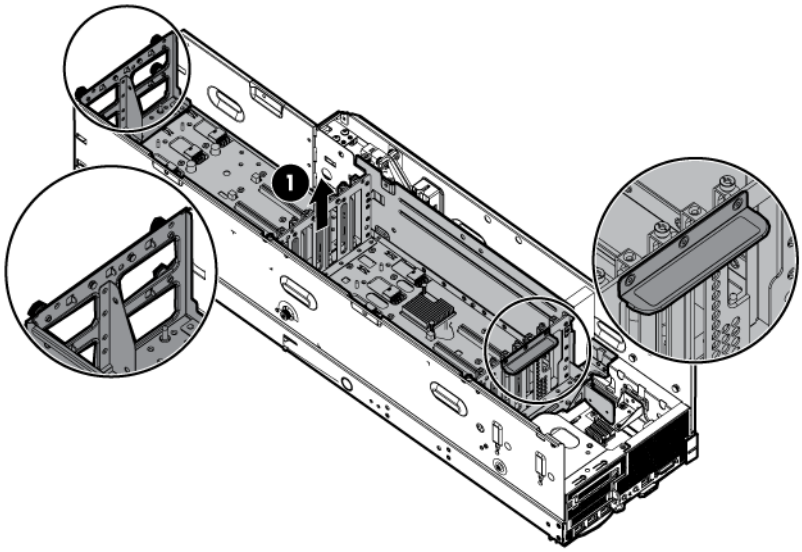
5. Remove all shipping brackets.



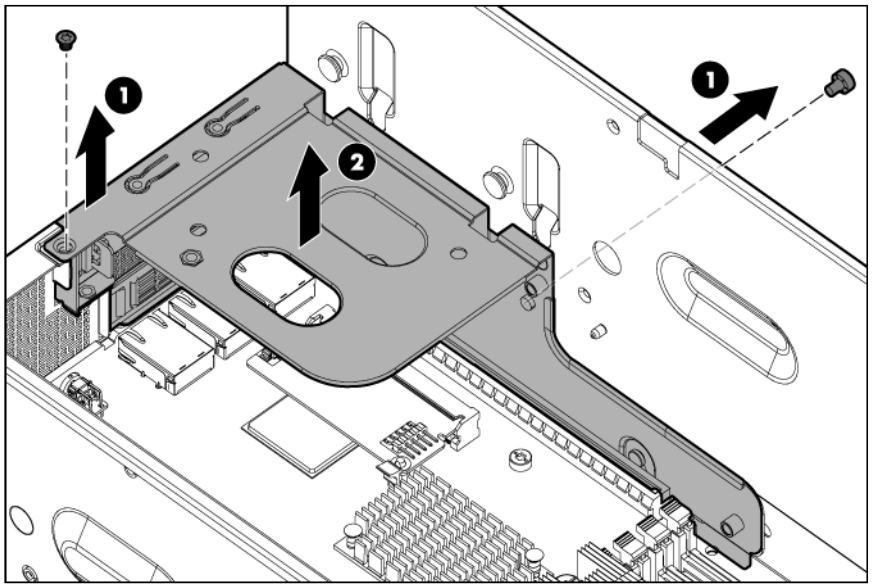
6. Loosen screws securing the GPU shelf.



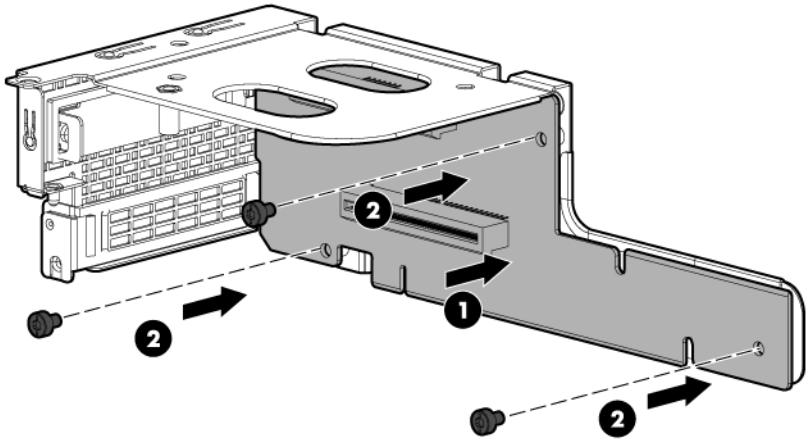
7. Remove the GPU shelf.



8. Remove the PCI cage.



9. Install the riser card into the PCI cage.



10. If necessary, install the expansion boards ("Installing an expansion board or FlexibleLOM" on page 46).

IMPORTANT: The server does not power up if the PCI riser board assembly is not seated properly.

11. Connect all internal cabling to the expansion boards.
12. Install all components removed from the server.
13. Install the server into the chassis ("Installing the server into the chassis" on page 23).
14. Power up the server (on page 15).

Redundant hot-plug power supply option

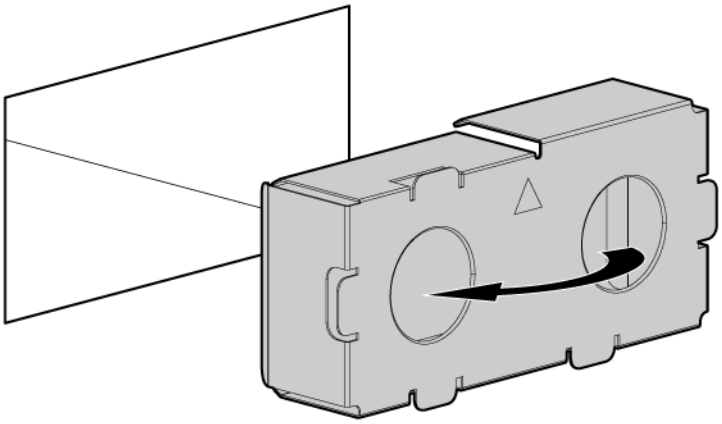
CAUTION: All power supplies installed in the server must have the same output power capacity. Verify that all power supplies have the same part number and label color. The system becomes unstable and may shut down when it detects mismatched power supplies.

Label color	Output
Orange	750W
Green	1,200W
White	1,200W -48Vdc

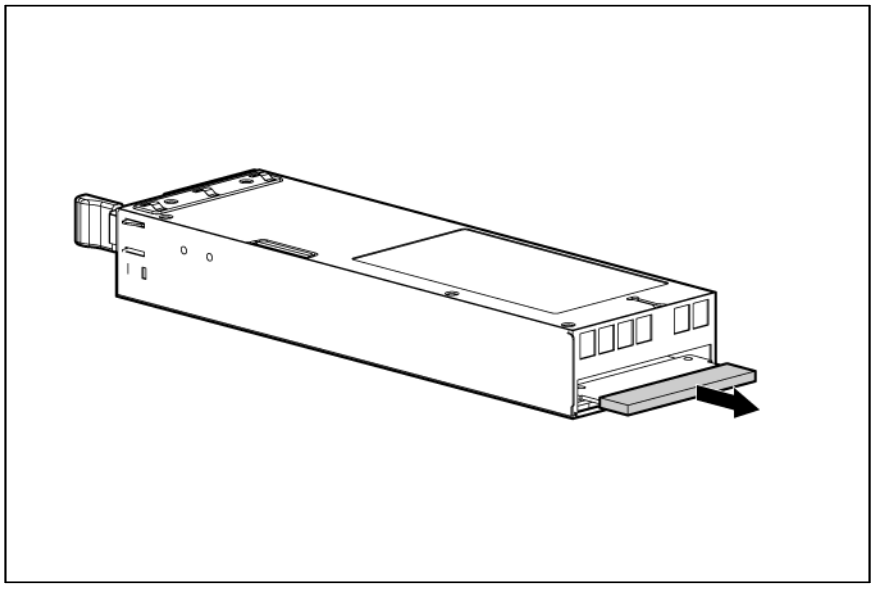
CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To install the component:

1. Unfasten the cable management solution to access the power supply bays.
2. Remove the power supply blank.

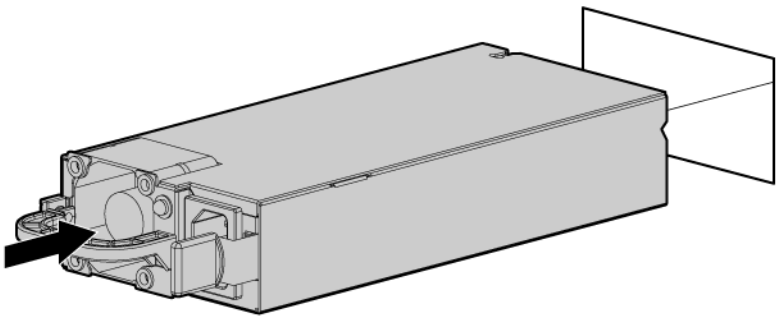


3. Remove the protective cover from the connector pins on the power supply.

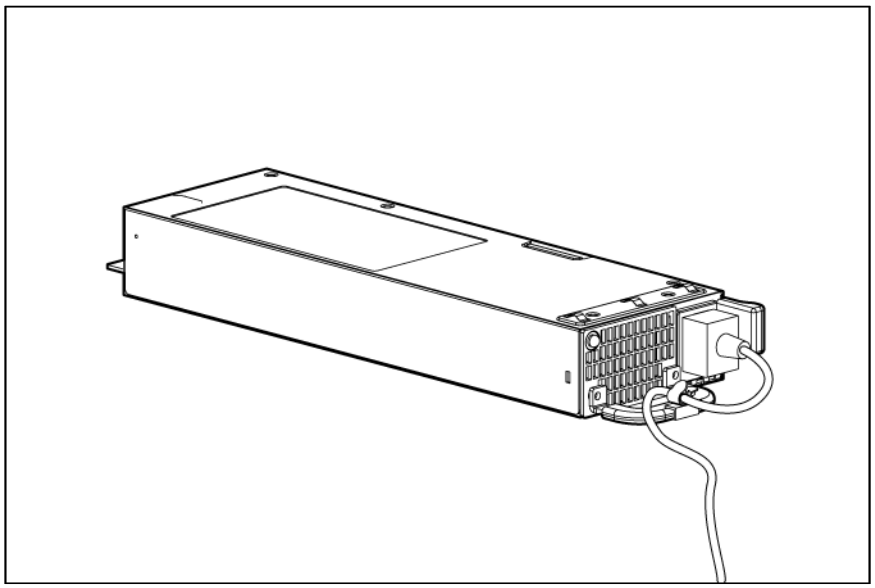


⚠ **WARNING:** To reduce the risk of electric shock or damage to the equipment, do not connect the power cord to the power supply until the power supply is installed.

4. Install the redundant power supply into the bay until it clicks.



5. Connect the power cord to the power supply.
6. Use the strain relief clip from the server hardware kit to secure the power cord.

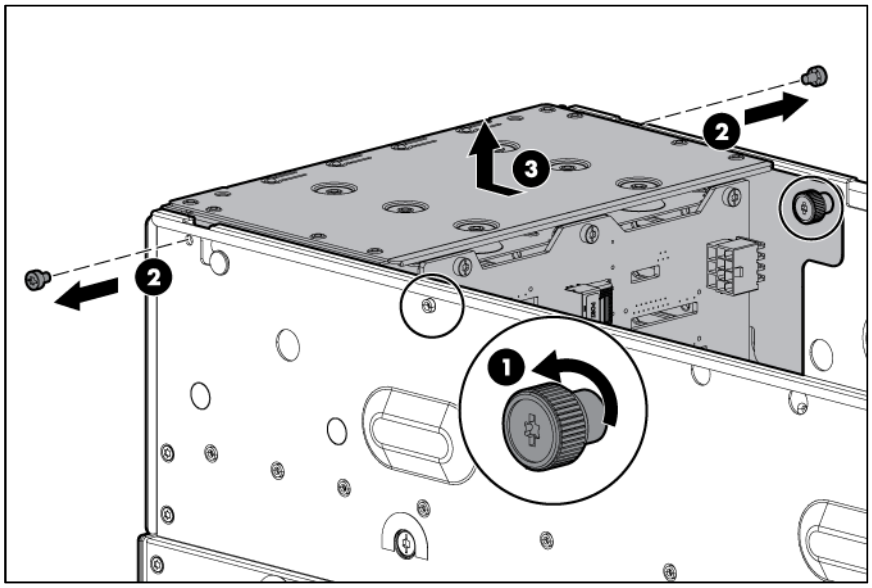


7. Route the power cord through the cable management solution.
8. Connect the power cord to the power source.
9. Be sure that the power supply LED is green.

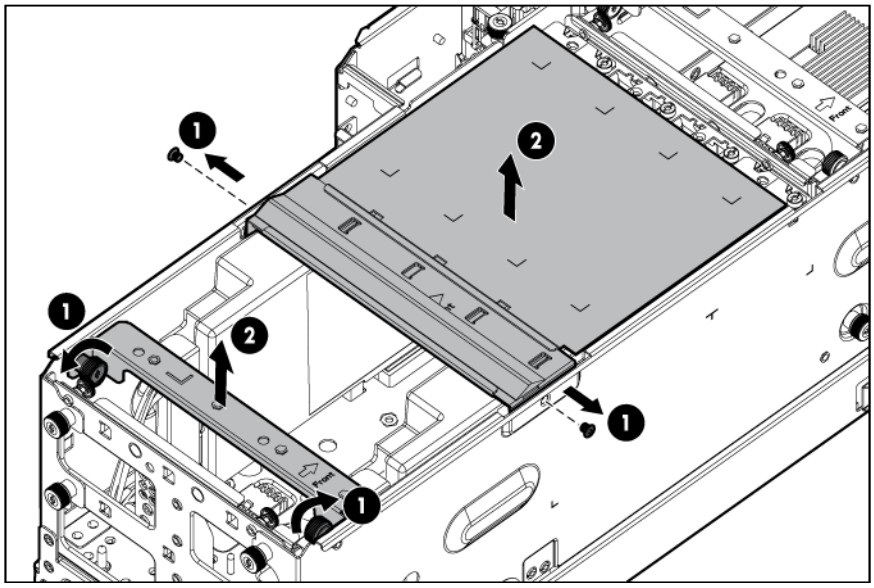
Installing the 8X SFF Smart Array enablement option

1. Power down the server (on page 15).
2. Disconnect all peripheral cables from the server.
3. Remove the server from the chassis (on page 15).

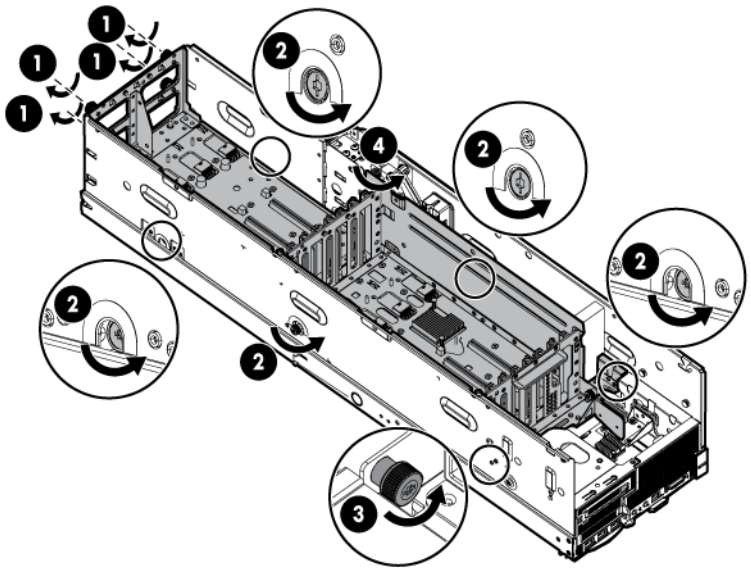
4. Remove the hard drive cage.



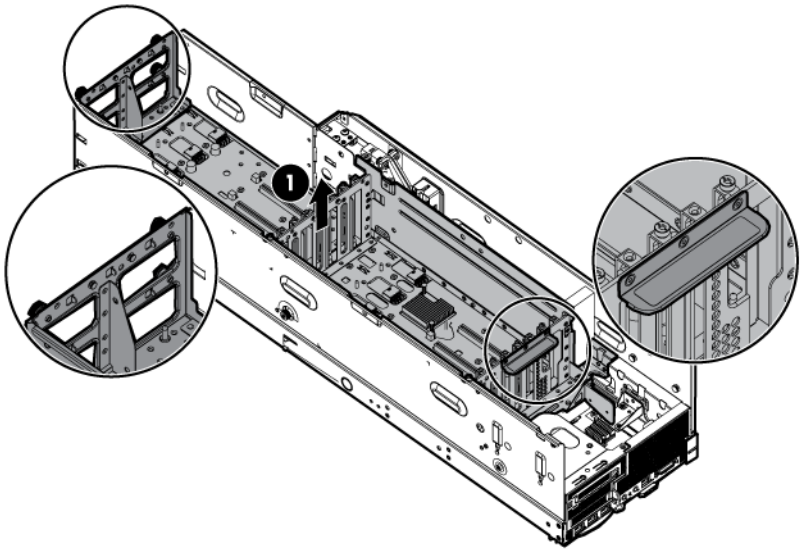
5. Remove all shipping brackets.



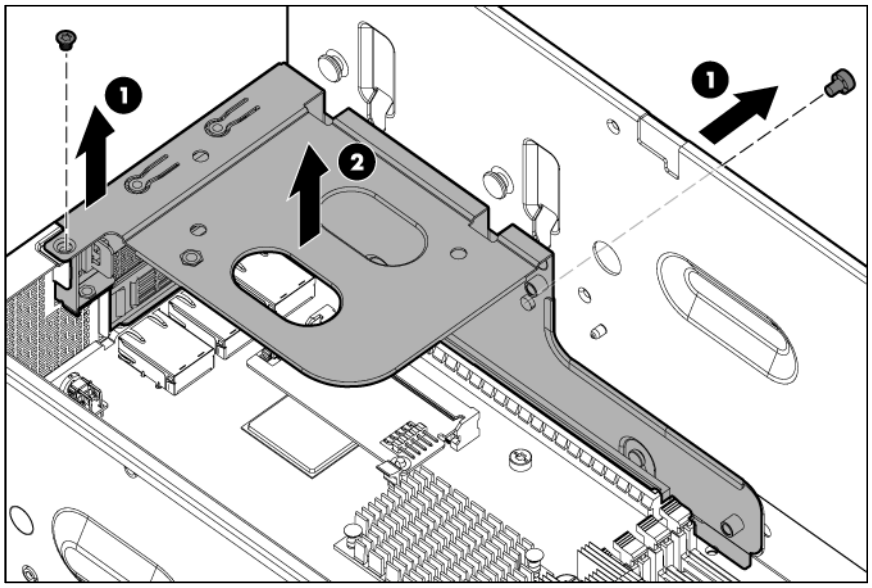
6. Loosen screws securing the GPU shelf.



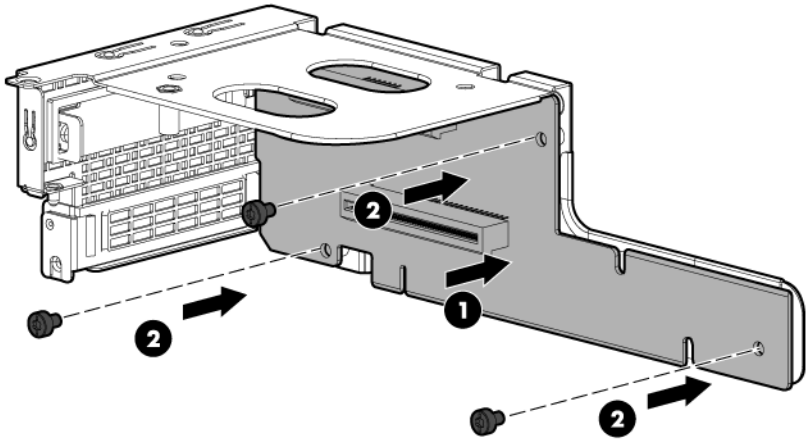
7. Remove the GPU shelf.



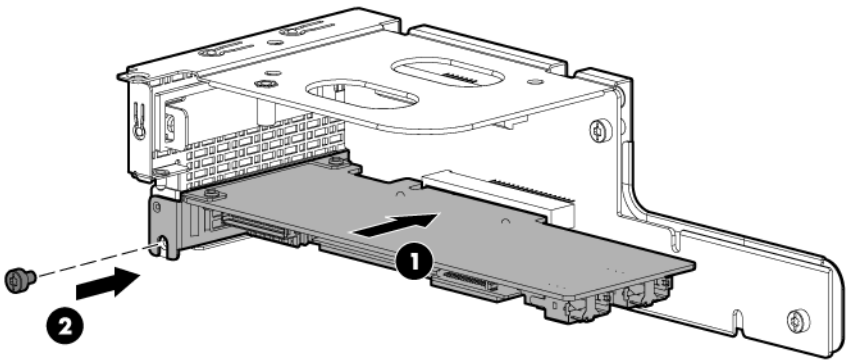
8. Remove the PCI cage.



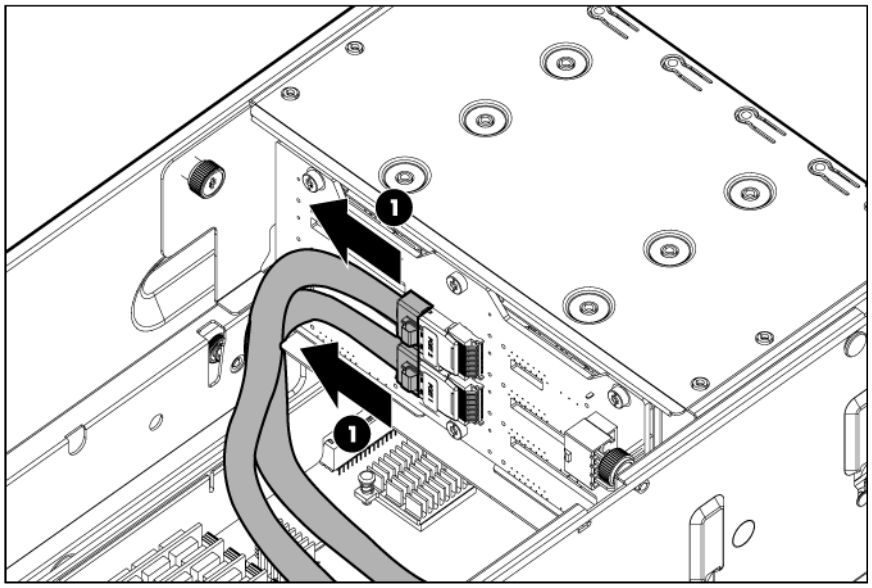
9. Install the riser card into the PCI cage.



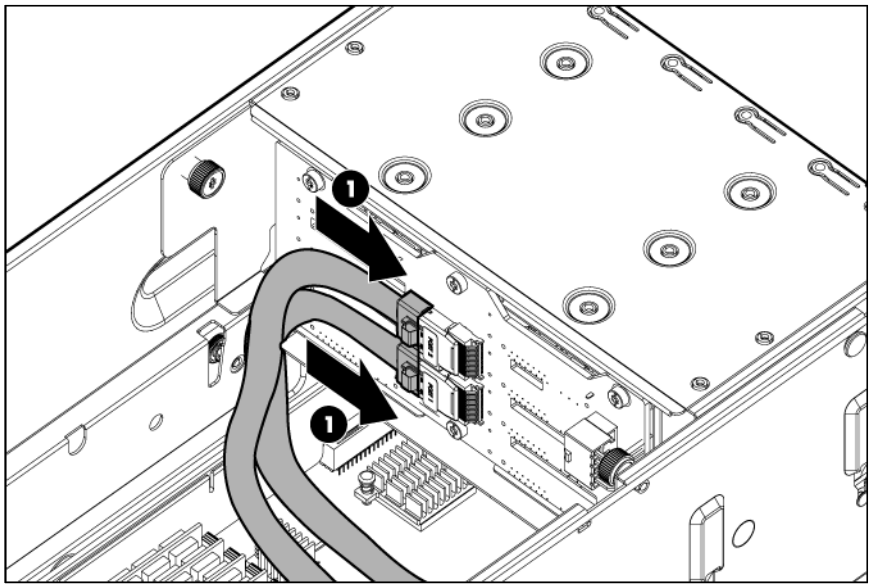
10. Install the controller card into the PCI cage.



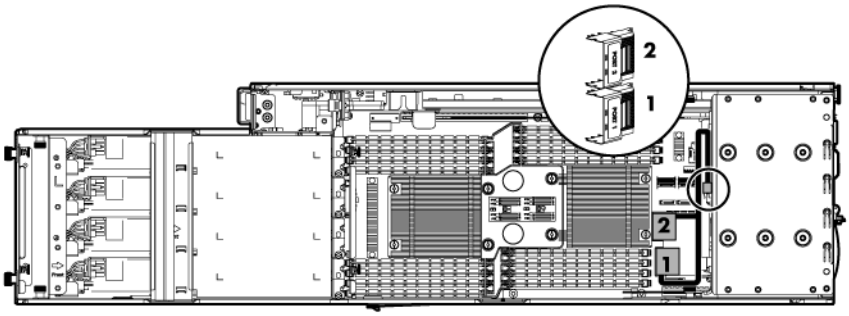
11. Install the PCI cage into the server.
12. Install the HDD cage.
13. Disconnect the existing mini-SAS cables from the SFF HDD cage.



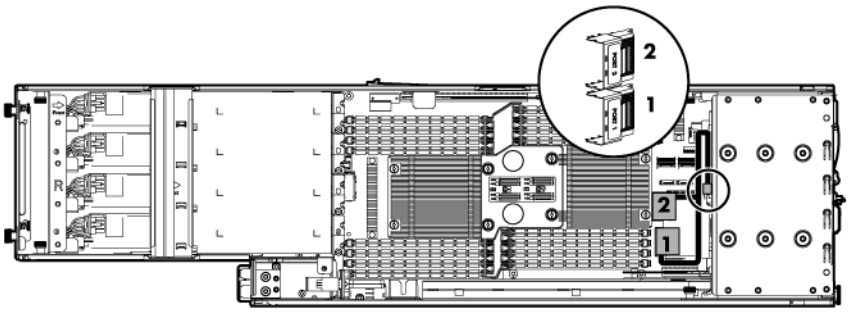
14. Install the mini-SAS cable included in this kit to the HDD cage.



15. Connect the mini-SAS cable to the SAS connection on the controller card.
    - Left node



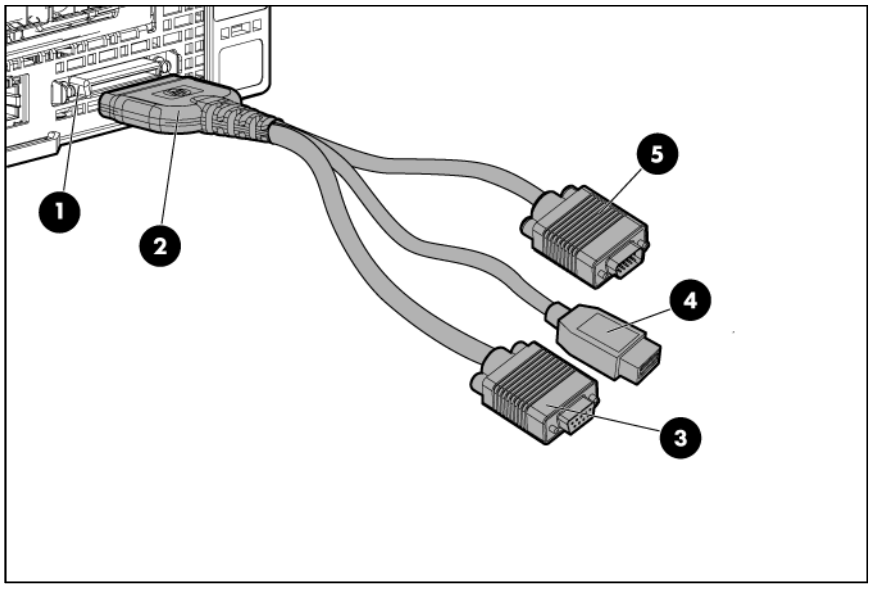
- Right node



16. Install all components removed from the server.
17. Install the server into the chassis ("Installing the server into the chassis" on page 23).
18. Power up the server (on page 15).

Connecting the SUV cable

CAUTION: Before disconnecting the SUV cable from the connector, always squeeze the release buttons on the sides of the connector. Failure to do so can result in damage to the equipment.



Item	Connector	Description
1	SUV port	SUV port on the server front panel
2	SUV connector	For connecting to the SUV connector on the server front panel

Item	Connector	Description
3	Video	For connecting a video monitor
4	USB	For connecting up to two USB devices
5	Serial	For trained personnel to connect a null modem serial cable and perform advanced diagnostic procedures

HP Trusted Platform Module option

Use these instructions to install and enable a TPM on a supported server. This procedure includes three sections:

1. Installing the Trusted Platform Module board.
2. Retaining the recovery key/password (on page 64).
3. Enabling the Trusted Platform Module (on page 65).

   Enabling the TPM requires accessing RBSU ("HP ROM-Based Setup Utility" on page 73). For more information about RBSU, see the HP website (http://www.hp.com/go/ilomgmtengine/docs).

TPM installation requires the use of drive encryption technology, such as the Microsoft Windows BitLocker Drive Encryption feature. For more information on BitLocker, see the Microsoft website (http://www.microsoft.com).

CAUTION: Always observe the guidelines in this document. Failure to follow these guidelines can cause hardware damage or halt data access.

When installing or replacing a TPM, observe the following guidelines:

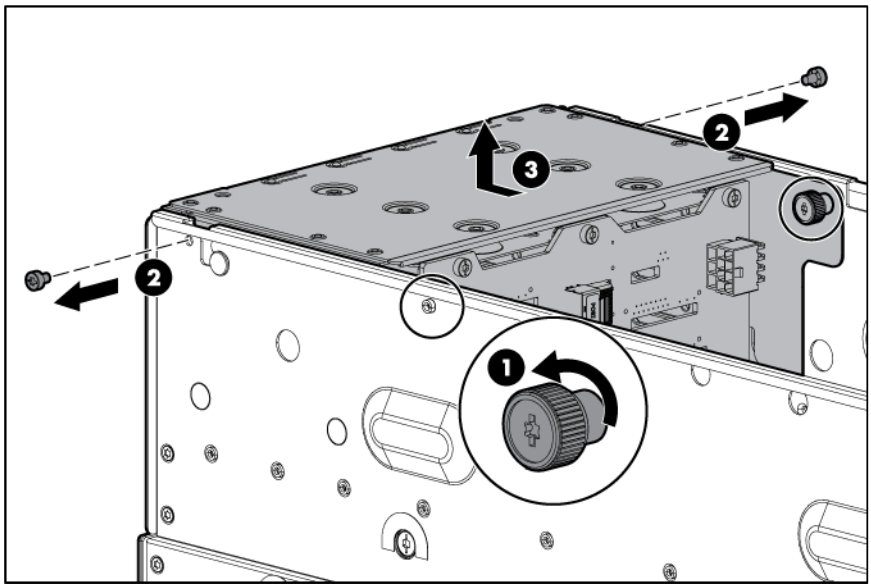
- Do not remove an installed TPM. Once installed, the TPM becomes a permanent part of the system board.
- When installing or replacing hardware, HP service providers cannot enable the TPM or the encryption technology. For security reasons, only the customer can enable these features.
- When returning a system board for service replacement, do not remove the TPM from the system board. When requested, HP Service provides a TPM with the spare system board.
- Any attempt to remove an installed TPM from the system board breaks or disfigures the TPM security rivet. Upon locating a broken or disfigured rivet on an installed TPM, administrators should consider the system compromised and take appropriate measures to ensure the integrity of the system data.
- When using BitLocker, always retain the recovery key/password. The recovery key/password is required to enter Recovery Mode after BitLocker detects a possible compromise of system integrity.
- HP is not liable for blocked data access caused by improper TPM use. For operating instructions, see the encryption technology feature documentation provided by the operating system.

Installing the Trusted Platform Module board

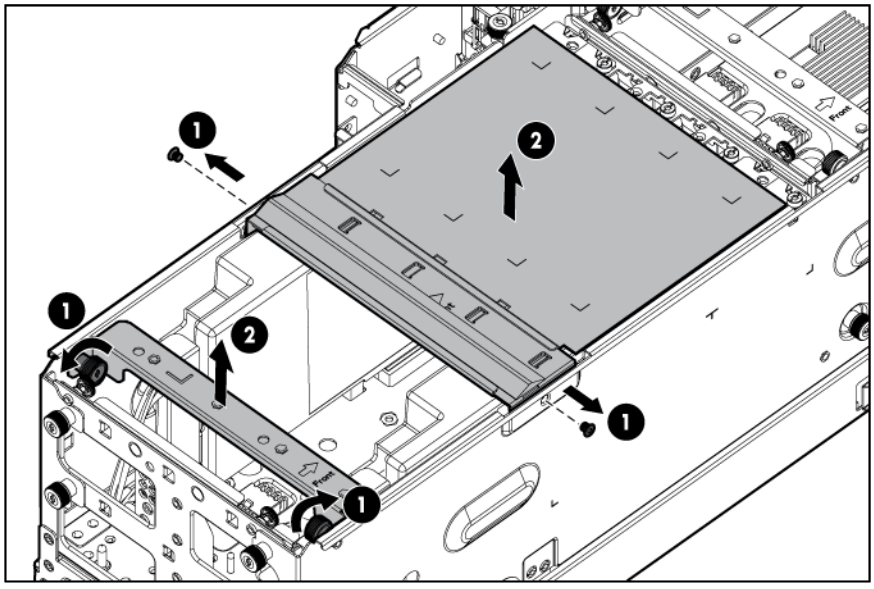
WARNING: To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC power is removed.

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

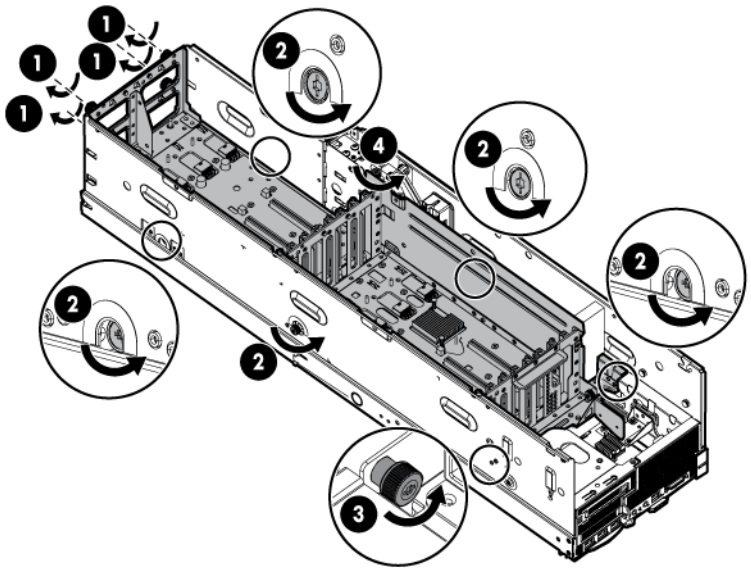
1. Power down the server (on page 15).
2. Disconnect all peripheral cables from the server.
3. Remove the server from the chassis (on page 15).
4. Remove the hard drive cage.



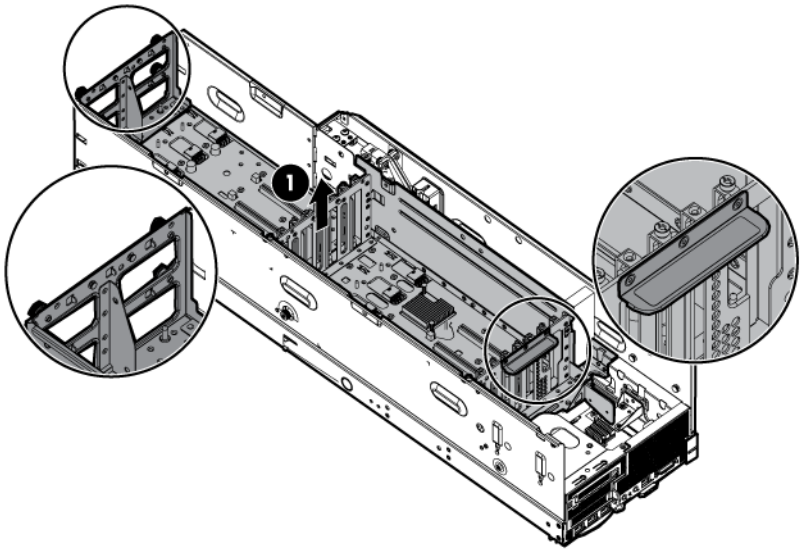
5. Remove all shipping brackets.



6. Loosen screws securing the GPU shelf.

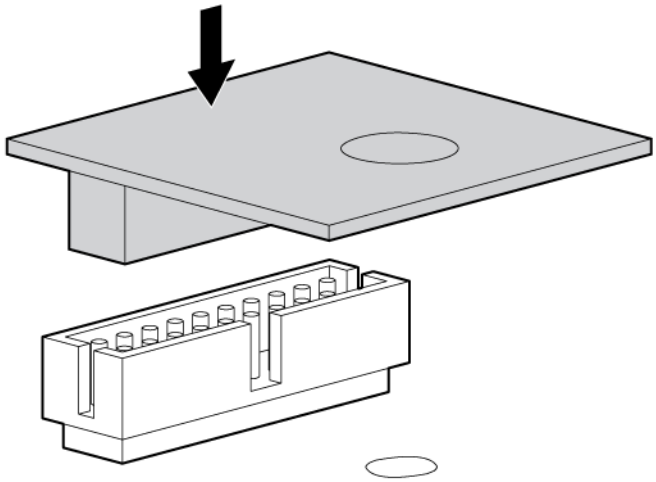


7. Remove the GPU shelf.

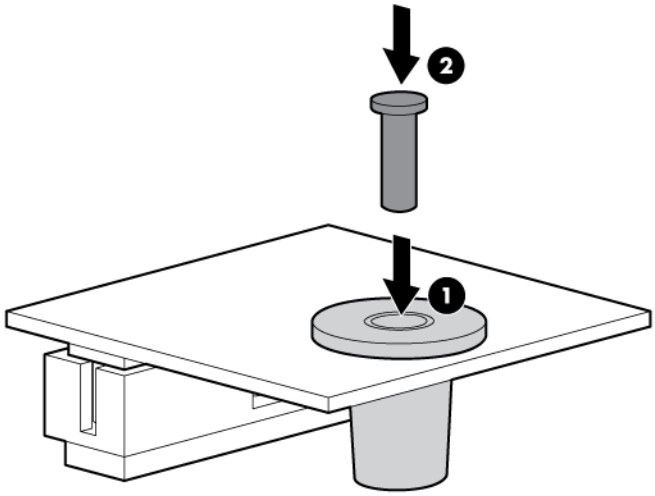


△ **CAUTION:** Any attempt to remove an installed TPM from the system board breaks or disfigures the TPM security rivet. Upon locating a broken or disfigured rivet on an installed TPM, administrators should consider the system compromised and take appropriate measures to ensure the integrity of the system data.

8. Install the TPM board. Press down on the connector to seat the board ("System board components" on page 9).



9. Install the TPM security rivet by pressing the rivet firmly into the system board.



10. Install all components removed from the server.
11. Install the server into the chassis ("Installing the server into the chassis" on page 23).
12. Power up the server (on page 15).

Retaining the recovery key/password

The recovery key/password is generated during BitLocker™ setup, and can be saved and printed after BitLocker™ is enabled. When using BitLocker™, always retain the recovery key/password. The recovery key/password is required to enter Recovery Mode after BitLocker™ detects a possible compromise of system integrity.

To help ensure maximum security, observe the following guidelines when retaining the recovery key/password:

- Always store the recovery key/password in multiple locations.

- Always store copies of the recovery key/password away from the server.
- Do not save the recovery key/password on the encrypted hard drive.

Enabling the Trusted Platform Module

1. When prompted during the start-up sequence, access RBSU by pressing the **F9** key.
2. From the Main Menu, select **Server Security**.
3. From the Server Security Menu, select **Trusted Platform Module**.
4. From the Trusted Platform Module Menu, select **TPM Functionality**.
5. Select **Enable**, and then press the **Enter** key to modify the TPM Functionality setting.
6. Press the **Esc** key to exit the current menu, or press the **F10** key to exit RBSU.
7. Reboot the server.
8. Enable the TPM in the OS. For OS-specific instructions, see the OS documentation.

> △ **CAUTION:** When a TPM is installed and enabled on the server, data access is locked if you fail to follow the proper procedures for updating the system or option firmware, replacing the system board, replacing a hard drive, or modifying OS application TPM settings.

For more information on firmware updates and hardware procedures, see the *HP Trusted Platform Module Best Practices White Paper* on the HP website (http://www.hp.com/support).

For more information on adjusting TPM usage in BitLocker™, see the Microsoft website (http://technet.microsoft.com/en-us/library/cc732774.aspx).

Cabling

Cabling overview

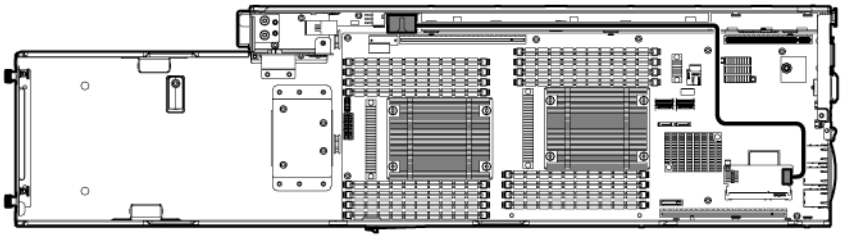
This section provides guidelines that help you make informed decisions about cabling the server and hardware options to optimize performance.

For information on cabling peripheral components, refer to the white paper on high-density deployment at the HP website (http://www.hp.com/products/servers/platforms).

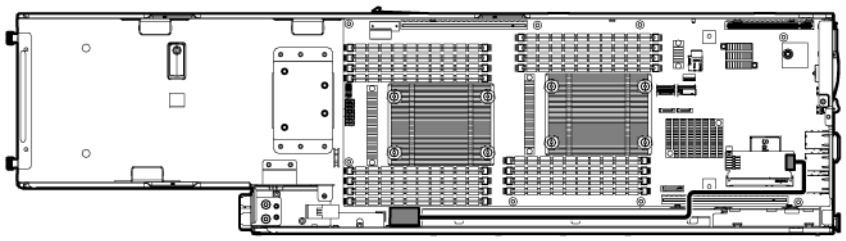
CAUTION: When routing cables, always be sure that the cables are not in a position where they can be pinched or crimped.

FBWC capacitor pack cabling

Left node



Right node



Software and configuration utilities

Server mode

The software and configuration utilities presented in this section operate in online mode, offline mode, or in both modes.

Software or configuration utility	Server mode
HP iLO (on page 68)	Online and Offline
Active Health System (on page 69)	Online and Offline
Integrated Management Log (on page 70)	Online and Offline
Intelligent Provisioning	Offline
HP Insight Diagnostics (on page 70)	Online and Offline
Erase Utility (on page 71)	Offline
HP Insight Remote Support software (on page 71)	Online
Scripting Toolkit (on page 72)	Online
HP Service Pack for ProLiant (on page 72)	Online and Offline
HP Smart Update Manager (on page 73)	Online and Offline
HP ROM-Based Setup Utility (on page 73)	Offline
Array Configuration Utility (on page 76)	Online and Offline
Option ROM Configuration for Arrays (on page 77)	Offline
ROMPaq utility (on page 77)	Offline

Server QuickSpecs

For more information about product features, specifications, options, configurations, and compatibility, see the QuickSpecs on the HP website (http://www.hp.com/go/productbulletin). At the website, choose the geographic region, and then locate the product by name or product category.

HP iLO Management Engine

The HP iLO Management Engine is a set of embedded management features supporting the complete lifecycle of the server, from initial deployment through ongoing management.

HP iLO

The iLO 4 subsystem is a standard component of selected HP ProLiant servers that simplifies initial server setup, server health monitoring, power and thermal optimization, and remote server administration. The iLO 4 subsystem includes an intelligent microprocessor, secure memory, and a dedicated network interface. This design makes iLO 4 independent of the host server and its operating system.

iLO 4 enables and manages the Active Health System (on page 69) and also features Agentless Management. All key internal subsystems are monitored by iLO 4. SNMP alerts are sent directly by iLO 4 regardless of the host operating system or even if no host operating system is installed.

Using iLO 4, you can do the following:

- Access a high-performance and secure Remote Console to the server from anywhere in the world.
- Use the shared iLO 4 Remote Console to collaborate with up to six server administrators.
- Remotely mount high-performance Virtual Media devices to the server.
- Securely and remotely control the power state of the managed server.
- Have true Agentless Management with SNMP alerts from iLO 4 regardless of the state of the host server.
- Access Active Health System troubleshooting features through the iLO 4 interface.

For more information about iLO 4 features (which may require an iLO Advanced Pack or iLO Advanced for BladeSystem license), see the iLO 4 documentation on the Documentation CD or on the HP website (http://www.hp.com/go/ilo/docs).

Active Health System

HP Active Health System provides the following features:

- Combined diagnostics tools/scanners
- Always on, continuous monitoring for increased stability and shorter downtimes
- Rich configuration history
- Health and service alerts
- Easy export and upload to Service and Support

The HP Active Health System monitors and records changes in the server hardware and system configuration. The Active Health System assists in diagnosing problems and delivering rapid resolution when server failures occur.

The Active Health System collects the following types of data:

- Server model
- Serial number
- Processor model and speed
- Storage capacity and speed
- Memory capacity and speed
- Firmware/BIOS

HP Active Health System does not collect information about Active Health System users' operations, finances, customers, employees, partners, or data center, such as IP addresses, host names, user names, and passwords. HP Active Health System does not parse or change operating system data from third-party error event log activities, such as content created or passed through by the operating system.

The data that is collected is managed according to the HP Data Privacy policy. For more information see the HP website (http://www.hp.com/go/privacy).

The Active Health System log, in conjunction with the system monitoring provided by Agentless Management or SNMP Pass-thru, provides continuous monitoring of hardware and configuration changes, system status, and service alerts for various server components.

The Agentless Management Service is available in the SPP, which is a disk image (.iso) that you can download from the HP website (http://www.hp.com/go/spp/download). The Active Health System log can be downloaded manually from iLO 4 or HP Intelligent Provisioning and sent to HP. For more information, see the *HP iLO User Guide* or *HP Intelligent Provisioning User Guide* on the HP website (http://www.hp.com/go/ilo/docs).

Integrated Management Log

The IML records hundreds of events and stores them in an easy-to-view form. The IML timestamps each event with 1-minute granularity.

You can view recorded events in the IML in several ways, including the following:

- From within HP SIM
- From within operating system-specific IML viewers
  - For Windows: IML Viewer
  - For Linux: IML Viewer Application
- From within the iLO 4 user interface
- From within HP Insight Diagnostics (on page 70)

Intelligent Provisioning

Several packaging changes have taken place with HP ProLiant Gen8 servers: SmartStart CDs and the Smart Update Firmware DVD will no longer ship with these new servers. Instead, the deployment capability is embedded in the server as part of HP iLO Management Engine's Intelligent Provisioning.

Intelligent Provisioning is an essential single-server deployment tool embedded in HP ProLiant Gen8 servers that simplifies HP ProLiant server setup, providing a reliable and consistent way to deploy HP ProLiant server configurations.

- Intelligent Provisioning assists with the OS installation process by preparing the system for installing "off-the-shelf" versions of leading operating system software and automatically integrating optimized HP ProLiant server support software from SPP. SPP is the installation package for operating system-specific bundles of HP ProLiant optimized drivers, utilities, management agents, and system firmware.
- Intelligent Provisioning provides maintenance-related tasks through Perform Maintenance features.

For more information on Intelligent Provisioning software, see the HP website (http://www.hp.com/go/ilo). For more information about Intelligent Provisioning drivers, firmware, and SPP, see the HP website (http://www.hp.com/go/spp/download).

HP Insight Diagnostics

HP Insight Diagnostics is a proactive server management tool, available in both offline and online versions, that provides diagnostics and troubleshooting capabilities to assist IT administrators who verify server installations, troubleshoot problems, and perform repair validation.

HP Insight Diagnostics Offline Edition performs various in-depth system and component testing while the OS is not running. To run this utility, boot the server using Intelligent Provisioning.

HP Insight Diagnostics Online Edition is a web-based application that captures system configuration and other related data needed for effective server management. Available in Microsoft Windows and Linux versions, the utility helps to ensure proper system operation.

For more information or to download the utility, see the HP website (http://www.hp.com/servers/diags). HP Insight Diagnostics Online Edition is also available in the SPP. For more information, see the HP website (http://www.hp.com/go/spp/download).

HP Insight Diagnostics survey functionality

HP Insight Diagnostics (on page 70) provides survey functionality that gathers critical hardware and software information on ProLiant servers.

This functionality supports operating systems that are supported by the server. For operating systems supported by the server, see the HP website (http://www.hp.com/go/supportos).

If a significant change occurs between data-gathering intervals, the survey function marks the previous information and overwrites the survey data files to reflect the latest changes in the configuration.

Survey functionality is installed with every Intelligent Provisioning-assisted HP Insight Diagnostics installation, or it can be installed through the SPP ("HP Service Pack for ProLiant" on page 72).

Erase Utility

△ **CAUTION:** Perform a backup before running the System Erase Utility. The utility sets the system to its original factory state, deletes the current hardware configuration information, including array setup and disk partitioning, and erases all connected hard drives completely. Refer to the instructions for using this utility.

The Erase utility enables you to erase system CMOS, NVRAM, and hard drives. Run the Erase Utility if you must erase the system for the following reasons:

- You want to install a new operating system on a server with an existing operating system.
- You encounter an error when completing the steps of a factory-installed operating system installation.

To access the Erase Utility, click the Perform Maintenance icon from the Intelligent Provisioning home screen and then select **Erase**.

Run the Erase utility to:

- **Reset all settings** — erases all drives, NVRAM, and RBSU
- **Reset all disks** — erases all drives
- **Reset RBSU** — erases current RBSU settings

After selecting the appropriate option, click **Erase System**. Click **Exit** to reboot the server after the erase task is completed. Click **Cancel Erase** to exit the utility without erasing.

HP Insight Remote Support software

HP strongly recommends that you install HP Insight Remote Support software to complete the installation or upgrade of your product and to enable enhanced delivery of your HP Warranty, HP Care Pack Service, or HP contractual support agreement. HP Insight Remote Support supplements your monitoring 24 x 7 to ensure

maximum system availability by providing intelligent event diagnosis, and automatic, secure submission of hardware event notifications to HP, which will initiate a fast and accurate resolution, based on your product's service level. Notifications may be sent to your authorized HP Channel Partner for on-site service, if configured and available in your country. The software is available in two variants:

- HP Insight Remote Support Standard: This software supports server and storage devices and is optimized for environments with 1–50 servers. Ideal for customers who can benefit from proactive notification but do not need proactive service delivery and integration with a management platform.
- HP Insight Remote Support Advanced: For customers with mid-size to large environments with over 500 devices who require HP Proactive Services, or customers currently using HP Operations Manager or SAP Solution Manager to manage their environment, HP recommends installing the latest HP Insight Remote Support Advanced software. This software provides comprehensive remote monitoring and proactive service support for nearly all HP servers, storage, network, and SAN environments, plus selected non-HP servers that have a support obligation with HP. It is integrated with HP Systems Insight Manager. A dedicated server is recommended to host both HP Systems Insight Manager and HP Insight Remote Support Advanced.

Details for both versions are available on the HP website (http://www.hp.com/go/insightremotesupport).

To download the software, go to Software Depot (http://www.software.hp.com).

Select **Insight Remote Support** from the menu on the right.

The HP Insight Remote Support software release notes detail the specific prerequisites, supported hardware, and associated operating systems. For more information:

- See the HP Insight Remote Support Standard Release Notes on the HP website (http://www.hp.com/go/insightremotestandard-docs).
- See the HP Insight Remote Support Advanced Release Notes on the HP website (http://www.hp.com/go/insightremoteadvanced-docs).

Scripting Toolkit

The Scripting Toolkit is a server deployment product that enables you to build an unattended automated installation for high-volume server deployments. The Scripting Toolkit is designed to support ProLiant BL, ML, DL, and SL servers. The toolkit includes a modular set of utilities and important documentation that describes how to apply these tools to build an automated server deployment process.

The Scripting Toolkit provides a flexible way to create standard server configuration scripts. These scripts are used to automate many of the manual steps in the server configuration process. This automated server configuration process cuts time from each deployment, making it possible to scale rapid, high-volume server deployments.

For more information, and to download the Scripting Toolkit, see the HP website (http://www.hp.com/go/ProLiantSTK).

HP Service Pack for ProLiant

SPP is a release set that contains a comprehensive collection of firmware and system software components, all tested together as a single solution stack for HP ProLiant servers, their options, BladeSystem enclosures, and limited HP external storage.

SPP has several key features for updating HP ProLiant servers. Using HP SUM as the deployment tool, SPP can be used in an online mode on a Windows or Linux hosted operating system, or in an offline mode where the server is booted to the ISO so that the server can be updated automatically with no user interaction or updated in interactive mode.

For more information or to download SPP, see the HP website (http://www.hp.com/go/spp).

HP Smart Update Manager

The HP SUM provides intelligent and flexible firmware and software deployment. This technology assists in reducing the complexity of provisioning and updating HP ProLiant Servers, options, and Blades within the data center. HP SUM is used to deploy firmware and software in SPP.

HP SUM enables system administrators to upgrade ROM images efficiently across a wide range of servers and options. This tool has the following features:

- Enables GUI and a command-line, scriptable interface
- Provides scriptable, command-line deployment
- Requires no agent for remote installations
- Enables dependency checking, which ensures appropriate install order and dependency checking between components
- Deploys software and firmware on Windows and Linux operating systems
- Performs local or remote (one-to-many) online deployment
- Deploys firmware and software together
- Supports offline and online deployment
- Deploys necessary component updates only
- Downloads the latest components from Web
- Enables direct update of BMC firmware (HP iLO)

For more information about HP SUM and to access the *HP Smart Update Manager User Guide*, see the HP website (http://www.hp.com/go/hpsum/documentation).

HP ROM-Based Setup Utility

RBSU is a configuration utility embedded in ProLiant servers that performs a wide range of configuration activities that can include the following:

- Configuring system devices and installed options
- Enabling and disabling system features
- Displaying system information
- Selecting the primary boot controller
- Configuring memory options
- Language selection

For more information on RBSU, see the *HP ROM-Based Setup Utility User Guide* on the Documentation CD or the HP website (http://www.hp.com/support/rbsu).

Using RBSU

To use RBSU, use the following keys:

- To access RBSU, press the **F9** key during power-up when prompted.
- To navigate the menu system, use the arrow keys.
- To make selections, press the **Enter** key.
- To access Help for a highlighted configuration option, press the **F1** key.

IMPORTANT: RBSU automatically saves settings when you press the **Enter** key. The utility does not prompt you for confirmation of settings before you exit the utility. To change a selected setting, you must select a different setting and press the **Enter** key.

Default configuration settings are applied to the server at one of the following times:

- Upon the first system power-up
- After defaults have been restored

Default configuration settings are sufficient for proper typical server operation, but configuration settings can be modified using RBSU. The system will prompt you for access to RBSU with each power-up.

Auto-configuration process

The auto-configuration process automatically runs when you boot the server for the first time. During the power-up sequence, the system ROM automatically configures the entire system without needing any intervention. During this process, the ORCA utility, in most cases, automatically configures the array to a default setting based on the number of drives connected to the server.

NOTE: If the boot drive is not empty or has been written to in the past, ORCA does not automatically configure the array. You must run ORCA to configure the array settings.

NOTE: The server may not support all the following examples.

Drives installed	Drives used	RAID level
1	1	RAID 0
2	2	RAID 1
3, 4, 5, or 6	3, 4, 5, or 6	RAID 5
More than 6	0	None

To change any ORCA default settings and override the auto-configuration process, press the **F8** key when prompted.

For more information on RBSU, see the *HP ROM-Based Setup Utility User Guide* on the Documentation CD or the HP website (http://www.hp.com/support/rbsu).

Boot options

Near the end of the boot process, the boot options screen is displayed. This screen is visible for several seconds before the system attempts to boot from a supported boot device. During this time, you can do the following:

- Access RBSU by pressing the **F9** key.
- Access Intelligent Provisioning Maintenance Menu by pressing the **F10** key.
- Access the boot menu by pressing the **F11** key.
- Force a PXE Network boot by pressing the **F12** key.

Configuring AMP modes

Not all ProLiant servers support all AMP modes. RBSU provides menu options only for the modes supported by the server. Advanced memory protection within RBSU enables the following advanced memory modes:

- Advanced ECC Mode—Provides memory protection beyond Standard ECC. All single-bit failures and some multi-bit failures can be corrected without resulting in system downtime.
- Online Spare Mode—Provides protection against failing or degraded DIMMs. Certain memory is set aside as spare, and automatic failover to spare memory occurs when the system detects a degraded DIMM. DIMMs that are likely to receive a fatal or uncorrectable memory error are removed from operation automatically, resulting in less system downtime.

For DIMM population requirements, see the server-specific user guide.

Re-entering the server serial number and product ID

After you replace the system board, you must re-enter the server serial number and the product ID.

1. During the server startup sequence, press the **F9** key to access RBSU.
2. Select the **Advanced Options** menu.
3. Select **Service Options**.
4. Select **Serial Number**. The following warnings appear:

   ```
   WARNING! WARNING! WARNING! The serial number is loaded into the system during the manufacturing process and should NOT be modified. This option should only be used by qualified service personnel. This value should always match the serial number sticker located on the chassis.
   ```

   ```
   Warning: The serial number should ONLY be modified by qualified service personnel. This value should always match the serial number located on the chassis.
   ```
5. Press the **Enter** key to clear the warning.
6. Enter the serial number and press the **Enter** key.
7. Select **Product ID**. The following warning appears:

   ```
   Warning: The Product ID should ONLY be modified by qualified service personnel. This value should always match the Product ID on the chassis.
   ```
8. Enter the product ID and press the **Enter** key.
9. Press the **Esc** key to close the menu.
10. Press the **Esc** key to exit RBSU.
11. Press the **F10** key to confirm exiting RBSU. The server automatically reboots.

Utilities and features

Array Configuration Utility

ACU is a utility with the following features:

- Runs as a local application or remote service accessed through the HP System Management Homepage
- Supports online array capacity expansion, logical drive extension, assignment of online spares, and RAID or stripe size migration
- Suggests the optimum configuration for an unconfigured system
- For supported controllers, provides access to licensed features, including:
  - Moving and deleting individual logical volumes
  - Advanced Capacity Expansion (SATA to SAS and SAS to SATA)
  - Offline Split Mirror
  - RAID 6 and RAID 60
  - RAID 1 (ADM) and RAID 10 (ADM)
  - HP Drive Erase
  - Video-On-Demand Advanced Controller Settings
- Provides different operating modes, enabling faster configuration or greater control over the configuration options
- Remains available any time that the server is on
- Displays on-screen tips for individual steps of a configuration procedure
- Provides context-sensitive searchable help content
- Provides diagnostic and SmartSSD Wear Gauge functionality on the Diagnostics tab

ACU is now available as an embedded utility, starting with HP ProLiant Gen8 servers. To access ACU, use one of the following methods:

- If an optional controller is not installed, press **F10** during boot.
- If an optional controller is installed, when the system recognizes the controller during POST, press **F5**.

For optimum performance, the minimum display settings are 1024 × 768 resolution and 16-bit color. Servers running Microsoft® operating systems require one of the following supported browsers:

- Internet Explorer 6.0 or later
- Mozilla Firefox 2.0 or later

For Linux servers, see the README.TXT file for additional browser and support information.

For more information about the controller and its features, see the *HP Smart Array Controllers for HP ProLiant Servers User Guide* on the HP website (http://www.hp.com/support/SAC_UG_ProLiantServers_en). To configure arrays, see the *Configuring Arrays on HP Smart Array Controllers Reference Guide* on the HP website (http://www.hp.com/support/CASAC_RG_en).

Option ROM Configuration for Arrays

Before installing an operating system, you can use the ORCA utility to create the first logical drive, assign RAID levels, and establish online spare configurations.

The utility also provides support for the following functions:

- Reconfiguring one or more logical drives
- Viewing the current logical drive configuration
- Deleting a logical drive configuration
- Setting the controller to be the boot controller
- Selecting the boot volume

If you do not use the utility, ORCA will default to the standard configuration.

For more information regarding the default configurations that ORCA uses, see the *HP ROM-Based Setup Utility User Guide* on the Documentation CD or the HP website (http://www.hp.com/support/rbsu).

For more information about the controller and its features, see the *HP Smart Array Controllers for HP ProLiant Servers User Guide* on the HP website (http://www.hp.com/support/SAC_UG_ProLiantServers_en). To configure arrays, see the *Configuring Arrays on HP Smart Array Controllers Reference Guide* on the HP website (http://www.hp.com/support/CASAC_RG_en).

ROMPaq utility

The ROMPaq utility enables you to upgrade the system firmware (BIOS). To upgrade the firmware, insert a ROMPaq USB Key into an available USB port and boot the system. In addition to ROMPaq, Online Flash Components for Windows and Linux operating systems are available for updating the system firmware.

The ROMPaq utility checks the system and provides a choice (if more than one exists) of available firmware revisions.

For more information, go to the HP website (http://www.hp.com/go/hpsc) and click on **Drivers, Software & Firmware**. Then, enter your product name in the **Find an HP product** field and click **Go**.

Automatic Server Recovery

ASR is a feature that causes the system to restart when a catastrophic operating system error occurs, such as a blue screen, ABEND (does not apply to HP ProLiant DL980 Servers), or panic. A system fail-safe timer, the ASR timer, starts when the System Management driver, also known as the Health Driver, is loaded. When the operating system is functioning properly, the system periodically resets the timer. However, when the operating system fails, the timer expires and restarts the server.

ASR increases server availability by restarting the server within a specified time after a system hang. At the same time, the HP SIM console notifies you by sending a message to a designated pager number that ASR has restarted the system. You can disable ASR from the System Management Homepage or through RBSU.

USB support

HP provides both standard USB 2.0 support and legacy USB 2.0 support. Standard support is provided by the OS through the appropriate USB device drivers. Before the OS loads, HP provides support for USB devices through legacy USB support, which is enabled by default in the system ROM.

Legacy USB support provides USB functionality in environments where USB support is not available normally. Specifically, HP provides legacy USB functionality for the following:

- POST
- RBSU
- Diagnostics
- DOS
- Operating environments which do not provide native USB support

Redundant ROM support

The server enables you to upgrade or configure the ROM safely with redundant ROM support. The server has a single ROM that acts as two separate ROM images. In the standard implementation, one side of the ROM contains the current ROM program version, while the other side of the ROM contains a backup version.

NOTE: The server ships with the same version programmed on each side of the ROM.

Safety and security benefits

When you flash the system ROM, ROMPaq writes over the backup ROM and saves the current ROM as a backup, enabling you to switch easily to the alternate ROM version if the new ROM becomes corrupted for any reason. This feature protects the existing ROM version, even if you experience a power failure while flashing the ROM.

Keeping the system current

Drivers

IMPORTANT: Always perform a backup before installing or updating device drivers.

The server includes new hardware that may not have driver support on all OS installation media.

If you are installing an Intelligent Provisioning-supported OS, use Intelligent Provisioning and its Configure and Install feature to install the OS and latest supported drivers.

If you do not use Intelligent Provisioning to install an OS, drivers for some of the new hardware are required. These drivers, as well as other option drivers, ROM images, and value-add software can be downloaded as part of an SPP.

If you are installing drivers from SPP, be sure that you are using the latest SPP version that your server supports. To verify that your server is using the latest supported version and for more information about SPP, see the HP website (http://www.hp.com/go/spp/download).

To locate the drivers for a particular server, go to the HP website (http://www.hp.com/go/hpsc) and click on **Drivers, Software & Firmware**. Then, enter your product name in the **Find an HP product** field and click **Go**.

Software and firmware

Software and firmware should be updated before using the server for the first time, unless any installed software or components require an older version. For system software and firmware updates, download the SPP ("HP Service Pack for ProLiant" on page 72) from the HP website (http://www.hp.com/go/spp).

Version control

The VCRM and VCA are web-enabled Insight Management Agents tools that HP SIM uses to schedule software update tasks to the entire enterprise.

- VCRM manages the repository for SPP. Administrators can view the SPP contents or configure VCRM to automatically update the repository with internet downloads of the latest software and firmware from HP.
- VCA compares installed software versions on the node with updates available in the VCRM managed repository. Administrators configure VCA to point to a repository managed by VCRM.

For more information about version control tools, see the *HP Systems Insight Manager User Guide,* the *HP Version Control Agent User Guide*, and the *HP Version Control Repository User Guide* on the HP website (http://www.hp.com/go/hpsim).

HP Operating Systems and Virtualization Software Support for ProLiant Servers

For information about specific versions of a supported operating system, see the HP website (http://www.hp.com/go/ossupport).

HP Technology Service Portfolio

HP Technology Services offers a targeted set of consultancy, deployment, and service solutions designed to meet the support needs of the most business and IT environments.

Foundation Care services deliver scalable hardware and software support packages for HP ProLiant server and industry-standard software. You can choose the type and level of service that is most suitable for your business needs.

HP Collaborative Support —With a single call, HP addresses initial hardware and software support needs and helps to quickly identify if a problem is related to hardware or software. If the problem is identified as hardware, HP will resolve as per service level commitments. If the reported incident is related to HP or supported 3rd party software product and cannot be resolved by applying known fixes, HP will contact the third-party vendor and create a problem incident on the your behalf.

HP Proactive Care — For customers running business critical environments where down time is not an option, then HP Proactive Care helps to deliver high levels of application availability. Key to these service options is the delivery of proactive service management offers to help you avoid the causes of down time. If a problems arises than HP offers advanced technical response from critical system support specialist for fast problem identification and resolution.

HP Support Center — All service options include HP Support Center delivering information, tools, and experts required to support HP business products.

HP Insight Remote Support — Provides 24x7 secure remote monitoring, diagnosis and problem resolution.

For more information, see the HP website (http://www.hp.com/services/proliant) or the HP website for the HP BladeSystem (http://www.hp.com/services/bladesystem).

Change control and proactive notification

HP offers Change Control and Proactive Notification to notify customers 30 to 60 days in advance of upcoming hardware and software changes on HP commercial products.

For more information, refer to the HP website (http://www.hp.com/go/pcn).

Troubleshooting

Troubleshooting resources

The *HP ProLiant Gen8 Troubleshooting Guide, Volume I: Troubleshooting* provides procedures for resolving common problems and comprehensive courses of action for fault isolation and identification, issue resolution, and software maintenance on ProLiant servers and server blades. To view the guide, select a language:

- English (http://www.hp.com/support/ProLiant_TSG_v1_en)
- French (http://www.hp.com/support/ProLiant_TSG_v1_fr)
- Spanish (http://www.hp.com/support/ProLiant_TSG_v1_sp)
- German (http://www.hp.com/support/ProLiant_TSG_v1_gr)
- Japanese (http://www.hp.com/support/ProLiant_TSG_v1_jp)
- Simplified Chinese (http://www.hp.com/support/ProLiant_TSG_v1_sc)

The *HP ProLiant Gen8 Troubleshooting Guide, Volume II: Error Messages* provides a list of error messages and information to assist with interpreting and resolving error messages on ProLiant servers and server blades. To view the guide, select a language:

- English (http://www.hp.com/support/ProLiant_EMG_v1_en)
- French (http://www.hp.com/support/ProLiant_EMG_v1_fr)
- Spanish (http://www.hp.com/support/ProLiant_EMG_v1_sp)
- German (http://www.hp.com/support/ProLiant_EMG_v1_gr)
- Japanese (http://www.hp.com/support/ProLiant_EMG_v1_jp)
- Simplified Chinese (http://www.hp.com/support/ProLiant_EMG_v1_sc)

System battery

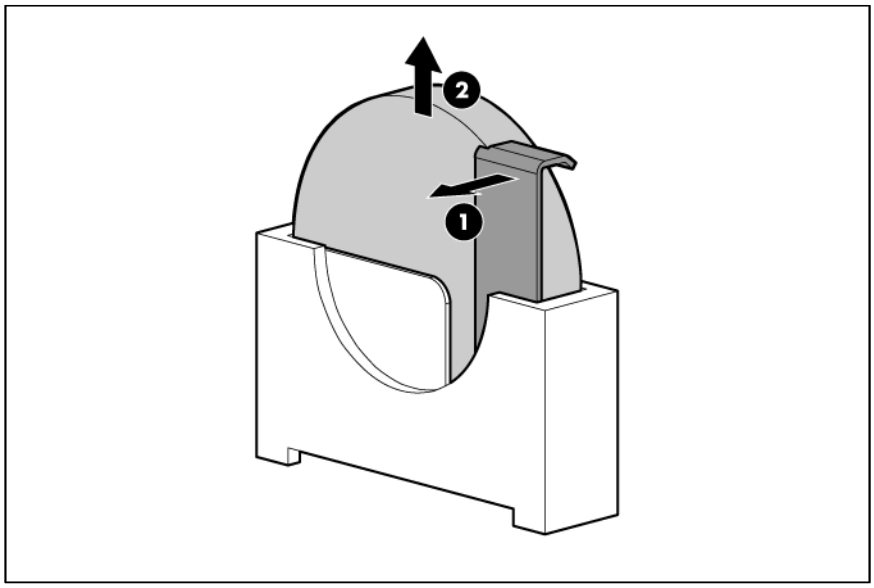
If the server no longer automatically displays the correct date and time, you might have to replace the battery that provides power to the real-time clock. Under normal use, battery life is 5 to 10 years.

WARNING: The computer contains an internal lithium manganese dioxide, a vanadium pentoxide, or an alkaline battery pack. A risk of fire and burns exists if the battery pack is not properly handled. To reduce the risk of personal injury:

- Do not attempt to recharge the battery.
- Do not expose the battery to temperatures higher than 60°C (140°F).
- Do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water.
- Replace only with the spare designated for this product.

To remove the component:

1. Power down the server (on page 15).
2. Disconnect all peripheral cables from the server.
3. Remove the server from the chassis (on page 15).
4. If installed, remove the PCI riser board assembly.
5. Locate the battery on the system board ("System board components" on page 9).
6. Remove the battery.



IMPORTANT: Replacing the system board battery resets the system ROM to its default configuration. After replacing the battery, reconfigure the system through RBSU.

To replace the component, reverse the removal procedure.

For more information about battery replacement or proper disposal, contact an authorized reseller or an authorized service provider.

Regulatory compliance notices

Regulatory compliance identification numbers

For the purpose of regulatory compliance certifications and identification, this product has been assigned a unique regulatory model number. The regulatory model number can be found on the product nameplate label, along with all required approval markings and information. When requesting compliance information for this product, always refer to this regulatory model number. The regulatory model number is not the marketing name or model number of the product.

Federal Communications Commission notice

Part 15 of the Federal Communications Commission (FCC) Rules and Regulations has established Radio Frequency (RF) emission limits to provide an interference-free radio frequency spectrum. Many electronic devices, including computers, generate RF energy incidental to their intended function and are, therefore, covered by these rules. These rules place computers and related peripheral devices into two classes, A and B, depending upon their intended installation. Class A devices are those that may reasonably be expected to be installed in a business or commercial environment. Class B devices are those that may reasonably be expected to be installed in a residential environment (for example, personal computers). The FCC requires devices in both classes to bear a label indicating the interference potential of the device as well as additional operating instructions for the user.

FCC rating label

The FCC rating label on the device shows the classification (A or B) of the equipment. Class B devices have an FCC logo or ID on the label. Class A devices do not have an FCC logo or ID on the label. After you determine the class of the device, refer to the corresponding statement.

FCC Notice, Class A Equipment

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference, in which case the user will be required to correct the interference at personal expense.

FCC Notice, Class B Equipment

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to

radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit that is different from that to which the receiver is connected.
- Consult the dealer or an experienced radio or television technician for help.

Declaration of conformity for products marked with the FCC logo, United States only

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

For questions regarding this product, contact us by mail or telephone:

- Hewlett-Packard Company
  P. O. Box 692000, Mail Stop 530113
  Houston, Texas 77269-2000
- 1-800-HP-INVENT (1-800-474-6836). (For continuous quality improvement, calls may be recorded or monitored.)

For questions regarding this FCC declaration, contact us by mail or telephone:

- Hewlett-Packard Company
  P. O. Box 692000, Mail Stop 510101
  Houston, Texas 77269-2000
- 1-281-514-3333

To identify this product, refer to the part, series, or model number found on the product.

Modifications

The FCC requires the user to be notified that any changes or modifications made to this device that are not expressly approved by Hewlett-Packard Company may void the user's authority to operate the equipment.

Cables

Connections to this device must be made with shielded cables with metallic RFI/EMI connector hoods in order to maintain compliance with FCC Rules and Regulations.

Canadian notice (Avis Canadien)

Class A equipment

This Class A digital apparatus meets all requirements of the Canadian Interference-Causing Equipment Regulations.

Cet appareil numérique de la classe A respecte toutes les exigences du Règlement sur le matériel brouilleur du Canada.

Class B equipment

This Class B digital apparatus meets all requirements of the Canadian Interference-Causing Equipment Regulations.

Cet appareil numérique de la classe B respecte toutes les exigences du Règlement sur le matériel brouilleur du Canada.

European Union regulatory notice

Products bearing the CE marking comply with the following EU Directives:

- Low Voltage Directive 2006/95/EC
- EMC Directive 2004/108/EC
- Ecodesign Directive 2009/125/EC, where applicable

CE compliance of this product is valid if powered with the correct CE-marked AC adapter provided by HP.

Compliance with these directives implies conformity to applicable harmonized European standards (European Norms) that are listed in the EU Declaration of Conformity issued by HP for this product or product family and available (in English only) either within the product documentation or at the following HP website (http://www.hp.eu/certificates) (type the product number in the search field).

The compliance is indicated by one of the following conformity markings placed on the product:

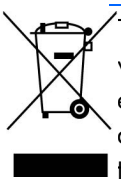
For non-telecommunications products and for EU harmonized telecommunications products, such as Bluetooth® within power class below 10mW.

For EU non-harmonized telecommunications products (If applicable, a 4-digit notified body number is inserted between CE and !).

Please refer to the regulatory label provided on the product.

The point of contact for regulatory matters is Hewlett-Packard GmbH, Dept./MS: HQ-TRE, Herrenberger Strasse 140, 71034 Boeblingen, GERMANY.

Disposal of waste equipment by users in private households in the European Union



This symbol on the product or on its packaging indicates that this product must not be disposed of with your other household waste. Instead, it is your responsibility to dispose of your waste equipment by handing it over to a designated collection point for the recycling of waste electrical and electronic equipment. The separate collection and recycling of your waste equipment at the time of disposal will help to conserve natural resources and ensure that it is recycled in a manner that protects human health and the environment. For more information about where you can drop off your waste equipment for recycling, please contact your local city office, your household waste disposal service or the shop where you purchased the product.

Japanese notice

ご使用になっている装置に VCCI マークが付いていましたら、次の説明文をお読み下さい。

この装置は、クラス B 情報技術装置です。この装置は、家庭環境で使用することを目的としていますが、この装置がラジオやテレビジョン受信機に近接して使用されると、受信障害を引き起こすことがあります。取扱説明書に従って正しい取り扱いをして下さい。

VCCI-B

VCCI マークが付いていない場合には、次の点にご注意下さい。

この装置は、クラス A 情報技術装置です。この装置を家庭環境で使用すると電波妨害を引き起こすことがあります。この場合には使用者は適切な対策を講ずるよう要求されることがあります。

VCCI-A

BSMI notice

警告使用者:

這是甲類的資訊產品，在居住的環境中使用時，可能會造成射頻干擾，在這種情況下，使用者會被要求採取某些適當的對策。

Korean notice

Class A equipment

A급 기기 (업무용 방송통신기기)	이 기기는 업무용(A급)으로 전자파적합등록을 한 기기이오니 판매자 또는 사용자는 이 점을 주의하시기 바라며, 가정 외의 지역에서 사용하는 것을 목적으로 합니다.

Class B equipment

B급 기기 (가정용 방송통신기기)	이 기기는 가정용(B급)으로 전자파적합등록을 한 기기로서 주로 가정에서 사용하는 것을 목적으로 하며, 모든 지역에서 사용할 수 있습니다.

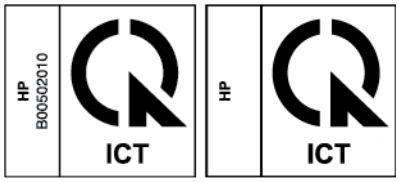
Chinese notice

Class A equipment

声明
此为 A 级产品，在生活环境中，该产品可能会造成无线电干扰。在这种情况下，可能需要用户对其干扰采取可行的措施。

Vietnam compliance marking notice

This marking is for applicable products only.



Ukraine notice

Україна
Додаток до документації користувача

Обладнання відповідає вимогам Технічного регламенту щодо обмеження використання деяких небезпечних речовин в електричному та електронному обладнанні, затвердженого постановою Кабінету Міністрів України від 3 грудня 2008 № 1057

Збережіть цей документ разом із документацією користувача для цього виробу

Laser compliance

This product may be provided with an optical storage device (that is, CD or DVD drive) and/or fiber optic transceiver. Each of these devices contains a laser that is classified as a Class 1 Laser Product in accordance with US FDA regulations and the IEC 60825-1. The product does not emit hazardous laser radiation.

Each laser product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated June 24, 2007; and with IEC 60825-1:2007.

⚠ **WARNING:** Use of controls or adjustments or performance of procedures other than those specified herein or in the laser product's installation guide may result in hazardous radiation exposure. To reduce the risk of exposure to hazardous radiation:

- Do not try to open the module enclosure. There are no user-serviceable components inside.
- Do not operate controls, make adjustments, or perform procedures to the laser device other than those specified herein.
- Allow only HP Authorized Service technicians to repair the unit.

The Center for Devices and Radiological Health (CDRH) of the U.S. Food and Drug Administration implemented regulations for laser products on August 2, 1976. These regulations apply to laser products manufactured from August 1, 1976. Compliance is mandatory for products marketed in the United States.

Battery replacement notice

⚠ **WARNING:** The computer contains an internal lithium manganese dioxide, a vanadium pentoxide, or an alkaline battery pack. A risk of fire and burns exists if the battery pack is not properly handled. To reduce the risk of personal injury:

- Do not attempt to recharge the battery.
- Do not expose the battery to temperatures higher than 60°C (140°F).
- Do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water.

Batteries, battery packs, and accumulators should not be disposed of together with the general household waste. To forward them to recycling or proper disposal, use the public collection system or return them to HP, an authorized HP Partner, or their agents.

For more information about battery replacement or proper disposal, contact an authorized reseller or an authorized service provider.

Taiwan battery recycling notice

The Taiwan EPA requires dry battery manufacturing or importing firms in accordance with Article 15 of the Waste Disposal Act to indicate the recovery marks on the batteries used in sales, giveaway or promotion. Contact a qualified Taiwanese recycler for proper battery disposal.

Power cord statement for Japan

製品には、同梱された電源コードをお使い下さい。
同梱された電源コードは、他の製品では使用出来ません。

Acoustics statement for Germany (Geräuschemission)

Schalldruckpegel L_{pA} < 70 dB(A)

Zuschauerpositionen (bystander positions), Normaler Betrieb (normal operation)

Nach ISO 7779:1999 (Typprüfung)

Electrostatic discharge

Preventing electrostatic discharge

To prevent damaging the system, be aware of the precautions you need to follow when setting up the system or handling parts. A discharge of static electricity from a finger or other conductor may damage system boards or other static-sensitive devices. This type of damage may reduce the life expectancy of the device.

To prevent electrostatic damage:

- Avoid hand contact by transporting and storing products in static-safe containers.
- Keep electrostatic-sensitive parts in their containers until they arrive at static-free workstations.
- Place parts on a grounded surface before removing them from their containers.
- Avoid touching pins, leads, or circuitry.
- Always be properly grounded when touching a static-sensitive component or assembly.

Grounding methods to prevent electrostatic discharge

Several methods are used for grounding. Use one or more of the following methods when handling or installing electrostatic-sensitive parts:

- Use a wrist strap connected by a ground cord to a grounded workstation or computer chassis. Wrist straps are flexible straps with a minimum of 1 megohm ±10 percent resistance in the ground cords. To provide proper ground, wear the strap snug against the skin.
- Use heel straps, toe straps, or boot straps at standing workstations. Wear the straps on both feet when standing on conductive floors or dissipating floor mats.
- Use conductive field service tools.
- Use a portable field service kit with a folding static-dissipating work mat.

If you do not have any of the suggested equipment for proper grounding, have an authorized reseller install the part.

For more information on static electricity or assistance with product installation, contact an authorized reseller.

Specifications

Environmental specifications

Specification	Value
Temperature range*	
Operating	10°C to 35°C (50°F to 95°F)
Shipping	-40°C to 70°C (-40°F to 158°F)
Maximum wet bulb temperature	28°C (82.4°F)
Relative humidity (noncondensing)**	
Operating	10% to 90%
Nonoperating	5% to 95%

* All temperature ratings shown are for sea level. An altitude derating of 1°C per 300 m (1.8°F per 1,000 ft) to 3,048 m (10,000 ft) is applicable. No direct sunlight allowed.
** Storage maximum humidity of 95% is based on a maximum temperature of 45°C (113°F). Altitude maximum for storage corresponds to a pressure minimum of 70 kPa.

Server specifications

Specification	Value
Height	16.82 cm (6.62 in)
Depth	81.91 cm (32.25 in)
Width	22.08 cm (8.69 in)
Weight (maximum: two processors, eight hard drives)	21.32 kg (47.00 lb)

Hot-plug power supply calculations

For hot-plug power supply specifications and calculators to determine electrical and heat loading for the server, refer to the HP Enterprise Configurator website (http://h30099.www3.hp.com/configurator/).

Support and other resources

Before you contact HP

Be sure to have the following information available before you call HP:

- Active Health System log

  Download and have available an Active Health System log for 3 days before the failure was detected. For more information, see the *HP iLO 4 User Guide* or *HP Intelligent Provisioning User Guide* on the HP website (http://www.hp.com/go/ilo/docs).

- Onboard Administrator SHOW ALL report (for HP BladeSystem products only)

  For more information on obtaining the Onboard Administrator SHOW ALL report, see the HP website (http://h20000.www2.hp.com/bizsupport/TechSupport/Document.jsp?lang=en&cc=us&objectID=c02843807).

- Technical support registration number (if applicable)
- Product serial number
- Product model name and number
- Product identification number
- Applicable error messages
- Add-on boards or hardware
- Third-party hardware or software
- Operating system type and revision level

HP contact information

For United States and worldwide contact information, see the Contact HP website (http://www.hp.com/go/assistance).

In the United States:

- To contact HP by phone, call 1-800-334-5144. For continuous quality improvement, calls may be recorded or monitored.
- If you have purchased a Care Pack (service upgrade), see the Support & Drivers website (http://www8.hp.com/us/en/support-drivers.html). If the problem cannot be resolved at the website, call 1-800-633-3600. For more information about Care Packs, see the HP website (http://pro-aq-sama.houston.hp.com/services/cache/10950-0-0-225-121.html).

Customer Self Repair

HP products are designed with many Customer Self Repair (CSR) parts to minimize repair time and allow for greater flexibility in performing defective parts replacement. If during the diagnosis period HP (or HP service

providers or service partners) identifies that the repair can be accomplished by the use of a CSR part, HP will ship that part directly to you for replacement. There are two categories of CSR parts:

- **Mandatory**—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.
- **Optional**—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

NOTE: Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

Based on availability and where geography permits, CSR parts will be shipped for next business day delivery. Same day or four-hour delivery may be offered at an additional charge where geography permits. If assistance is required, you can call the HP Technical Support Center and a technician will help you over the telephone. HP specifies in the materials shipped with a replacement CSR part whether a defective part must be returned to HP. In cases where it is required to return the defective part to HP, you must ship the defective part back to HP within a defined period of time, normally five (5) business days. The defective part must be returned with the associated documentation in the provided shipping material. Failure to return the defective part may result in HP billing you for the replacement. With a customer self repair, HP will pay all shipping and part return costs and determine the courier/carrier to be used.

For more information about HP's Customer Self Repair program, contact your local service provider. For the North American program, refer to the HP website (http://www.hp.com/go/selfrepair).

Réparation par le client (CSR)

Les produits HP comportent de nombreuses pièces CSR (Customer Self Repair = réparation par le client) afin de minimiser les délais de réparation et faciliter le remplacement des pièces défectueuses. Si pendant la période de diagnostic, HP (ou ses partenaires ou mainteneurs agréés) détermine que la réparation peut être effectuée à l'aide d'une pièce CSR, HP vous l'envoie directement. Il existe deux catégories de pièces CSR:

Obligatoire - Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

Facultatif - Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

REMARQUE: Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

Les pièces CSR sont livrées le jour ouvré suivant, dans la limite des stocks disponibles et selon votre situation géographique. Si votre situation géographique le permet et que vous demandez une livraison le jour même ou dans les 4 heures, celle-ci vous sera facturée. Pour bénéficier d'une assistance téléphonique, appelez le Centre d'assistance technique HP. Dans les documents envoyés avec la pièce de rechange CSR, HP précise s'il est nécessaire de lui retourner la pièce défectueuse. Si c'est le cas, vous devez le faire dans le délai indiqué, généralement cinq (5) jours ouvrés. La pièce et sa documentation doivent être retournées dans l'emballage fourni. Si vous ne retournez pas la pièce défectueuse, HP se réserve le droit de vous facturer les coûts de remplacement. Dans le cas d'une pièce CSR, HP supporte l'ensemble des frais d'expédition et de retour, et détermine la société de courses ou le transporteur à utiliser.

Pour plus d'informations sur le programme CSR de HP, contactez votre Mainteneur Agrée local. Pour plus d'informations sur ce programme en Amérique du Nord, consultez le site Web HP (http://www.hp.com/go/selfrepair).

Riparazione da parte del cliente

Per abbreviare i tempi di riparazione e garantire una maggiore flessibilità nella sostituzione di parti difettose, i prodotti HP sono realizzati con numerosi componenti che possono essere riparati direttamente dal cliente (CSR, Customer Self Repair). Se in fase di diagnostica HP (o un centro di servizi o di assistenza HP) identifica il guasto come riparabile mediante un ricambio CSR, HP lo spedirà direttamente al cliente per la sostituzione. Vi sono due categorie di parti CSR:

Obbligatorie – Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.

Opzionali – Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

NOTA: alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

In base alla disponibilità e alla località geografica, le parti CSR vengono spedite con consegna entro il giorno lavorativo seguente. La consegna nel giorno stesso o entro quattro ore è offerta con un supplemento di costo solo in alcune zone. In caso di necessità si può richiedere l'assistenza telefonica di un addetto del centro di supporto tecnico HP. Nel materiale fornito con una parte di ricambio CSR, HP specifica se il cliente deve restituire dei componenti. Qualora sia richiesta la resa ad HP del componente difettoso, lo si deve spedire ad HP entro un determinato periodo di tempo, generalmente cinque (5) giorni lavorativi. Il componente difettoso deve essere restituito con la documentazione associata nell'imballo di spedizione fornito. La mancata restituzione del componente può comportare la fatturazione del ricambio da parte di HP. Nel caso di riparazione da parte del cliente, HP sostiene tutte le spese di spedizione e resa e sceglie il corriere/vettore da utilizzare.

Per ulteriori informazioni sul programma CSR di HP contattare il centro di assistenza di zona. Per il programma in Nord America fare riferimento al sito Web HP (http://www.hp.com/go/selfrepair).

Customer Self Repair

HP Produkte enthalten viele CSR-Teile (Customer Self Repair), um Reparaturzeiten zu minimieren und höhere Flexibilität beim Austausch defekter Bauteile zu ermöglichen. Wenn HP (oder ein HP Servicepartner) bei der Diagnose feststellt, dass das Produkt mithilfe eines CSR-Teils repariert werden kann, sendet Ihnen HP dieses Bauteil zum Austausch direkt zu. CSR-Teile werden in zwei Kategorien unterteilt:

Zwingend – Teile, für die das Customer Self Repair-Verfahren zwingend vorgegeben ist. Wenn Sie den Austausch dieser Teile von HP vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

Optional – Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

HINWEIS: Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No“ bzw. „Nein“ gekennzeichnet.

CSR-Teile werden abhängig von der Verfügbarkeit und vom Lieferziel am folgenden Geschäftstag geliefert. Für bestimmte Standorte ist eine Lieferung am selben Tag oder innerhalb von vier Stunden gegen einen Aufpreis verfügbar. Wenn Sie Hilfe benötigen, können Sie das HP technische Support Center anrufen und sich von einem Mitarbeiter per Telefon helfen lassen. Den Materialien, die mit einem CSR-Ersatzteil geliefert werden, können Sie entnehmen, ob das defekte Teil an HP zurückgeschickt werden muss. Wenn es erforderlich ist, das defekte Teil an HP zurückzuschicken, müssen Sie dies innerhalb eines vorgegebenen Zeitraums tun, in der Regel innerhalb von fünf (5) Geschäftstagen. Das defekte Teil muss mit der zugehörigen Dokumentation in der Verpackung zurückgeschickt werden, die im Lieferumfang enthalten ist. Wenn Sie das defekte Teil nicht zurückschicken, kann HP Ihnen das Ersatzteil in Rechnung stellen. Im Falle von Customer Self Repair kommt HP für alle Kosten für die Lieferung und Rücksendung auf und bestimmt den Kurier-/Frachtdienst.

Weitere Informationen über das HP Customer Self Repair Programm erhalten Sie von Ihrem Servicepartner vor Ort. Informationen über das CSR-Programm in Nordamerika finden Sie auf der HP Website unter (http://www.hp.com/go/selfrepair).

Reparaciones del propio cliente

Los productos de HP incluyen muchos componentes que el propio usuario puede reemplazar (*Customer Self Repair*, CSR) para minimizar el tiempo de reparación y ofrecer una mayor flexibilidad a la hora de realizar sustituciones de componentes defectuosos. Si, durante la fase de diagnóstico, HP (o los proveedores o socios de servicio de HP) identifica que una reparación puede llevarse a cabo mediante el uso de un componente CSR, HP le enviará dicho componente directamente para que realice su sustitución. Los componentes CSR se clasifican en dos categorías:

- **Obligatorio:** componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.
- **Opcional:** componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

NOTA: Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

Según la disponibilidad y la situación geográfica, los componentes CSR se enviarán para que lleguen a su destino al siguiente día laborable. Si la situación geográfica lo permite, se puede solicitar la entrega en el mismo día o en cuatro horas con un coste adicional. Si precisa asistencia técnica, puede llamar al Centro de asistencia técnica de HP y recibirá ayuda telefónica por parte de un técnico. Con el envío de materiales para la sustitución de componentes CSR, HP especificará si los componentes defectuosos deberán devolverse a HP. En aquellos casos en los que sea necesario devolver algún componente a HP, deberá hacerlo en el periodo de tiempo especificado, normalmente cinco días laborables. Los componentes defectuosos deberán devolverse con toda la documentación relacionada y con el embalaje de envío. Si no enviara el componente defectuoso requerido, HP podrá cobrarle por el de sustitución. En el caso de todas

sustituciones que lleve a cabo el cliente, HP se hará cargo de todos los gastos de envío y devolución de componentes y escogerá la empresa de transporte que se utilice para dicho servicio.

Para obtener más información acerca del programa de Reparaciones del propio cliente de HP, póngase en contacto con su proveedor de servicios local. Si está interesado en el programa para Norteamérica, visite la página web de HP siguiente (http://www.hp.com/go/selfrepair).

Customer Self Repair

Veel onderdelen in HP producten zijn door de klant zelf te repareren, waardoor de reparatieduur tot een minimum beperkt kan blijven en de flexibiliteit in het vervangen van defecte onderdelen groter is. Deze onderdelen worden CSR-onderdelen (Customer Self Repair) genoemd. Als HP (of een HP Service Partner) bij de diagnose vaststelt dat de reparatie kan worden uitgevoerd met een CSR-onderdeel, verzendt HP dat onderdeel rechtstreeks naar u, zodat u het defecte onderdeel daarmee kunt vervangen. Er zijn twee categorieën CSR-onderdelen:

Verplicht: Onderdelen waarvoor reparatie door de klant verplicht is. Als u HP verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.

Optioneel: Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

OPMERKING: Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorwaarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

Afhankelijk van de leverbaarheid en de locatie worden CSR-onderdelen verzonden voor levering op de eerstvolgende werkdag. Levering op dezelfde dag of binnen vier uur kan tegen meerkosten worden aangeboden, indien dit mogelijk is gezien de locatie. Indien assistentie gewenst is, belt u een HP Service Partner om via de telefoon technische ondersteuning te ontvangen. HP vermeldt in de documentatie bij het vervangende CSR-onderdeel of het defecte onderdeel aan HP moet worden geretourneerd. Als het defecte onderdeel aan HP moet worden teruggezonden, moet u het defecte onderdeel binnen een bepaalde periode, gewoonlijk vijf (5) werkdagen, retourneren aan HP. Het defecte onderdeel moet met de bijbehorende documentatie worden geretourneerd in het meegeleverde verpakkingsmateriaal. Als u het defecte onderdeel niet terugzendt, kan HP u voor het vervangende onderdeel kosten in rekening brengen. Bij reparatie door de klant betaalt HP alle verzendkosten voor het vervangende en geretourneerde onderdeel en kiest HP zelf welke koerier/transportonderneming hiervoor wordt gebruikt.

Neem contact op met een Service Partner voor meer informatie over het Customer Self Repair programma van HP. Informatie over Service Partners vindt u op de HP website (http://www.hp.com/go/selfrepair).

Reparo feito pelo cliente

Os produtos da HP são projetados com muitas peças para reparo feito pelo cliente (CSR) de modo a minimizar o tempo de reparo e permitir maior flexibilidade na substituição de peças com defeito. Se, durante o período de diagnóstico, a HP (ou fornecedores/parceiros de serviço da HP) concluir que o reparo pode ser efetuado pelo uso de uma peça CSR, a peça de reposição será enviada diretamente ao cliente. Existem duas categorias de peças CSR:

Obrigatória – Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

Opcional – Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

OBSERVAÇÃO: Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

Conforme a disponibilidade e o local geográfico, as peças CSR serão enviadas no primeiro dia útil após o pedido. Onde as condições geográficas permitirem, a entrega no mesmo dia ou em quatro horas pode ser feita mediante uma taxa adicional. Se precisar de auxílio, entre em contato com o Centro de suporte técnico da HP para que um técnico o ajude por telefone. A HP especifica nos materiais fornecidos com a peça CSR de reposição se a peça com defeito deve ser devolvida à HP. Nos casos em que isso for necessário, é preciso enviar a peça com defeito à HP dentro do período determinado, normalmente cinco (5) dias úteis. A peça com defeito deve ser enviada com a documentação correspondente no material de transporte fornecido. Caso não o faça, a HP poderá cobrar a reposição. Para as peças de reparo feito pelo cliente, a HP paga todas as despesas de transporte e de devolução da peça e determina a transportadora/serviço postal a ser utilizado.

Para obter mais informações sobre o programa de reparo feito pelo cliente da HP, entre em contato com o fornecedor de serviços local. Para o programa norte-americano, visite o site da HP (http://www.hp.com/go/selfrepair).

顧客自己修理保証サービス

修理時間を短縮し、故障部品の交換における高い柔軟性を確保するために、HP製品には多数の顧客自己修理（CSR）部品があります。診断の際に、CSR部品を使用すれば修理ができるとHP（HPまたはHP正規保守代理店）が判断した場合、HPはその部品を直接、お客様に発送し、お客様に交換していただきます。CSR部品には以下の2通りがあります。

- 必須 - 顧客自己修理が必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。
- 任意 - 顧客自己修理が任意である部品。この部品も顧客自己修理用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、別途費用を負担していただくことなく保証サービスを受けることができます。

注： HP製品の一部の部品は、顧客自己修理用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品が顧客自己修理除外品である旨が記載されています。

部品供給が可能な場合、地域によっては、CSR部品を翌営業日に届くように発送します。また、地域によっては、追加費用を負担いただくことにより同日または4時間以内に届くように発送することも可能な場合があります。サポートが必要なときは、HPの修理受付窓口に電話していただければ、技術者が電話でアドバイスします。交換用のCSR部品または同梱物には、故障部品をHPに返送する必要があるかどうかが表示されています。故障部品をHPに返送する必要がある場合は、指定期限内（通常は5営業日以内）に故障部品をHPに返送してください。故障部品を返送する場合は、届いた時の梱包箱に関連書類とともに入れてください。故障部品を返送しない場合、HPから部品費用が請求されます。顧客自己修理の際には、HPは送料および部品返送費を全額負担し、使用する宅配便会社や運送会社を指定します。

客户自行维修

HP 产品提供许多客户自行维修 (CSR) 部件，以尽可能缩短维修时间和在更换缺陷部件方面提供更大的灵活性。如果在诊断期间 HP（或 HP 服务提供商或服务合作伙伴）确定可以通过使用 CSR 部件完成维修，HP 将直接把该部件发送给您进行更换。有两类 CSR 部件：

- **强制性的** — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。
- **可选的** — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

注：某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为“否”。

CSR 部件将在下一个工作日发运（取决于备货情况和允许的地理范围）。在允许的地理范围内，可在当天或四小时内发运，但要收取额外费用。如果需要帮助，您可以致电 HP 技术支持中心，将会有技术人员通过电话为您提供帮助。HP 会在随更换的 CSR 部件发运的材料中指明是否必须将有缺陷的部件返还给 HP。如果要求您将有缺陷的部件返还给 HP，那么您必须在规定期限内（通常是五 (5) 个工作日）将缺陷部件发给 HP。有缺陷的部件必须随所提供的发运材料中的相关文件一起返还。如果未能送还有缺陷的部件，HP 可能会要求您支付更换费用。客户自行维修时，HP 将承担所有相关运输和部件返回费用，并指定快递商/承运商。

有关 HP 客户自行维修计划的详细信息，请与您当地的服务提供商联系。有关北美地区的计划，请访问 HP 网站 (http://www.hp.com/go/selfrepair)。

客戶自行維修

HP 產品設計了許多「客戶自行維修」(CSR) 的零件以減少維修時間，並且使得更換瑕疵零件時能有更大的彈性。如果在診斷期間 HP（或 HP 服務供應商或維修夥伴）辨認出此項維修工作可以藉由使用 CSR 零件來完成，則 HP 將直接寄送該零件給您作更換。CSR 零件分為兩種類別：

- **強制的** — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。
- **選購的** — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 HP 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

備註：某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固，HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

基於材料取得及環境允許的情況下，CSR 零件將於下一個工作日以快遞寄送。在環境的允許下當天或四小時內送達，則可能需要額外的費用。若您需要協助，可致電「HP 技術支援中心」，會有一位技術人員透過電話來協助您。不論損壞的零件是否必須退回，HP 皆會在與 CSR 替換零件一起運送的材料中註明。若要將損壞的零件退回 HP，您必須在指定的一段時間內（通常為五 (5) 個工作天），將損壞的零件寄回 HP。損壞的零件必須與寄送資料中隨附的相關技術文件一併退還。如果無法退還損壞的零件，HP 可能要向您收取替換費用。針對客戶自行維修情形，HP 將負責所有運費及零件退還費用並指定使用何家快遞/貨運公司。

如需 HP 的「客戶自行維修」方案詳細資訊，請連絡您當地的服務供應商。至於北美方案，請參閱 HP 網站 (http://www.hp.com/go/selfrepair)。

고객 셀프 수리

HP 제품은 수리 시간을 최소화하고 결함이 있는 부품 교체 시 더욱 융통성을 발휘할 수 있도록 하기 위해 고객 셀프 수리(CSR) 부품을 다량 사용하여 설계되었습니다. 진단 기간 동안 HP(또는 HP 서비스 공급업체 또는 서비스 협력업체)에서 CSR 부품을 사용하여 수리가 가능하다고 판단되면 HP는 해당 부품을 바로 사용자에게 보내어 사용자가 교체할 수 있도록 합니다. CSR 부품에는 두 가지 종류가 있습니다.

- **고객 셀프 수리가 의무 사항인 필수 부품.** 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.
- **고객 셀프 수리가 선택 사항인 부품.** 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

참고: 일부 HP 부품은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 만족스러운 고객 보증을 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다. 이러한 부품들은 Illustrated Parts Catalog에 "No"라고 표시되어 있습니다.

CSR 부품은 재고 상태와 지리적 조건이 허용하는 경우 다음 영업일 납품이 가능하도록 배송이 이루어집니다. 지리적 조건이 허용하는 경우 추가 비용이 청구되는 조건으로 당일 또는 4시간 배송이 가능할 수도 있습니다. 도움이 필요하시면 HP 기술 지원 센터로 전화하십시오. 전문 기술자가 전화로 도움을 줄 것입니다. HP는 결함이 발생한 부품을 HP로 반환해야 하는지 여부를 CSR 교체 부품과 함께 배송된 자료에 지정합니다. 결함이 발생한 부품을 HP로 반환해야 하는 경우에는 지정된 기간 내(통상 영업일 기준 5일)에 HP로 반환해야 합니다. 이 때 결함이 발생한 부품은 제공된 포장 재료에 넣어 관련 설명서와 함께 반환해야 합니다. 결함이 발생한 부품을 반환하지 않는 경우 HP가 교체 부품에 대해 비용을 청구할 수 있습니다. 고객 셀프 수리의 경우, HP는 모든 운송 및 부품 반환 비용을 부담하며 이용할 운송업체 및 택배 서비스를 결정합니다.

HP 고객 셀프 수리 프로그램에 대한 자세한 내용은 가까운 서비스 제공업체에 문의하십시오. 북미 지역의 프로그램에 대해서는 HP 웹 사이트(http://www.hp.com/go/selfrepair)를 참조하십시오.

Acronyms and abbreviations

ABEND

abnormal end

ACU

Array Configuration Utility

ADM

Advanced Data Mirroring

AMP

Advanced Memory Protection

ASR

Automatic Server Recovery

BMC

baseboard management controller

CSA

Canadian Standards Association

CSR

Customer Self Repair

DDDC

Double Device Data Correction

DDR

double data rate

FBWC

flash-backed write cache

GPU

graphics processing unit

HDD

hard drive

HP SIM

HP Systems Insight Manager

HP SUM

HP Smart Update Manager

IEC

International Electrotechnical Commission

iLO

Integrated Lights-Out

IML

Integrated Management Log

LFF

large form factor

LRDIMM

load reduced dual in-line memory module

NMI

nonmaskable interrupt

NVRAM

nonvolatile memory

ORCA

Option ROM Configuration for Arrays

PCIe

peripheral component interconnect express

PCI-X

peripheral component interconnect extended

POST

Power-On Self Test

RBSU

ROM-Based Setup Utility

RDIMM

registered dual in-line memory module

RDP

Rapid Deployment Pack

SAS

serial attached SCSI

SATA

serial ATA

SDDC

Single Device Data Correction

SFF

small form factor

SIM

Systems Insight Manager

SLAPM

SL Advanced Power Manager

SPP

HP Service Pack for ProLiant

SUV

serial, USB, video

TMRA

recommended ambient operating temperature

TPM

Trusted Platform Module

UDIMM

unregistered dual in-line memory module

UID

unit identification

UPS

uninterruptible power system

USB

universal serial bus

VCA

Version Control Agent

VCRM

Version Control Repository Manager

Documentation feedback

HP is committed to providing documentation that meets your needs. To help us improve the documentation, send any errors, suggestions, or comments to Documentation Feedback (mailto:docsfeedback@hp.com). Include the document title and part number, version number, or the URL when submitting your feedback.

Index

A

ACU (Array Configuration Utility) 68, 76
Advanced ECC memory 34, 35, 75
airflow requirements 19, 20
Array Configuration Utility (ACU) 76
ASR (Automatic Server Recovery) 77
authorized reseller 92
auto-configuration process 74
Automatic Server Recovery (ASR) 77

B

batteries, replacing 88
battery 82, 88
BIOS upgrade 68, 77
boot options 25, 74
BSMI notice 86
buttons 6, 8

C

cables 66, 84
cabling 60, 66
Canadian notices 84
Care Pack 19, 80
Change Control 80
components 6
components, identification 6, 8, 9
components, system board 9, 11
configuration of system 25, 68
connectors 6
contacting HP 92

D

Declaration of Conformity 84
default settings 34
diagnosing problems 81
diagnostic tools 68, 70, 77
diagnostics utility 70
DIMM installation guidelines 35
DIMM population guidelines 35
DIMM slots 35
DIMMs 32
DIMMs, dual-rank 32
DIMMs, quad-rank 32
DIMMs, single- and dual-rank 32
drive LEDs 14
drivers 78
drives 14

E

electrical grounding requirements 21
electrostatic discharge 90
environmental requirements 19, 21, 91
Erase Utility 68, 71
European Union notice 85
expansion blade, installing 46
expansion board 46

F

FBWC capacitor cabling 66
FBWC capacitor pack 42
features 6, 76
Federal Communications Commission (FCC) notice 83, 84

G

grounding methods 90
grounding requirements 21

H

hard drive blanks 38
hard drive LEDs 14
hard drives, determining status of 14
hard drives, installing 27, 37
hardware options 27
hardware options installation 27
health driver 77
hot-plug power supply 52
HP Insight Diagnostics 70, 71
HP Smart memory 31

I

identification number 83

iLO (Integrated Lights-Out) 68, 69, 70
IML (Integrated Management Log) 68, 70
Insight Diagnostics 70, 71, 78
installation services 19
installation, server options 27
installing hardware 27
Integrated Lights-Out (iLO) 68
Integrated Management Log (IML) 70

J

Japanese notice 86

K

Korean notices 86

L

laser devices 87
LEDs 6, 8, 14
LEDs, drive 14
LEDs, hard drive 14
LEDs, power supply 8
LEDs, SAS hard drive 14
LEDs, troubleshooting 81

M

memory 32, 33, 34
memory subsystem architecture 32
memory, Advanced ECC 34, 75
memory, configuration requirements 34, 36
memory, configuring 34, 35
memory, online spare 34, 75

N

NMI jumper 11

O

online spare memory 34, 75
operating systems 79
operations 15
optimum environment 19
Option ROM Configuration for Arrays (ORCA) 68, 77
options installation 27, 37, 46
ORCA (Option ROM Configuration for Arrays) 68, 77

P

PCI expansion slots 15, 46
phone numbers 92
population guidelines, Advanced ECC 35
power cord 88
power distribution unit (PDU) 21
Power On button 15, 25
power requirements 91
power supply 91
power supply LEDs 8
powering down 15
powering up 15, 25, 74
preparation procedures 15
problem diagnosis 81
processor option 27

R

rack installation 19, 21
rack mounting hardware 22
rack resources 19
rack warnings 21
RBSU (ROM-Based Setup Utility) 73, 74, 75
RBSU configuration 74
rear panel components 8
rear panel LEDs 8
redundant power supply 52
redundant ROM 78
registering the server 26
regulatory compliance notices 83, 85
required information 92
requirements, airflow 20
requirements, power 21, 91
requirements, space 20
requirements, temperature 20
ROM redundancy 78
ROM-Based Setup Utility (RBSU) 65, 68, 73
ROMPaq utility 68, 77, 78

S

safety considerations 21, 78
safety information 78
scripted installation 72
serial number 75
series number 83
server features and options 27
shipping carton contents 22
software 79
space requirements 20
specifications 68, 91

static electricity 90
support 92
supported operating systems 79
system battery 82
system board battery 88
system board components 9
System Erase Utility 71
system maintenance switch 11

T

Taiwan battery recycling notice 88
technical support 80, 92
telephone numbers 92
temperature requirements 20
TPM (Trusted Platform Module) 61, 64, 65
troubleshooting 81
Trusted Platform Module (TPM) 61, 64, 65

U

UID LED 8
updating the system ROM 78
USB support 77
utilities 68, 76
utilities, deployment 68, 72, 73

V

ventilation 19

W

warnings 21